



應 廣 科 技

***LeapDragon*** ( 跃龙 )

**PFC232**

Industrial Grade - 8bit MTP MCU (FPPA™)  
with 12-bit Enhanced ADC

Data Sheet

*Version 0.00*

*August 23, 2019*

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## Revision History:

Revision	Date	Description
0.00	2019/08/23	Preliminary version

## Warning

User must read all application notes of the IC by detail before using it. Please download the related application notes from the following link:

<http://www.padauk.com.tw/tw/technical/index.aspx>

## 1. Features

### 1.1. Special Features

- ◆ High EFT series  
Especially fit for the products that are AC powered with even using RC step-down circuit, or require strong noise immunity, or required high EFT capability ( $\pm 4\text{KV}$ ) for passing safety regulation tests.
- ◆ Operating temperature range:  $-40^{\circ}\text{C} \sim 85^{\circ}\text{C}$

### 1.2. System Features

- ◆ 2KW MTP program memory for both FPP units (programming cycle at least 1,000 times)
- ◆ 128 Bytes data RAM for both FPP units
- ◆ One hardware 16-bit timer
- ◆ Two hardware 8-bit timers with PWM generation
- ◆ Three hardware 11-bit PWM generators (PWMG0, PWMG1 & PWMG2)
- ◆ Provide one hardware comparator
- ◆ Provide one OP Amplifier (OPA)
- ◆ Provide 1T 8x8 hardware multiplier
- ◆ 14 IO pins with optional pull-high / pull-low resistor
- ◆ Every IO pin can be configured to enable wake-up function
- ◆ For every wake-up enabled IO, two optional wake-up speed are supported: normal and fast
- ◆ Bandgap circuit to provide 1.20V reference voltage
- ◆ Up to 12-channel 12-bit resolution ADC with one channel comes from internal Bandgap reference voltage or  $0.25 \cdot V_{DD}$
- ◆ Provide ADC reference high voltage: external input, internal  $V_{DD}$ , Bandgap(1.20V), 4V, 3V, 2V
- ◆ Clock sources: internal high RC oscillator, internal low RC oscillator and external crystal oscillator
- ◆ Built-in  $V_{DD}/2$  bias voltage generator to provide maximum 5x9 dots LCD display
- ◆ 8 selectable levels of LVR reset from 1.8V to 4.5V
- ◆ Four selectable external interrupt pins

### 1.3. CPU Features

- ◆ Operating modes: Two processing units FPPA<sup>TM</sup> mode or Traditional one processing unit mode
- ◆ 89 powerful instructions
- ◆ Most instructions are 1T execution cycle
- ◆ Programmable stack pointer and adjustable stack level
- ◆ Direct and indirect addressing modes for data access. Data memories are available for use as an index pointer of Indirect addressing mode
- ◆ Register space, memory space and MTP space are independent



## 1.4. Package Information

- ◆ PFC232-S08: SOP8 (150mil);
- ◆ PFC232-D08: DIP8 (300mil);
- ◆ PFC232-S14: SOP14 (150mil);
- ◆ PFC232-D14: DIP14 (300mil);
- ◆ PFC232-S16: SOP16 (150mil);
- ◆ PFC232-D16: DIP16 (300mil)

## 2. General Description and Block Diagram

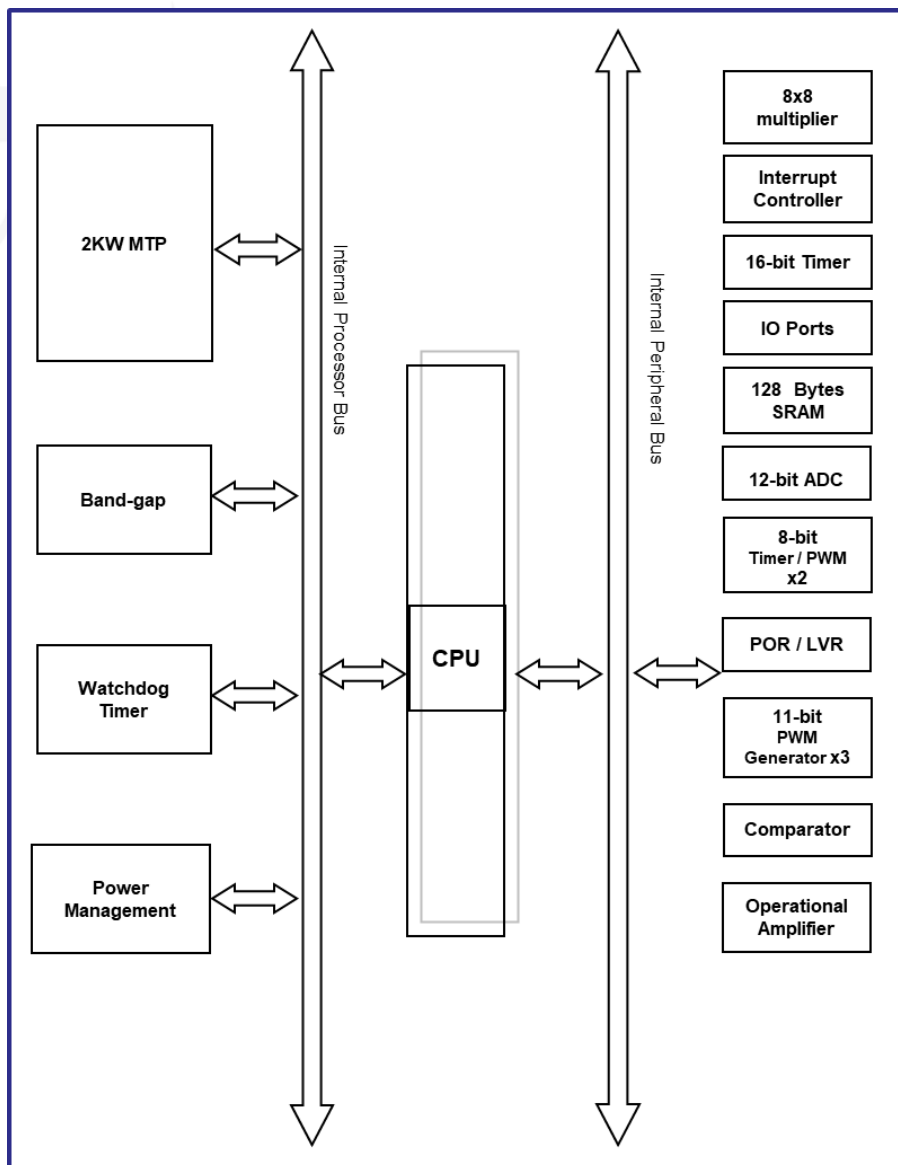
The PFC232 family is an ADC-Type of PADAUK's parallel processing, fully static, MTP-based CMOS 8 bit\*2 processor array that can execute two peripheral functions in parallel. It employs RISC architecture based on patent pending FPPA™ (Field Programmable Processor Array) technology and all the instructions are executed in one cycle except that some instructions are two cycles that handle indirect memory access.

2KW MTP program memory and 128 bytes data SRAM are inside for two FPP units using.

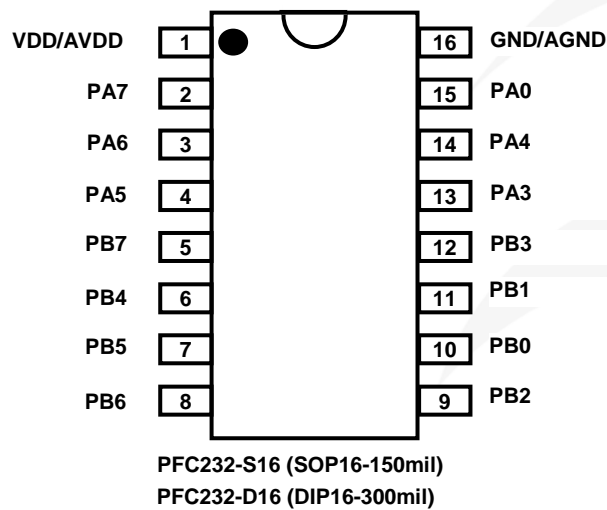
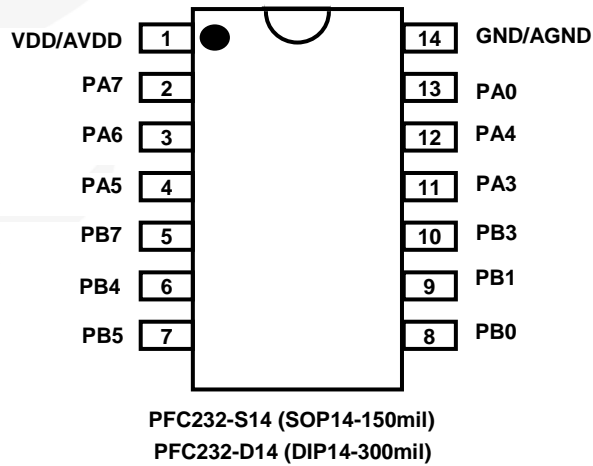
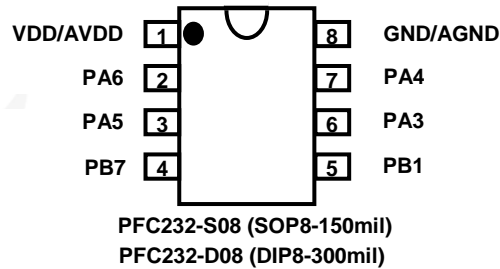
One up to 12 channels 12-bit ADC is built inside the chip with one channel for internal Bandgap reference voltage or  $0.25 \cdot V_{DD}$ .

PFC232 provides a hardware 16-bit timer, two hardware 8-bit timers with PWM generation (Timer2, Timer3) and Three hardware 11-bit timers with PWM generation (PWMG0, PWMG1, PWMG2).

PFC232 also supports an Operational Amplifier (OPA) and a hardware comparator, plus one  $V_{DD}/2$  bias voltage generator for LCD display application and one 8x8 hardware multiplier to enhance hardware capability in arithmetic function.



## 3. Pin Definition and Functional Description



Pin Name	Input / output				Special Functions								
	I / O	Pull High	Pull Low	Wake Up	Crystal	Comparator	PWM	VDD/2	ADC	OPA	External Interrupt	External Reset	Program
PA0	√	√	√	√		CO CIN- CIN+	PG0PWM	COM2	AD10	OPO	INT0		
PA3	√	√	√	√		CIN-	TM2PWM PG2PWM	COM4	AD8	OPIN-			√
PA4	√	√	√	√		CIN+ CIN-	PG1PWM	COM3	AD9	OPIN+ OPIN-	INT1A		
PA5	√	√	√	√			PG2PWM					√	√
PA6	√	√	√	√	√								√
PA7	√	√	√	√	√								
PB0	√	√	√	√				COM1	AD0		INT1		
PB1	√	√	√	√					AD1 Vref				
PB2	√	√	√	√			TM2PWM PG2PWM		AD2				
PB3	√	√	√	√			PG2PWM	COM5	AD3				
PB4	√	√	√	√			TM2PWM PG0PWM		AD4				
PB5	√	√	√	√			TM3PWM PG0PWM		AD5		INT0A		
PB6	√	√	√	√		CIN-	TM3PWM PG1PWM		AD6	OPIN-			
PB7	√	√	√	√		CIN-	TM3PWM PG1PWM		AD7	OPIN-			
VDD AVDD													√
GND AGND													√
Notice	<ol style="list-style-type: none"> <li>1. All the I/O pins have: Schmitt Trigger input and CMOS voltage level.</li> <li>2. IO function is automatically deactivated when a pin is used as PWM output port.</li> <li>3. Please put 33Ω resistor in series to have high noise immunity when PA5 is in input mode.</li> <li>4. ICE doesn't support the function PG2PWM output to PA5.</li> <li>5. VDD is the IC power supply while AVDD is the Analog positive power supply. AVDD and VDD are double bonding internally and they have the same external pin.</li> <li>6. GND is the IC ground pin while AGND is the Analog negative ground pin. AGND and GND are double bonding internally and they have the same external pin.</li> </ol>												

## 4. Central Processing Unit (CPU)

### 4.1. Functional Description

There are two processing units (FPP0 and FPP1) inside the chip of PFC232. In each processing unit, it includes:

- its own Program Counter to control the program execution sequence
- its own Stack Pointer to store or restore the program counter for program execution
- its own accumulator
- status Flag to record the status of program execution.

Each FPP unit has its own program counter and accumulator for program execution, flag register to record the status, and stack pointer for jump operation. Based on such architecture, FPP unit can execute its own program independently, thus parallel processing can be expected.

#### 4.1.1. Two FPP Units

These two FPP units share the same 2K words MTP program memory, 128 bytes data SRAM and all the IO ports, these two FPP units are operated at mutual exclusive clock cycles to avoid interference. One task switch is built inside the chip to decide which FPP unit should be active for the corresponding cycle. The hardware diagram and basic timing diagram of FPP units are illustrated in Fig. 1. For FPP0 unit, its program will be executed in sequence every other system clock, shown as (M-1)<sub>th</sub>, M<sub>th</sub> and (M+1)<sub>th</sub> instructions. For FPP1 unit, its program will be also executed in sequence every other system clock, shown as (N-1)<sub>th</sub>, N<sub>th</sub> and (N+1)<sub>th</sub> instructions.

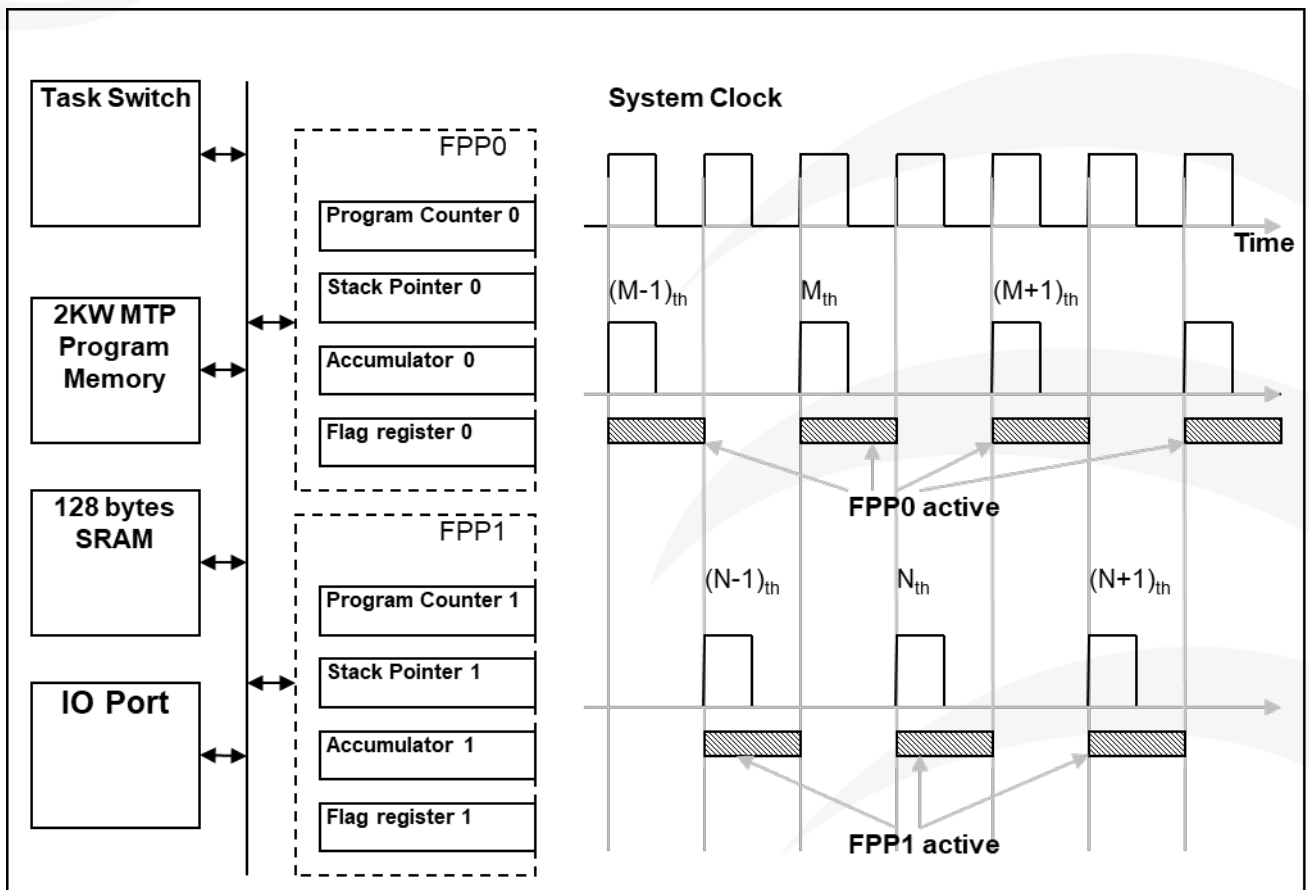


Fig. 1: Hardware and Timing Diagram of FPP unit

Each FPP unit has half computing power of whole system; for example, FPP0 and FPP1 will be operated at 4MHz if system clock is 8MHz. The FPP unit can be enabled or disabled by programming the FPP unit Enable Register, and only FPP0 is enabled after power-on reset. The system initialization will be started from FPP0 and FPP1 unit can be enabled by user's program if necessary. Both FPP0 and FPP1 can be enabled or disabled by using any one FPP unit.

## 4.1.2. Single FPP Unit

For traditional MCU user who does not need parallel processing capability, PFC232 provides single FPP mode optional to behave as traditional MCU. After single FPP mode is selected, FPP1 is always disabled and only FPP0 is active. Fig.2 shows the timing diagram for each FPP unit, FPP1 is always disabled and only FPP0 active.

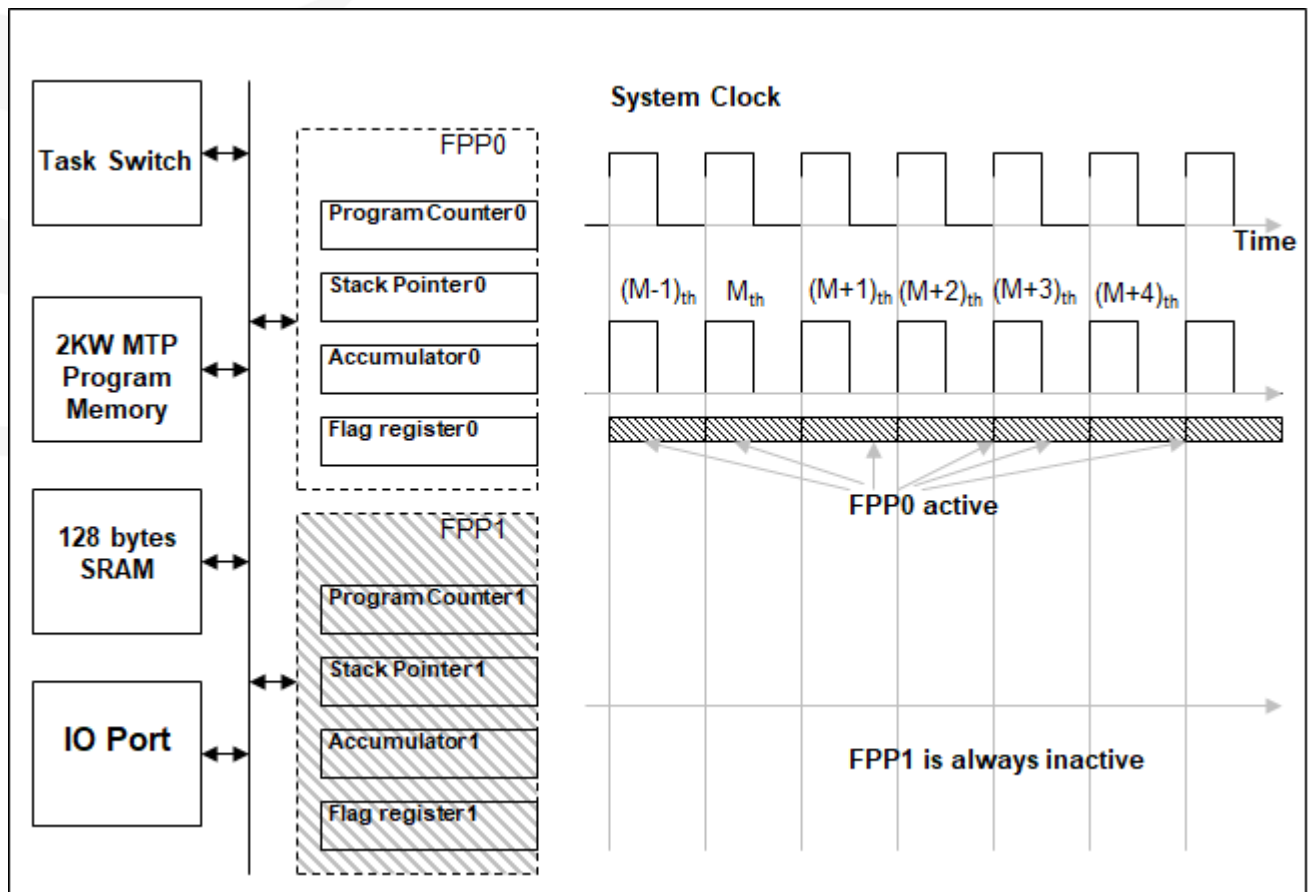


Fig. 2: Timing Diagram of single FPP mode

## 4.1.3. Program Counter

Program Counter (PC) is the unit that contains the address of an instruction to be executed next. The program counter is automatically incremented at each instruction cycle so that instructions are retrieved sequentially from the program memory. Certain instructions, such as branches and subroutine calls, interrupt the sequence by placing a new value in the program counter. The bit length of the program counter is 11 for PFC232. The program counter of FPP0 is 0 after hardware reset and 1 for FPP1. Whenever an interrupt happens in FPP0, the program counter will jump to 0x10 for interrupt service routine. Each FPP unit has its own program counter to control the program execution sequence.

## 4.1.4. Program Structure

### Program structure of two FPP units mode

After power-up, the program starting address of FPP0 is 0x000 and 0x001 for FPP1. The 0x010 is the entry address of interrupt service routine, which belongs to FPP0 only. The basic firmware structure for PFC232 is shown as Fig. 3, the program codes of two FPP units are placed in one whole program space. Except for the initial addresses of processing units and entry address of interrupt, the memory location is not specially specified; the program codes of processing unit can be resided at any location no matter what the processing unit is. After power-up, the fpp0Boot will be executed first, which will include the system initialization and other FPP units enabled.

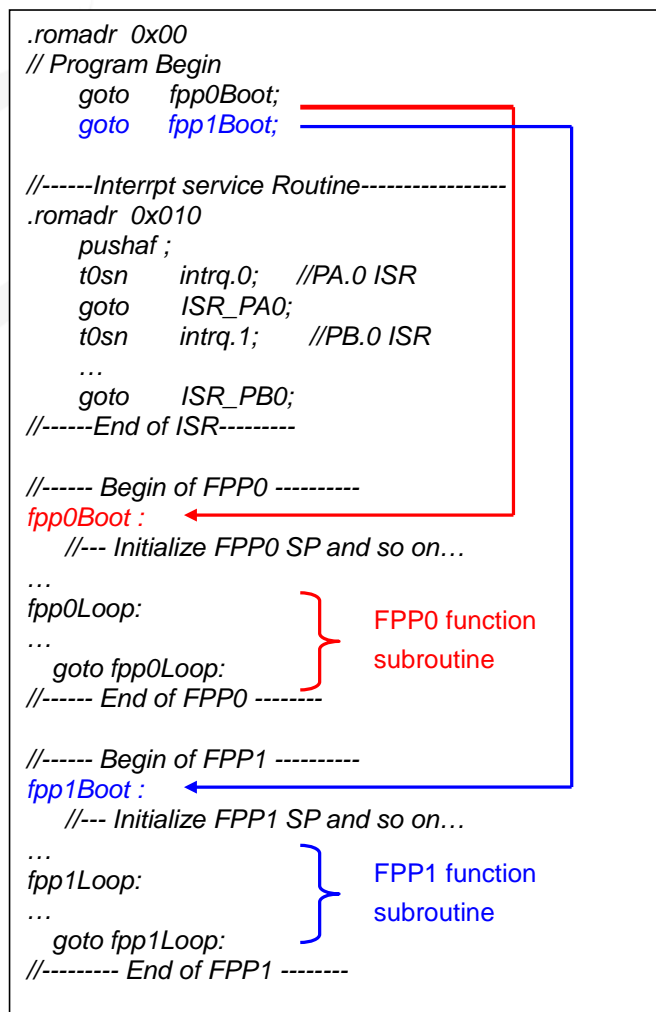


Fig. 3: Program Structure

### Program structure of single FPP mode

After power-up, the program starting address of FPP0 is 0x000, 0x010 is the entry address of interrupt service routine. For single FPP unit mode, the firmware structure is same as traditional MCU. After power-up, the program will be executed from address 0x000, then continuing the program sequence.

## 4.1.5. Arithmetic and Logic Unit

Arithmetic and Logic Unit (ALU) is the computation element to operate integer arithmetic, logic, shift and other specialized operations. The operation data can be from instruction, accumulator or SRAM data memory. Computation result could be written into accumulator or SRAM. FPP0 and FPP1 will share ALU for its corresponding operation.

## 4.2. Storage Memory

### 4.2.1. Program Memory – ROM

The PFC232 program memory is MTP (Multiple Time Programmable), used to store data (including: data, tables and interrupt entry) and program instructions to be executed. All program codes for each FPP unit are stored in this MTP memory for both FPP0 and FPP1. The MTP program memory for PFC232 is 2K words that is partitioned as Table 1.

After reset, the initial address for FPP0 is 0x000 and 0x001 for FPP1. The interrupt entry is 0x010 if used and interrupt function is for FPP0 only.

The MTP memory from address 0x7E0 to 0x7FF are for system using, address space from 0x001 to 0x00F and from 0x011 to 0x7DF are user program spaces. And the address 0x001 is the FPP1 initial address for two FPP units mode and user program for single FPP unit mode.

The last 32 addresses are reserved for system using, like checksum, serial number, etc.

Address	Function
0x000	FPP0 reset – <i>goto</i> instruction
0x001	FPP1 reset – <i>goto</i> instruction
0x002	User program
•	•
0x00F	User program
0x010	Interrupt entry address
0x011	User program
•	•
0x7DF	User program
0X7E0	System Using
•	•
0x7FF	System Using

Table 1: Program Memory Organization



## Example of Using Program Memory for Two FPP mode

Table 2 shows one example of using program memory which two FPP units are active.

Address	Function
0x000	FPP0 reset – <i>goto</i> instruction ( <i>goto</i> 0x020)
0x001	Begin of FPP1 program
•	•
0x00F	<i>goto</i> 0x1A1 to continue FPP1 program
0x010	Interrupt entry address (FPP0 only)
•	•
0x01F	End of ISR (depend on user code size)
0x020	Begin of FPP0 user program
•	•
0x1A0	End of FPP0 user program
0x1A1	Continuing FPP1 program
•	•
0x7DF	End of FPP1 program
0x7E0	System Using
•	•
0x7FF	System Using

Table 2: Example of using Program Memory for two FPP units mode

## Example of Using Program Memory for Single FPP mode

The entire user's program memory can be assigned to FPP0 when single FPP mode is selected.

Table 3 shows the example of program memory using for single FPP unit mode.

Address	Function
0x000	FPP0 reset
0x001	Begin of user program
0x002	user program
•	•
0x00F	<i>goto</i> instruction ( <i>goto</i> 0x020)
0x010	Interrupt entry address
0x011	ISR
•	•
0x01F	End of ISR (depend on user code size)
0x020	user program
•	•
•	•
0x7DF	user program
0x7E0	System Using
•	•
0x7FF	System Using

Table 3: Example of using Program Memory for single FPP mode

## 4.2.2. Data Memory – SRAM

Fig. 4 shows the SRAM data memory organization of PFC232, all the SRAM data memory could be accessed by FPP0 and FPP1 directly with 1T clock cycle. The access of data memory can be byte or bit operation. Besides data storage, the SRAM data memory is also served as data pointer of indirect access method and the stack memory for all FPP units.

The stack memory for each processing unit should be independent from each other, and defined in the data memory. The stack pointer is defined in the stack pointer register of each processing unit; the depth of stack memory of each processing unit is defined by the user. The arrangement of stack memory fully flexible and can be dynamically adjusted by the user.

For indirect memory access mechanism, the data memory is used as the data pointer to address the data byte. All the data memory could be the data pointer; it's quite flexible and useful to do the indirect memory access. Since the data width is 8-bit, all the 128 bytes data memory of PFC232 can be accessed by indirect access mechanism.

Bit defined: Only addressed at 0x00 ~ 0x3F.

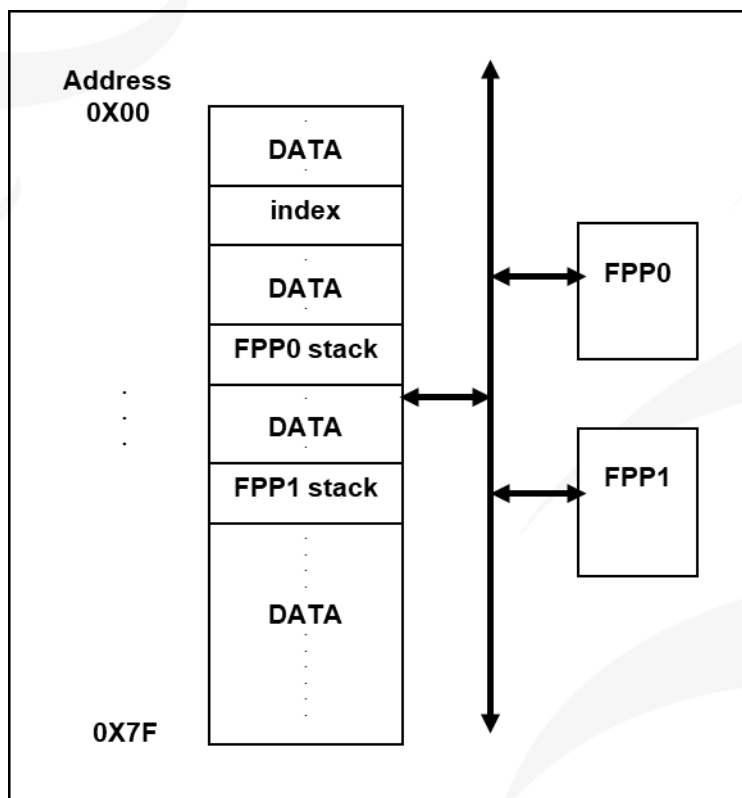


Fig. 4: Data Memory Organization

## 4.2.3. System Register

The register space of PFC232 is independent of SRAM space and MTP space.

The following is the PFC232 register address and brief description:

	+0	+1	+2	+3	+4	+5	+6	+7
0x00	<i>FLAG</i>	<i>FPPEN</i>	<i>SP</i>	<i>CLKMD</i>	<i>INTEN</i>	<i>INTRQ</i>	<i>T16M</i>	<i>OPAOFS</i>
0x08	<i>MULOP</i>	<i>MULRH / TM2B</i>	<i>EOSCR</i>	-	<i>INTEGS</i>	<i>PADIER</i>	<i>PBDIER</i>	-
0x10	<i>PA</i>	<i>PAC</i>	<i>PAPH</i>	<i>PAPL</i>	<i>PB</i>	<i>PBC</i>	<i>PBPH</i>	<i>PBPL</i>
0x18	<i>GPCC</i>	<i>GPCS</i>	<i>OPAC</i>	-	<i>TM2C</i>	<i>TM2CT</i>	<i>TM2S</i>	<i>MISC</i>
0x20	<i>PWMG0C</i>	<i>PWMG0S</i>	<i>PWMG0-DTH</i>	<i>PWMG0-DTL</i>	<i>PWMG0-CUBH</i>	<i>PWMG0-CUBL</i>	<i>PWMG1C</i>	<i>PWMG1S</i>
0x28	<i>PWMG1DTH</i>	<i>PWMG1DTL</i>	<i>PWMG1-CUBH</i>	<i>PWMG1-CUBL</i>	<i>PWMG2C</i>	<i>PWMG2S</i>	<i>PWMG2-DTH</i>	<i>PWMG2-DTL</i>
0x30	<i>PWMG2CUBH</i>	<i>PWMG2CUBL</i>	<i>TM3C</i>	<i>TM3CT</i>	<i>TM3S</i>	<i>ADCC</i>	<i>ADCM</i>	<i>ADCRH</i>
0x38	<i>TM3B / ADCRL</i>	<i>ADCRGC</i>	-	-	-	-	-	-

*FLAG*: ACC Status Flag Register

*FPPEN*: FPP unit Enable Register

*SP*: Stack Pointer Register

*CLKMD*: Clock Mode Register

*INTEN*: Interrupt Enable Register

*INTRQ*: Interrupt Request Register

*T16M*: Timer 16 mode Register

*OPAOFS*: OPA Offset Register

*MULOP*: Multiplier Operand Register

*MULRH*: Multiplier Result High Byte Register

*TM2B / TM3B*: Timer2 / Timer3 Bound Register

*EOSCR*: External Oscillator setting Register

*INTEGS*: Interrupt Edge Select Register

*PADIER*: Port A Digital Input Enable Register

*PBDIER*: Port B Digital Input Enable Register

*PA*: Port A Data Registers

*PAC*: Port A Control Registers

*PAPH*: Port A Pull-High Registers

*PAPL*: Port A Pull-Low Registers

*PB*: Port B Data Registers

*PBC*: Port B Control Registers

*PBPH*: Port B Pull-High Registers

*PBPL*: Port B Pull-Low Registers

*GPCC*: Comparator Control Register

*GPCS*: Comparator Selection Register

*OPAC*: OPA Control Register

*TM2C / TM3C*: Timer2 / Timer3 Control Register

*TM2CT / TM3CT*: Timer2 / Timer3 Counter Register

*TM2S / TM3S*: Timer2 / Timer3 Scalar Register

*MISC*: MISC Register

*PWMG0C / PWMG1C / PWMG2C*:

*PWMG0 / PWMG1 / PWMG2* control Register

*PWMG0S / PWMG1S / PWMG2S*:

*PWMG0 / PWMG1 / PWMG2* Scalar Register

*PWMG0DTH / PWMG1DTH / PWMG2DTH*:

*PWMG0 / PWMG1 / PWMG2* Duty Value High Register

*PWMG0DTL / PWMG1DTL / PWMG2DTL*:

*PWMG0 / PWMG1 / PWMG2* Duty Value Low Register

*PWMG0CUBH / PWMG1CUBH / PWMG2CUBH*:

*PWMG0 / PWMG1 / PWMG2* Counter Upper Bound High Register

PWMG0CUBL / PWMG1CUBL / PWMG2CUBL:

PWMG0 / PWMG1 / PWMG2 Counter Upper Bound

Low Register

ADCC: ADC Control Register

ADCM: ADC Mode Register

ADCRH / ADCRL: ADC Result High Low Register

ADCRGC: ADC Regulator Control Register

#### 4.2.3.1.ACC Status Flag Register (*FLAG*), address = 0x00

Bit	Reset	R/W	Description
7 – 4	-	-	Reserved. These four bits are “1” when read.
3	-	R/W	OV (Overflow). This bit is set whenever the sign operation is overflow.
2	-	R/W	AC (Auxiliary Carry). There are two conditions to set this bit, the first one is carry out of low nibble in addition operation, and the other one is borrow from the high nibble into low nibble in subtraction operation.
1	-	R/W	C (Carry). There are two conditions to set this bit, the first one is carry out in addition operation, and the other one is borrow in subtraction operation. Carry is also affected by shift with carry instruction.
0	-	R/W	Z (Zero). This bit will be set when the result of arithmetic or logic operation is zero; Otherwise, it is cleared.

#### 4.2.3.2.FPP unit Enable Register (*FPPEN*), address = 0x01

Bit	Reset	R/W	Description
7 - 2	-	-	Reserved. Please keep 0 for future compatibility.
1	0	R/W	FPP1 enable. This bit is used to enable FPP1. 0 / 1: disable / enable
0	1	R/W	FPP0 enable. This bit is used to enable FPP0. 0 / 1: disable / enable

## 4.2.3.3. MISC Register (*MISC*), address = 0x1F

Bit	Reset	R/W	Description
7 – 5	-	-	Reserved. (keep 0 for future compatibility)
4	0	WO	Enable VDD/2 bias voltage generator 0 / 1 : Disable / Enable (ICE cannot be dynamically switched)
3	-	-	Reserved.
2	0	WO	Disable LVR function. 0 / 1 : Enable / Disable
1 – 0	00	WO	Watch dog time out period 00: 8k ILRC clock period 01: 16k ILRC clock period 10: 64k ILRC clock period 11: 256k ILRC clock period

## 4.3. The Stack

The stack pointer in each processing unit is used to point the top of the stack area where the local variables and parameters to subroutines are stored; the stack pointer register (*SP*) is located in register address 0x02. The bit number of stack pointer is 8 bit; the stack memory cannot be accessed over 128 bytes and should be defined within 128 bytes from 0x00 address. The stack memory of PFC232 for each FPP unit can be assigned by user via stack pointer register, means that the depth of stack pointer for each FPP unit is adjustable in order to optimize system performance. The following example shows how to define the stack in the ASM (assembly language) project:

```
.ROMADR0
GOTO      FPPA0
GOTO      FPPA1
...
.RAMADR0                                     // Address must be less than 0x100
WORD      Stack0 [1]                         // one WORD
WORD      Stack1 [2]                         // two WORD
...
FPPA0:
SP  =      Stack0;                           // assign Stack0 for FPPA0,
                                                // one level call because of Stack0[1]
...
call      function1
...
FPPA1:
SP  =      Stack1;                           // assign Stack1 for FPPA1,
                                                // two level call because of Stack1[2]
...
call      function2
...
```

In Mini-C project, the stack calculation is done by system software, user will not have effort on it, and the example is shown as below:

```
void      FPPA0 (void)
{
    ...
}
```

User can check the stack assignment in the window of program disassembling, Fig. 5 shows that the status of stack before FPP0 execution, system has calculated the required stack space and has reserved for the program.

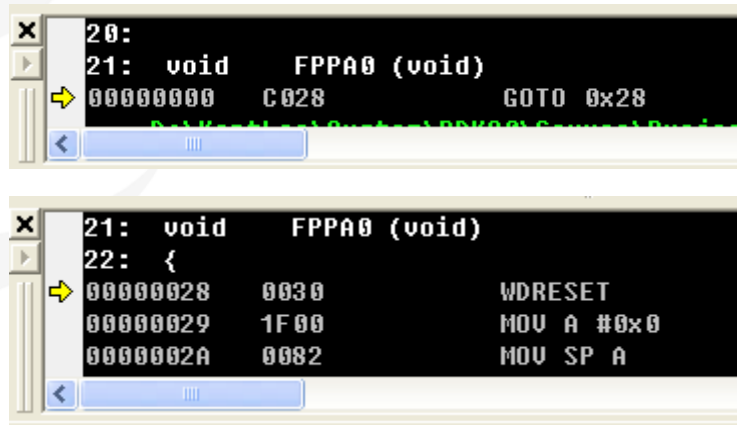


Fig. 5: Stack Assignment in Mini-C project

#### 4.3.1. Stack Pointer Register (SP), address = 0x02

Bit	Reset	R/W	Description
7 – 0	-	R/W	Stack Pointer Register. Read out the current stack pointer, or write to change the stack pointer. Please notice that bit 0 should be kept 0 due to program counter is 16 bits.

#### 4.4. Code Options

Option	Selection	Description
Security	Enable	MTP content is protected 7/8 words
	<b>Disable(default)</b>	MTP content is not protected so program can be read back
LVR	4.0V	Select LVR = 4.0V
	3.75V	Select LVR = 3.75V
	3.0V	Select LVR = 3.0V
	2.75V	Select LVR = 2.75V
	<b>2.5V(default)</b>	Select LVR = 2.5V
	2.2V	Select LVR = 2.2V
	2.0V	Select LVR = 2.0V
	1.8V	Select LVR = 1.8V
GPC_P_In	<b>PA.4(default)</b>	Comparator plus input is from PA.4
	PA.0	Comparator plus input is from PA.0
GPC_PWM	<b>Disable(default)</b>	GPC / PWM are independent
	Enable	GPC output control PWM output (ICE does NOT Support.)

Option	Selection	Description
OPA_PWM	<b>Disable(default)</b>	OPA / PWM are independent
	Enable	OPA output control PWM output (ICE does NOT Support.)
Comparator_Edge	<b>All_Edge(default)</b>	The comparator will trigger an interrupt on the rising edge or falling edge
	Rising_Edge	The comparator will trigger an interrupt on the rising edge
	Falling_Edge	The comparator will trigger an interrupt on the falling edge
Interrupt Src0	<b>PA.0(default)</b>	<i>INTEN/ INTRQ.Bit0</i> is from PA.0
	PB.5	<i>INTEN/ INTRQ.Bit0</i> is from PB.5
Interrupt Src1	<b>PB.0(default)</b>	<i>INTEN/ INTRQ.Bit1</i> is from PB.0
	PA.4	<i>INTEN/ INTRQ.Bit1</i> is from PA.4
PB4_PB7_Drive	Normal	PB4 & PB7 Drive / Sink Current is Normal
	<b>Strong(default)</b>	PB4 & PB7 Drive / Sink Current is Strong
PWM_Source	<b>16MHZ(default)</b>	When <i>PWMG0C.0</i> = 1, PWMG0 clock source = IHRC = 16MHZ When <i>PWMG1C.0</i> = 1, PWMG1 clock source = IHRC = 16MHZ When <i>PWMG2C.0</i> = 1, PWMG2 clock source = IHRC = 16MHZ
	32MHZ	When <i>PWMG0C.0</i> = 1, PWMG0 clock source = IHRC*2 = 32MHZ When <i>PWMG1C.0</i> = 1, PWMG1 clock source = IHRC*2 = 32MHZ When <i>PWMG2C.0</i> = 1, PWMG2 clock source = IHRC*2 = 32MHZ (ICE does NOT Support.)
TMx_Source	<b>16MHZ(default)</b>	When <i>TM2C[7:4]</i> = 0010, TM2 clock source = IHRC = 16MHZ When <i>TM3C[7:4]</i> = 0010, TM3 clock source = IHRC = 16MHZ
	32MHZ	When <i>TM2C[7:4]</i> = 0010, TM2 clock source = IHRC*2 = 32MHZ When <i>TM3C[7:4]</i> = 0010, TM3 clock source = IHRC*2 = 32MHZ (ICE does NOT Support.)
TMx_Bit	<b>6 Bit(default)</b>	When <i>TM2S.7</i> =1, TM2 PWM resolution is 6 Bit When <i>TM3S.7</i> =1, TM3 PWM resolution is 6 Bit
	7 Bit	When <i>TM2S.7</i> =1, TM2 PWM resolution is 7 Bit When <i>TM3S.7</i> =1, TM3 PWM resolution is 7 Bit (ICE does NOT Support.)
EMIEB	<b>Disable(default)</b>	Disable EMI optimize option
	Enable	The system clock will be slightly vibrated for better EMI performance
FPPA	<b>1-FPPA(default)</b>	Single FPP unit mode
	2-FPPA	Two FPP units mode

## 5. Oscillator and System Clock

There are three oscillator circuits provided by PFC232: external crystal oscillator (EOSC), internal high RC oscillator (IHRC) and internal low RC oscillator (ILRC).

These three oscillators are enabled or disabled by registers *EOSCR.7*, *CLKMD.4* and *CLKMD.2* independently. User can choose one of these three oscillators as system clock source and use *CLKMD* register to target the desired frequency as system clock to meet different applications.

Oscillator Module	Enable / Disable
EOSC	<i>EOSCR.7</i>
IHRC	<i>CLKMD.4</i>
ILRC	<i>CLKMD.2</i>

Table 4: Three Oscillator Circuits provided by PFC232

### 5.1. Internal High RC Oscillator and Internal Low RC Oscillator

The frequency of IHRC / ILRC will vary by process, supply voltage and temperature. Please refer to the measurement chart for IHRC / ILRC frequency verse  $V_{DD}$  and IHRC / ILRC frequency verse temperature.

The PFC232 writer tool provides IHRC frequency calibration (usually up to 16MHz) to eliminate frequency drift caused by factory production. ILRC has no calibration operation. For applications that require accurate timing, please do not use the ILRC clock as a reference time.

### 5.2. External Crystal Oscillator

The range of operating frequency of crystal oscillator can be from 32 KHz to 4MHz, depending on the crystal placed on; higher frequency oscillator than 4MHz is NOT supported. Fig. 6 shows the hardware connection under this application.

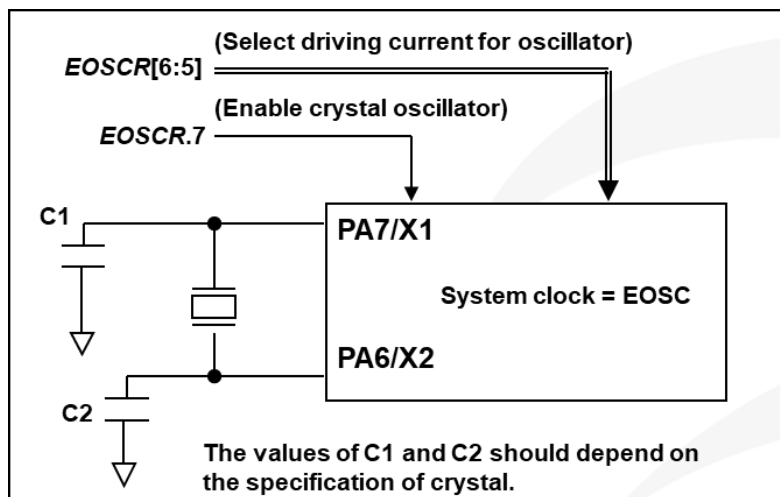


Fig. 6: Connection of crystal oscillator



## 5.2.1. External Oscillator Setting Register (*EOSCR*), address = 0x0A

Bit	Reset	R/W	Description
7	0	WO	Enable external crystal oscillator. 0 / 1 : Disable / Enable
6 – 5	00	WO	External crystal oscillator selection. 00 : reserved 01 : Low driving capability, for lower frequency, ex: 32KHz crystal oscillator 10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator 11 : High driving capability, for higher frequency, ex: 4MHz crystal oscillator
4 – 1	-	-	Reserved. Please keep 0 for future compatibility.
0	0	WO	Power-Down the Bandgap and LVR hardware modules. 0 / 1: normal / Power-Down.

## 5.2.2. Usages and Precautions of External Oscillator

Besides crystal, external capacitor and options of PFC232 should be fine tuned in *EOSCR* register to have good sinusoidal waveform. The *EOSCR.7* is used to enable crystal oscillator module. *EOSCR.6* and *EOSCR.5* are used to set the different driving current to meet the requirement of different frequency of crystal oscillator.

Table 5 shows the recommended values of C1 and C2 for different crystal oscillator; the measured start-up time under its corresponding conditions is also shown. Since the crystal or resonator had its own characteristic, the capacitors and start-up time may be slightly different for different type of crystal or resonator, please refer to its specification for proper values of C1 and C2.

Frequency	C1	C2	Measured Start-up time	Conditions
4MHz	4.7pF	4.7pF	6ms	( <i>EOSCR</i> [6:5]=11)
1MHz	10pF	10pF	11ms	( <i>EOSCR</i> [6:5]=10)
32KHz	22pF	22pF	450ms	( <i>EOSCR</i> [6:5]=01)

Table 5: Recommend values of C1 and C2 for crystal and resonator oscillators

Configuration of PA7 and PA6 when using crystal oscillator:

- (1) PA7 and PA6 are set as input;
- (2) PA7 and PA6 internal pull-high resistors are set to close;
- (3) Set PA6 and PA7 as analog inputs with the *PADIER* register to prevent power leakage.

**Note:** Please read the PMC-APN013 carefully. According to PMC-APN013, the crystal oscillator should be used reasonably. If the following situations happen to cause IC start-up slowly or non-startup, PADAUK Technology is not responsible for this: the quality of the user's crystal oscillator is not good, the usage conditions are unreasonable, the PCB cleaner leakage current, or the PCB layouts are unreasonable.

When using the crystal oscillator, user must pay attention to the stable time of oscillator after enabling it. The stable time of oscillator will depend on frequency, crystal type, external capacitor and supply voltage. Before switching the system to the crystal oscillator, user must make sure the oscillator is stable. The reference program is shown as below:

```
void    FPPA0 (void)
{
    . ADJUST_IC  SYSCLK=IHRC/16, IHRC=16MHz, VDD=5V
    ...
    $ EOSCR Enable, 4Mhz;           // EOSCR = 0b110_00000;
    $ T16M  EOSC, /1, BIT13;        // while T16.Bit13 0 => 1, Intrq.T16 => 1
                                     // suppose crystal eoscr. is stable

    WORD    count    =    0;
    stt16    count;
    Intrq.T16 =    0;
    while (! Intrq.T16) NULL;        // count from 0x0000 to 0x2000, then trigger INTRQ.T16
    CLKMD = 0xB4;                    // switch system clock to EOSC;
    CLKMD.4 = 0;                     // disable IHRC
    ...
}
```

Please notice that the crystal oscillator should be fully turned off before entering the Power-Down mode, in order to avoid unexpected wake-up event.

## 5.3. System Clock and IHRC Calibration

### 5.3.1. System Clock

The clock source of system clock comes from IHRC, ILRC or EOSC, the hardware diagram of system clock in the PFC232 is shown as Fig. 7.

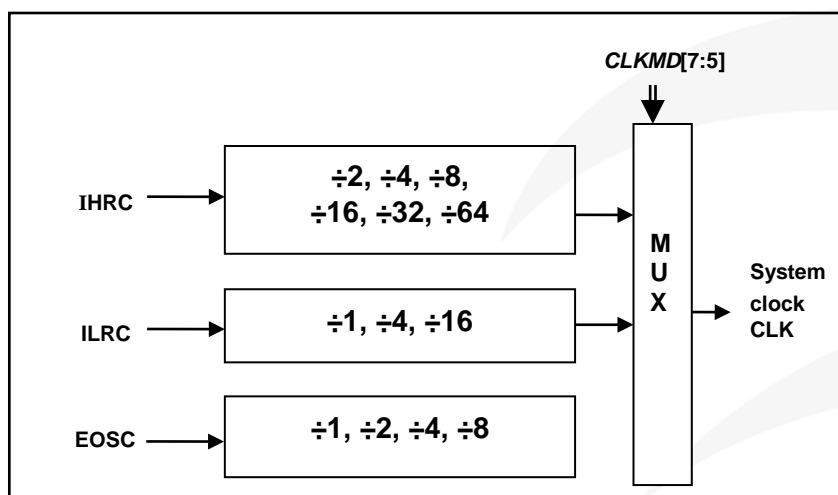


Fig. 7: Options of System Clock

## 5.3.1.1. Clock Mode Register (*CLKMD*), address = 0x03

Bit	Reset	R/W	Description
7 – 5	111	R/W	System clock selection
			Type 0, <i>CLKMD</i> [3]=0
			Type 1, <i>CLKMD</i> [3]=1
			000: IHRC/4 001: IHRC/2 010: IHRC 011: EOSC/4 100: EOSC/2 101: EOSC 110: ILRC/4 111: ILRC (default)
			000: IHRC/16 001: IHRC/8 010: ILRC/16 (ICE does NOT Support.) 011: IHRC/32 100: IHRC/64 101: EOSC/8 Others: reserved
4	1	R/W	IHRC oscillator Enable. 0 / 1: disable / enable
3	0	R/W	Clock Type Select. This bit is used to select the clock type in bit [7:5]. 0 / 1: Type 0 / Type 1
2	1	R/W	ILRC Enable. 0 / 1: disable / enable If ILRC is disabled, watchdog timer is also disabled.
1	1	R/W	Watch Dog Enable. 0 / 1: disable / enable
0	0	R/W	Pin PA5/PRSTB function. 0 / 1: PA5 / PRSTB

## 5.3.2. Frequency Calibration

The IHRC frequency and Bandgap reference voltage may be different chip by chip due to manufacturing variation, PFC232 provide the IHRC frequency calibration to eliminate this variation, and this function can be selected when compiling user's program and the command will be inserted into user's program automatically.

The calibration command is shown as below:

```
.ADJUST_IC SYSCLK=IHRC/(p1), IHRC=(p2)MHz, VDD=(p3)V
```

Where,

**p1**=2, 4, 8, 16, 32; In order to provide different system clock.

**p2**=16 ~ 18; In order to calibrate the chip to different frequency, 16MHz is the usually one.

**p3**=2.2 ~ 5.5; In order to calibrate the chip under different supply voltage.

Usually, .ADJUST\_IC will be the first command after boot up, in order to set the target operating frequency whenever starting the system. The program code for IHRC frequency calibration is executed only one time that occurs in writing the codes into MTP memory; after then, it will not be executed again.

If the different option for IHRC calibration is chosen, the system status is also different after boot. As shown in table 6:

<b>SYSCCLK</b>	<b>CLKMD</b>	<b>IHRCR</b>	<b>Description</b>
○ Set IHRC / 2	= 34h (IHRC / 2)	Calibrated	IHRC calibrated to 16MHz, CLK=8MHz (IHRC/2)
○ Set IHRC / 4	= 14h (IHRC / 4)	Calibrated	IHRC calibrated to 16MHz, CLK=4MHz (IHRC/4)
○ Set IHRC / 8	= 3Ch (IHRC / 8)	Calibrated	IHRC calibrated to 16MHz, CLK=2MHz (IHRC/8)
○ Set IHRC / 16	= 1Ch (IHRC / 16)	Calibrated	IHRC calibrated to 16MHz, CLK=1MHz (IHRC/16)
○ Set IHRC / 32	= 7Ch (IHRC / 32)	Calibrated	IHRC calibrated to 16MHz, CLK=0.5MHz (IHRC/32)
○ Set ILRC	= E4h (ILRC / 1)	Calibrated	IHRC calibrated to 16MHz, CLK=ILRC
○ Disable	No change	No Change	IHRC not calibrated, CLK not changed, Bandgap OFF

Table 6: Options for IHRC Frequency Calibration

The following shows the different states of PFC232 under different options:

**(1) .ADJUST\_IC SYSCCLK=IHRC/4, IHRC=16MHz, V<sub>DD</sub>=5V**

After boot, CLKMD = 0x14:

- a. IHRC frequency is calibrated to 16MHz@V<sub>DD</sub>=5V and IHRC module is enabled
- b. System CLK = IHRC/4 = 4MHz
- c. Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

**(2) .ADJUST\_IC SYSCCLK=IHRC/8, IHRC=16MHz, V<sub>DD</sub>=2.5V**

After boot, CLKMD = 0x3C:

- a. IHRC frequency is calibrated to 16MHz@V<sub>DD</sub>=2.5V and IHRC module is enabled
- b. System CLK = IHRC/8 = 2MHz
- c. Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

**(3) .ADJUST\_IC SYSCCLK=ILRC, IHRC=16MHz, V<sub>DD</sub>=5V**

After boot, CLKMD = 0xE4:

- a. IHRC frequency is calibrated to 16MHz@V<sub>DD</sub>=5V and IHRC module is disabled
- b. System CLK = ILRC
- c. Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

**(4) .ADJUST\_IC DISABLE**

After boot, CLKMD is not changed (Do nothing):

- a. IHRC is not calibrated.
- b. System CLK = ILRC or IHRC/64
- c. Watchdog timer is enabled, ILRC is enabled, PA5 is in input mode

### 5.3.2.1.Special Statement

- (1) The IHRC frequency calibration is performed when IC is programmed by the writer.
- (2) Because the characteristic of the Epoxy Molding Compound (EMC) would some degrees affects the IHRC frequency (either for package or COB), if the calibration is done before molding process, the actual IHRC frequency after molding may be deviated or becomes out of spec. Normally, the frequency is getting slower a bit.
- (3) It usually happens in COB package or Quick Turnover Programming (QTP). And PADAUK would not take any responsibility for this situation.
- (4) Users can make some compensatory adjustments according to their own experiences. For example, users can set IHRC frequency to be 0.5% ~ 1% higher and aim to get better re-targeting after molding.

## 5.3.3. System Clock Switching

After IHRC calibration, the system clock of PFC232 can be switched among IHRC, ILRC and EOSC by setting the *CLKMD* register at any time, **but please notice that the original clock module can NOT be turned off at the same time as writing command to *CLKMD* register**. For example, when switching from A clock source to B clock source, you should first switch the system clock source to B and then close the A clock source. The examples are shown as below and more information about clock switching, please refer to the “Help” -> “Application Note” -> “IC Introduction” -> “Register Introduction” -> *CLKMD*”.

### Case 1: Switching system clock from ILRC to IHRC/4

```
... // system clock is ILRC
CLKMD = 0x14; // switch to IHRC/4, ILRC CAN NOT be disabled here
CLKMD.2 = 0; // ILRC CAN be disabled at this time
...
```

### Case 2: Switching system clock from IHRC/4 to EOSC

```
... // system clock is IHRC/4
CLKMD = 0xB0; // switch to EOSC, IHRC CAN NOT be disabled here
CLKMD.4 = 0; // IHRC CAN be disabled at this time
...
```

### Case 3: Switching system clock from IHRC/8 to IHRC/4

```
... // system clock is IHRC/8, ILRC is enabled here
CLKMD = 0x14; // switch to IHRC/4
...
```

### Case 4: System may hang if it is to switch clock and turn off original oscillator at the same time

```
... // system clock is ILRC
CLKMD = 0x10; // CAN NOT switch clock from ILRC to IHRC/4 and turn off
// ILRC oscillator at the same time
...
```

## 6. Reset

PFC232 reset can be caused by four factors: power-on reset, LVR reset, watchdog timeout overflow reset, and PRSTB pin reset. After the reset, the system will restart. The program counter will jump to address 0x000 and most of all the registers in PFC232 will be set to the default values.

### 6.1. Power On Reset - POR

POR (Power-On-Reset) is used to reset PFC232 when power up. Time for boot-up is about 3000 ILRC clock cycles. The power up sequence is shown in the Fig. 8. Customer must ensure the stability of supply voltage after power up no matter which option is chosen.

The PFC232 data memory is in an uncertain state when the power on reset occurs.

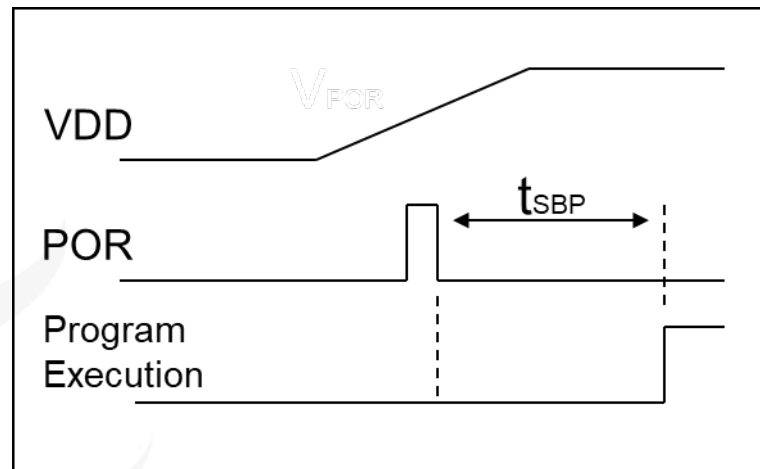


Fig. 8: Power Up Sequence

Fig. 9 shows the typical program flow after boot up. Please notice that the FPP1 is disabled after reset and recommend NOT enabling FPP1 before system and FPP0 initialization.

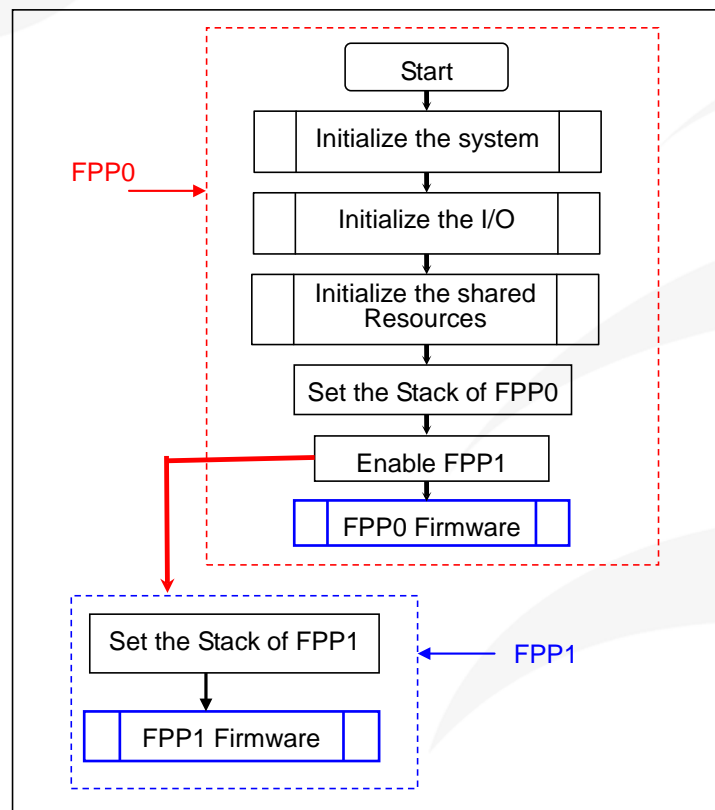


Fig. 9: Boot Procedure

## 6.2. Low Voltage Reset - LVR

If VDD drops below the Voltage level of LVR(Low Voltage Reset), LVR Reset will occur in the system. The LVR reset timing diagram is shown in figure 4.

The PFC232 data memory is in an uncertain state when the LVR reset occurs.

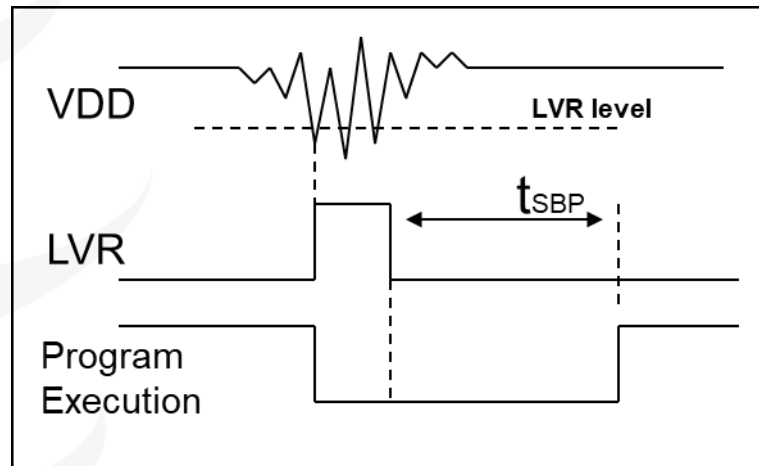


Fig. 10: Low Voltage Reset Sequence

LVR level selection is done at compile time. User must select LVR based on the system working frequency and power supply voltage to make the MCU work stably.

The following are Suggestions for setting operating frequency, power supply voltage and LVR level:

SYSCLK	VDD	LVR
8MHz	$\geq 3.75V$	3.75V
4MHz	$\geq 2.5V$	2.5V
2MHz	$\geq 2.2V$	2.2V

Table 7: LVR setting for reference

Users can set *EOSCR.0* as 1 to power off the LVR module, or *MISC.2* as 1 to disable the LVR function. At this time, it should be ensured that the VDD is above the minimum working voltage of the chip, otherwise the IC may not work properly.

External Oscillator setting Register ( <i>EOSCR</i> ), address = 0x0A			
Bit	Reset	R/W	Description
7	0	WO	Enable external crystal oscillator. 0 / 1 : Disable / Enable
6 – 5	00	WO	External crystal oscillator selection.
4 – 1	-	-	Reserved. Please keep 0 for future compatibility.
0	0	WO	Power-Down the Bandgap and LVR hardware modules. 0 / 1: normal / Power-Down.

MISC Register (MISC), address = 0x08			
Bit	Reset	R/W	Description
7 – 6	-	-	Reserved. (keep 0 for future compatibility)
5	0	WO	Enable fast Wake-up.
4	0	WO	Enable VDD/2 bias voltage generator 0 / 1 : Disable / Enable
3	-	-	Reserved. (keep 0 for future compatibility)
2	0	WO	Disable LVR function. 0 / 1 : Enable / Disable
1 – 0	00	WO	Watch dog time out period 00: 8k ILRC clock period 01: 16k ILRC clock period 10: 64k ILRC clock period 11: 256k ILRC clock period

## 6.3. Watch Dog Timeout Reset

The watchdog timer (WDT) is a counter with clock coming from ILRC, so it will be invalid if ILRC is off. The frequency of ILRC may drift a lot due to the variation of manufacture, supply voltage and temperature. User should reserve guard band for safe operation.

Besides, the watchdog period will also be shorter than expected after Reset or Wakeup events. It is suggested to clear WDT by *wdreset* command after these events to ensure enough clock periods before WDT timeout.

To ensure the watchdog is cleared before the timeout overflow, the instruction *wdreset* can be used to clear the WDT within a safe time. WDT can be cleared by power-on-reset or by command *wdreset* at any time.

When WDT is timeout, PFC232 will be reset to restart the program execution. The relative timing diagram of watchdog timer is shown as Fig. 11.

The PFC232 data memory will be reserved when the WDT reset occurs.

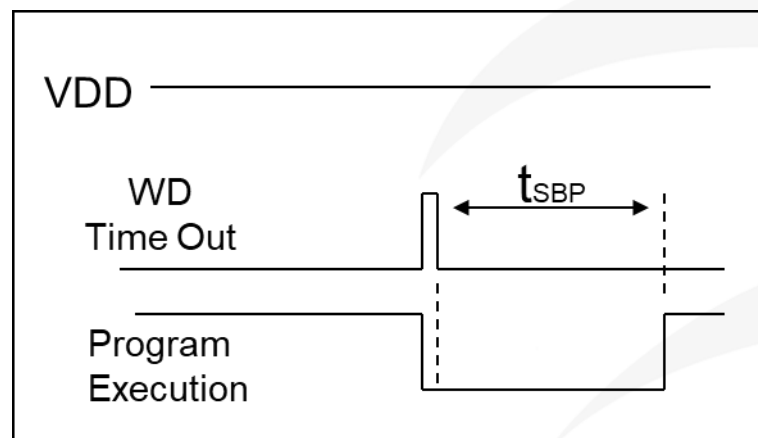


Fig. 11: Sequence of Watch Dog Timeout reset



There are four different timeout periods of watchdog timer can be chosen by setting the *MISC*[1:0]. And watchdog timer can be disabled by *CLKMD*.1.

Clock Mode Register ( <i>CLKMD</i> ), address = 0x03			
Bit	Reset	R/W	Description
7 – 5	111	R/W	System clock selection
4	1	R/W	IHRC oscillator Enable. 0 / 1: disable / enable
3	0	R/W	Clock Type Select.
2	1	R/W	ILRC Enable. 0 / 1: disable / enable If ILRC is disabled, watchdog timer is also disabled.
1	1	R/W	Watch Dog Enable. 0 / 1: disable / enable
0	0	R/W	Pin PA5/PRSTB function. 0 / 1: PA5 / PRSTB

## 6.4. External Reset Pin - PRSTB

The PFC232 supports external reset and its external reset pin shares the same IO port with PA5. Using external reset function requires:

- (1) Set PA5 as input;
- (2) Set *CLKMD*.0 = 1 to make PA5 as the external PRSTB input pin.

When the PRSTB pin is high, the system is in normal working state. Once the reset pin detects a low level, the system will be reset. The timing diagram of PRSTB reset is shown in figure 6.

The PFC232 data memory will be reserved when the PRSTB reset occurs.

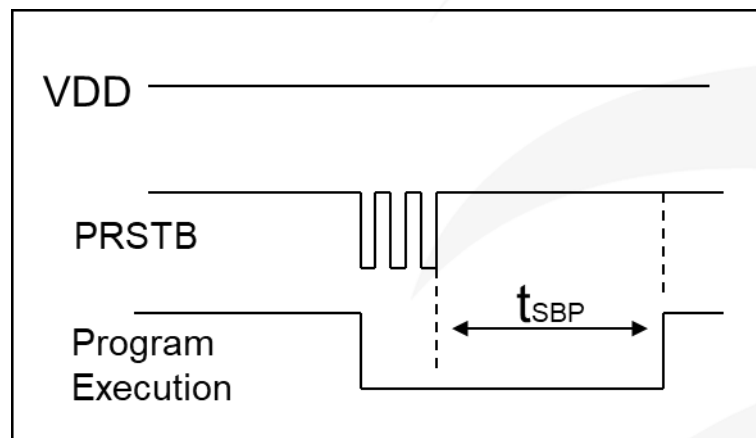


Fig. 12: Sequence of PRSTB reset

## 7. System Operating Mode

There are three operational modes defined by hardware:

- (1) ON mode
- (2) Power-Save mode
- (3) Power-Down mode

ON mode is the state of normal operation with all functions ON.

Power-Save mode (*stopexe*) is the state to reduce operating current and CPU keeps ready to continue.

Power-Down mode (*stopsys*) is used to save power deeply.

Therefore, Power-Save mode is used in the system which needs low operating power with wake-up periodically and Power-Down mode is used in the system which needs power down deeply with seldom wake-up.

### 7.1. Power-Save Mode (“*stopexe*”)

Using *stopexe* instruction to enter the Power-Save mode, only system clock is disabled, remaining all the oscillator modules be active. So only the CPU stops executing instructions. Wake-up from input pins can be considered as a continuation of normal execution.

The detail information for Power-Save mode shown below:

- (1) IHRC and oscillator modules: No change, keep active if it was enabled
- (2) ILRC oscillator modules: must remain enabled, need to start with ILRC when waking up
- (3) System clock: Disable, therefore, CPU stops execution
- (4) MTP memory is turned off.
- (5) Timer counter: Stop counting if its clock source is system clock or the corresponding oscillator module is disabled; otherwise, it keeps counting. (The Timer contains TM16, TM2, TM3, PWMG0, PWMG1, PWMG2.)
- (6) Wake-up sources:
  - a. IO toggle wake-up: IO toggling in digital input mode (*PxC* bit is 1 and *PxDIER* bit is 1)
  - b. Timer wake-up: If the clock source of Timer is not the SYSCLK, the system will be awakened when the Timer counter reaches the set value.
  - c. Comparator wake-up: It need setting *GPCC.7*=1 and *GPCS.6*=1 to enable the comparator wake-up function at the same time.

An example shows how to use Timer16 to wake-up from “*stopexe*”:

```
$ T16M  ILRC, /1, BIT8           // Timer16 setting
...
WORD   count   =    0;
STT16  count;
stopexe;
...
```

The initial counting value of Timer16 is zero and the system will be woken up after the Timer16 counts 256 ILRC clocks.

## 7.2. Power-Down Mode (“*stopsys*”)

Power-Down mode is the state of deeply power-saving with turning off all the oscillator modules. By using the *stopsys* instruction, this chip will be put on Power-Down mode directly. It is recommend to set *GPCC.7*=0 to disable the comparator before the command *stopsys*.

Wake-up from input pins can be considered as a continuation of normal execution. To minimize power consumption, all the I/O pins should be carefully manipulated before entering Power-Down mode.

The following shows the internal status of PFC232 in detail when *stopsys* command is issued:

- (1) All the oscillator modules are turned off
- (2) MTP memory is turned off
- (3) The contents of SRAM and registers remain unchanged
- (4) Wake-up sources: IO toggle in digital mode (*PxDIER* bit is 1)

The reference sample program for power down mode is shown as below:

```

CMKMD  =  0xF4;           //  Change clock from IHRC to ILRC, disable watchdog timer
CLKMD.4 =  0;             //  disable IHRC
...
while (1)
{
    STOPSYS;                //  enter Power-Down mode
    if (...) break;         //  if wake-up happen and check OK, then return to high speed,
                                //  else stay in Power-Down mode again.
}
CLKMD   =  0x14;          //  Change clock from ILRC to IHRC/4

```

## 7.3. Wake-Up

After entering the Power-Down or Power-Save modes, the PFC232 can be resumed to normal operation by toggling IO pins. Wake-up from timer are available for Power-Save mode ONLY. Table 8 shows the differences in wake-up sources between *stopsys* and *stopexe*.

Differences in wake-up sources between <i>stopsys</i> and <i>stopexe</i>		
	IO Toggle	Timer wake-up
<i>stopsys</i>	Yes	No
<i>stopexe</i>	Yes	Yes

Table 8: Differences in wake-up sources between Power-Save mode and Power-Down mode

When using the IO pins to wake-up the PFC232, registers *PxDIER* should be properly set to enable the wake-up function for every corresponding pin. The time for normal wake-up is about 3000 ILRC clocks counting from wake-up event; fast wake-up can be selected to reduce the wake-up time by *MISC* register, and the time for fast wake-up is about 45 ILRC clocks from IO toggling.

Suspend mode	Wake-up mode	Wake-up time ( $t_{WUP}$ ) from IO toggle
<i>stopexe</i> suspend or <i>stopsys</i> suspend	Fast wake-up	$45 * T_{ILRC}$ , Where $T_{ILRC}$ is the time period of ILRC
<i>stopexe</i> suspend or <i>stopsys</i> suspend	Normal wake-up	$3000 * T_{ILRC}$ , Where $T_{ILRC}$ is the clock period of ILRC

## 8. Interrupt

There are eight interrupt lines for PFC232:

- ◆ External interrupt PA0/PB5
- ◆ External interrupt PB0/PA4
- ◆ ADC interrupt
- ◆ GPC interrupt
- ◆ Timer16 interrupt
- ◆ Timer2 interrupt
- ◆ Timer3 interrupt
- ◆ PWMG0 interrupt

Every interrupt request line to CPU has its own corresponding interrupt control bit to enable or disable it. The hardware diagram of interrupt controller is shown as Fig. 13. All the interrupt request flags are set by hardware and cleared by writing *INTRQ* register. When the request flags are set, it can be rising edge, falling edge or both, depending on the setting of register *INTEGS*. All the interrupt request lines are also controlled by *engint* instruction (enable global interrupt) to enable interrupt operation and *disgint* instruction (disable global interrupt) to disable it.

The stack memory for interrupt is shared with data memory and its address is specified by stack register *SP*. Since the program counter is 16 bits width, the bit 0 of stack register *SP* should be kept 0. Moreover, user can use *pushaf / popaf* instructions to store or restore the values of *ACC* and *flag* register *to / from* stack memory. Since the stack memory is shared with data memory, the stack position and level are arranged by the compiler in Mini-C project. When defining the stack level in ASM project, users should arrange their locations carefully to prevent address conflicts.

During the interrupt service routine, the interrupt source can be determined by reading the *INTRQ* register.

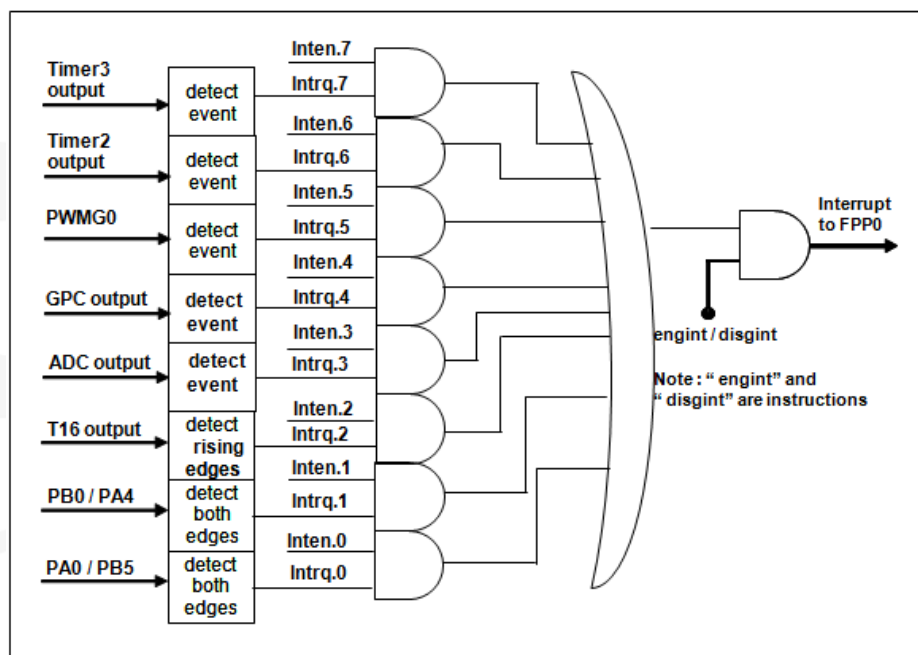


Fig. 13: Hardware diagram of Interrupt controller

## 8.1. Interrupt Enable Register (*INTEN*), address = 0x04

Bit	Reset	R/W	Description
7	0	R/W	Enable interrupt from Timer3. 0 / 1: disable / enable.
6	0	R/W	Enable interrupt from Timer2. 0 / 1: disable / enable.
5	0	R/W	Enable interrupt from PWMG0. 0 / 1: disable / enable.
4	0	R/W	Enable interrupt from comparator. 0 / 1: disable / enable.
3	0	R/W	Enable interrupt from ADC. 0 / 1: disable / enable.
2	0	R/W	Enable interrupt from Timer16 overflow. 0 / 1: disable / enable.
1	0	R/W	Enable interrupt from PB0/PA4. 0 / 1: disable / enable. (by code option Interrupt Src1)
0	0	R/W	Enable interrupt from PA0/PB5. 0 / 1: disable / enable. (by code option Interrupt Src0)

## 8.2. Interrupt Request Register (*INTRQ*), address = 0x05

Bit	Reset	R/W	Description
7	-	R/W	Interrupt Request from Timer3, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
6	-	R/W	Interrupt Request from Timer2, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
5	-	R/W	Interrupt Request from PWMG0, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
4	-	R/W	Interrupt Request from comparator, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
3	-	R/W	Interrupt Request from ADC, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
2	-	R/W	Interrupt Request from Timer16, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
1	-	R/W	Interrupt Request from pin PB0/PA4, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
0	-	R/W	Interrupt Request from pin PA0/PB5, this bit is set by hardware and cleared by software. 0 / 1: No Request / request

## 8.3. Interrupt Edge Select Register (*INTEGS*), address = 0x0C

Bit	Reset	R/W	Description
7 - 5	-	-	Reserved.
4	0	WO	Timer16 edge selection. 0 : rising edge of the selected bit to trigger interrupt 1 : falling edge of the selected bit to trigger interrupt
3 - 2	00	WO	PB0/PA4 edge selection. 00 : both rising edge and falling edge of the selected bit to trigger interrupt 01 : rising edge of the selected bit to trigger interrupt 10 : falling edge of the selected bit to trigger interrupt 11 : reserved.
1 - 0	00	WO	PA0/PB5 edge selection. 00 : both rising edge and falling edge of the selected bit to trigger interrupt 01 : rising edge of the selected bit to trigger interrupt 10 : falling edge of the selected bit to trigger interrupt 11 : reserved.

### Note:

- (1) *INTEN* and *INTRQ* have no initial values. Please set required value before enabling interrupt function. Even if *INTEN*=0, *INTRQ* will be still triggered by the interrupt source.
- (2) PA4 and PB5 can be used as external interrupt pins. When using the PA4 as external interrupt pin, the setting method of *INTEN* / *INTRQ* / *INTEGS* registers are same as that of PB0, the only difference is to choose PB0 or PA4 as source of interrupt\_Src1 in CODE\_OPTION. Similarly, when using the PB5 as external interrupt pin, the setting method of *INTEN* / *INTRQ* / *INTEGS* registers are same as that of PA0, the only difference is to choose PA0 or PB5 as source of interrupt\_Src0 in CODE\_OPTION.

## 8.4. Interrupt Work Flow

Once the interrupt occurs, its operation will be:

- (1) The program counter will be stored automatically to the stack memory specified by register *SP*.
- (2) New *SP* will be updated to *SP*+2.
- (3) Global interrupt will be disabled automatically.
- (4) The next instruction will be fetched from address 0x010.

After finishing the interrupt service routine and issuing the *reti* instruction to return back, its operation will be:

- (1) The program counter will be restored automatically from the stack memory specified by register *SP*.
- (2) New *SP* will be updated to *SP*-2.
- (3) Global interrupt will be enabled automatically.
- (4) The next instruction will be the original one before interrupt.

## 8.5. General Steps to Interrupt

When using the interrupt function, the procedure should be:

- Step1: Set *INTEN* register, enable the interrupt control bit.
- Step2: Clear *INTRQ* register.
- Step3: In the main program, using *engint* to enable CPU interrupt function.
- Step4: Wait for interrupt. When interrupt occurs, enter to Interrupt Service Routine.
- Step5: After the Interrupt Service Routine being executed, return to the main program.

When interrupt service routine starts, use *pushaf* instruction to save *ALU* and *FLAG* register. *Popaf* instruction is to restore *ALU* and *FLAG* register before *reti* as below:

```
void Interrupt (void)    // Once the interrupt occurs, jump to interrupt service routine
{                          // enter disgint status automatically, no more interrupt is accepted
    PUSHAF;
    ...
    POPAF;
}    // reti will be added automatically. After reti being executed, engint status will be restored
```

\* Use *disgint* in the main program can disable all interrupts.

## 8.6. Example for Using Interrupt

User must reserve enough stack memory for interrupt, two bytes stack memory for one level interrupt and four bytes for two levels interrupt.

For interrupt operation, the following sample program shows how to handle the interrupt, noticing that it needs four bytes stack memory to handle interrupt and *pushaf*.

```

void      FPPA0  (void)
{
    ...
    $ INTEN PA0;      // INTEN =1; interrupt request when PA0 level changed
    INTRQ = 0;         // clear INTRQ
    ENGINT              // global interrupt enable
    ...
    DISGINT            // global interrupt disable
    ...
}

void Interrupt (void)      // interrupt service routine
{
    PUSHAf              // store ALU and FLAG register

    // If INTEN.PA0 will be opened and closed dynamically,
    // user can judge whether INTEN.PA0 =1 or not.
    // Example: If (INTEN.PA0 && INTRQ.PA0) {...}

    // If INTEN.PA0 is always enable,
    // user can omit the INTEN.PA0 judgement to speed up interrupt service routine.

    If (INTRQ.PA0)
    {
        // Here for PA0 interrupt service routine
        INTRQ.PA0 = 0; // Delete corresponding bit (take PA0 for example)
        ...
    }
    ...
    // (X:) INTRQ = 0; // It is not recommended to use INTRQ = 0 to clear all at the end of the
                        // interrupt service routine.
                        // It may accidentally clear out the interrupts that have just occurred
                        // and are not yet processed.

    POPAf              // restore ALU and FLAG register
}

```



## 9. I/O Port

### 9.1. IO Related Registers

#### 9.1.1. Port A Digital Input Enable Register (*PADIER*), address = 0x0D

Bit	Reset	R/W	Description
7 - 6	11	WO	Enable PA7~PA6 digital input and wake-up event. 1 / 0 : enable / disable. These bits should be set to low to prevent leakage current when external crystal oscillator is used.
5	1	WO	Enable PA5 digital input and wake-up event. 1 / 0 : enable / disable.
4	1	WO	Enable PA4 digital input and wake-up event and interrupt request. 1 / 0 : enable / disable.
3	1	WO	Enable PA3 digital input and wake-up event. 1 / 0 : enable / disable.
2 - 1	1	WO	Reserved.
0	1	WO	Enable PA0 digital input and wake-up event and interrupt request. 1 / 0: enable / disable.

#### 9.1.2. Port B Digital Input Enable Register (*PBDIER*), address = 0x0E

Bit	Reset	R/W	Description
7 - 6	11	WO	Enable PB7~PB6 digital input and wake up event. 1 / 0: enable / disable.
5	1	WO	Enable PB5 digital input and wake-up event and interrupt request. 1 / 0: enable / disable.
4 - 1	1111	WO	Enable PB4~PB1 digital input and wake up event. 1 / 0: enable / disable.
0	1	WO	Enable PB0 digital input and wake-up event and interrupt request. 1 / 0: enable / disable.

#### 9.1.3. Port A Data Registers (*PA*), address = 0x10

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Data registers for Port A.

#### 9.1.4. Port A Control Registers (*PAC*), address = 0x11

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Port A control registers. This register is used to define input mode or output mode for each corresponding pin of port A. 0 / 1: input / output.

## 9.1.5. Port A Pull-High Registers (*PAPH*), address = 0x12

Bit	Reset	R/W	Description
7 – 3	00000	R/W	Port PA7 ~ PA3 pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port A. 0 / 1 : disable / enable
2 – 1	-	-	Reserved. Please keep 0 for future compatibility.
0	0	R/W	Port PA0 pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port A. 0 / 1 : disable / enable

## 9.1.6. Port A Pull-Low Register (*PAPL*), address = 0x13

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Port A pull-low register. This register is used to enable the internal pull-low device on each corresponding pin of port A and this pull low function is active only for input mode. 0 / 1 : disable / enable

## 9.1.7. Port B Data Registers (*PB*), address = 0x14

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Data registers for Port B.

## 9.1.8. Port B Control Registers (*PBC*), address = 0x15

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Port B control registers. This register is used to define input mode or output mode for each corresponding pin of port B. 0 / 1: input / output.

## 9.1.9. Port B Pull-High Registers (*PBPH*), address = 0x16

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Port B pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port B. 0 / 1 : disable / enable

## 9.1.10. Port B Pull-Low Register (*PBPL*), address = 0x17

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Port B pull-low register. This register is used to enable the internal pull-low device on each corresponding pin of port B and this pull low function is active only for input mode. 0 / 1 : disable / enable

## 9.2. IO Structure and Functions

### 9.2.1. IO Pin Structure

All the IO pins of PFC232 have the same structure. The hardware diagram of IO buffer is shown as Fig. 14.

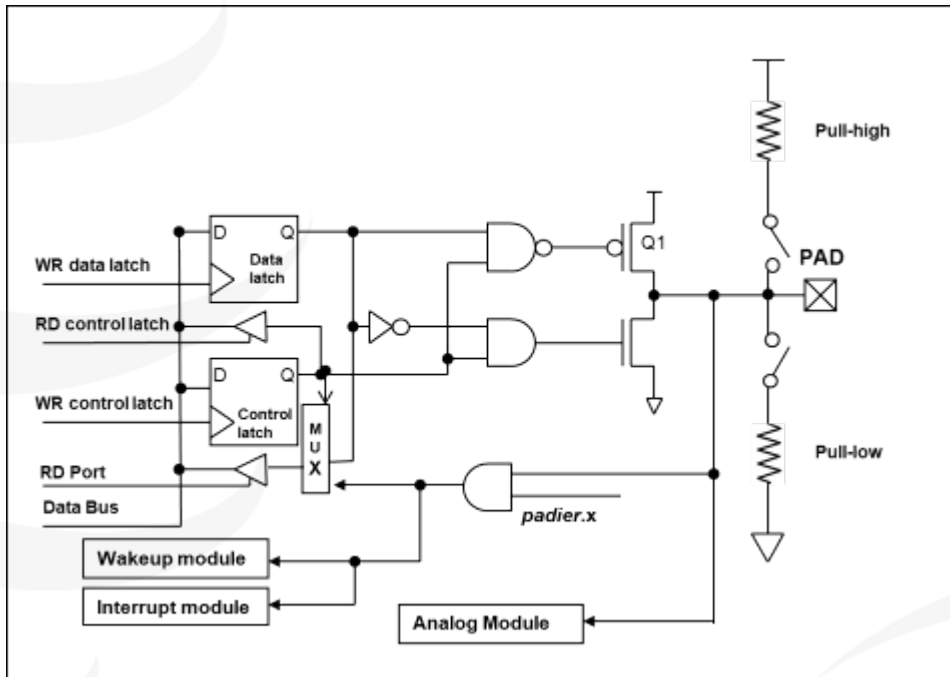


Fig. 14: Hardware diagram of IO buffer

### 9.2.2. IO Pin Functions

#### (1) Input / output function:

PFC232 all the pins can be independently set into digital input, analog input, output low, output high.

Each IO pin can be independently configured for different state by configuring the data registers (*PA/PB*), control registers (*PAC/PBC*), pull-high registers (*PAPH/PBPH*) and pull-low registers (*PAPL/PBPL*).

The corresponding bits in registers *PxDIER* should be set to low to prevent leakage current for those pins are selected to be analog function. When it is set to output mode, the pull-high / pull-low resistor is turned off automatically.

If user wants to read the pin state, please notice that it should be set to input mode before reading the data port. If user reads the data port when it is set to output mode, the reading data comes from data register, NOT from IO pad.

As an example, Table 9 shows the configuration table of bit 0 of port A.

<i>PA.0</i>	<i>PAC.0</i>	<i>PAPH.0</i>	<i>PAPL.0</i>	Description
X	0	0	0	Input without pull-high / pull-low resistor
X	0	1	0	Input with pull-high resistor
X	0	0	1	Input with pull-low resistor
X	0	1	1	Input with pull-low / pull-high resistor
0	1	X	X	Output low without pull-high / pull-low resistor
1	1	X	X	Output high without pull-high / pull-low resistor

Table 9: PA0 Configuration Table

## (2)Wake-up function:

When PFC232 put in Power-Down or Power-Save mode, every IO pin can be used to wake-up system by toggling its state. Therefore, those pins needed to wake-up system must be set to input mode and set the corresponding bits of registers *PxDIER* to high.

## (3)External interrupt function:

When the IO acts as an external interrupt pin, the corresponding bit of *PxDIER* should be set to high. For example, *PADIER.0* should be set to high when PA0 is used as external interrupt pin.

## (4)Drive capability optional:

PB4 and PB7 can adjust their drive and sink current by code option PB4\_PB7\_Drive.

## 9.2.3. IO Pin Usage and Setting

### (1) IO pin as digital input

- ◆ When IO is set as digital input, the level of  $V_{ih}$  and  $V_{il}$  would changes with the voltage and temperature. Please follow the minimum value of  $V_{ih}$  and the maximum value of  $V_{il}$ .
- ◆ The value of internal pull high resistor would also changes with the voltage, temperature and pin voltage. It is not the fixed value.

### (2) If IO pin is set to be digital input and enable wake-up function

- ◆ Configure IO pin as input mode by *PxC* register.
- ◆ Set corresponding bit to "1" in *PxDIER*.
- ◆ For those IO pins of PA that are not used, *PADIER*[1:2] should be set low in order to prevent them from leakage.

### (3) PA5 is set to be output pin

- ◆ PA5 can be set to be Open Drain output pin only, output high requires adding pull-up resistor.

### (4) PA5 is set to be PRSTB input pin.

- ◆ Configure PA5 as input.
- ◆ Set *CLKMD.0*=1 to enable PA5 as PRSTB input pin.

### (5) PA5 is set to be input pin and to connect with a push button or a switch by a long wire

- ◆ Needs to put a  $>10\Omega$  resistor in between PA5 and the long wire.
- ◆ Avoid using PA5 as input in such application.

## 10. Timer / PWM Counter

### 10.1. 16-bit Timer (Timer16)

#### 10.1.1. Timer16 Introduction

PFC232 provide a 16-bit hardware timer (Timer16/T16) and its block diagram is shown in Fig. 15.

The clock source of timer16 is selected by register *T16M*[7:5]. Before sending clock to the 16-bit counter (counter16), a pre-scaling logic with divided-by-1, 4, 16 or 64 is selected by *T16M*[4:3] for wide range counting.

*T16M*[2:0] is used to select the interrupt request. The interrupt request from Timer16 will be triggered by the selected bit which comes from bit[15:8] of this 16-bit counter. Rising edge or falling edge can be optional chosen by register *INTEGS.4*.

The 16-bit counter performs up-counting operation only, the counter initial values can be stored from data memory by issuing the *stt16* instruction and the counting values can be loaded to data memory by issuing the *ldt16* instruction.

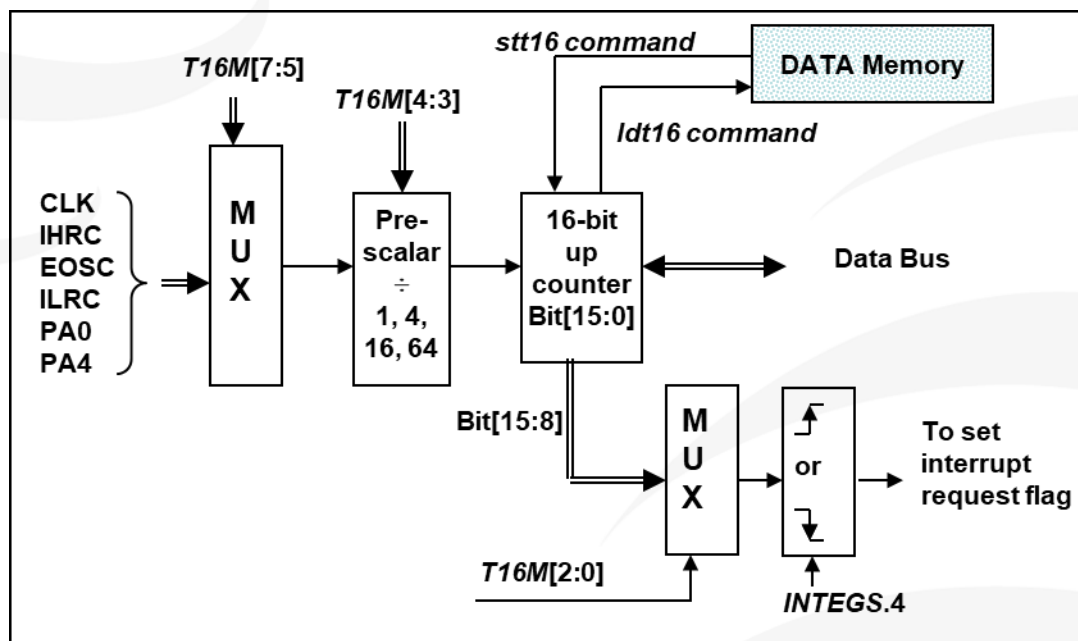


Fig. 15: Hardware diagram of Timer16

There are three parameters to define the Timer16 using; 1<sup>st</sup> parameter is used to define the clock source of Timer16, 2<sup>nd</sup> parameter is used to define the pre-scaler and the 3<sup>rd</sup> one is to define the interrupt source.

<b><i>T16M</i></b>	<b><i>IO_RW</i></b>	<b><i>0x06</i></b>	
<b>\$ 7~5:</b>	<b><i>STOP, SYSCLK, X, PA4_F, IHRC, EOSC, ILRC, PA0_F</i></b>		// 1 <sup>st</sup> par.
<b>\$ 4~3:</b>	<b><i>/1, /4, /16, /64</i></b>		// 2 <sup>nd</sup> par.
<b>\$ 2~0:</b>	<b><i>BIT8, BIT9, BIT10, BIT11, BIT12, BIT13, BIT14, BIT15</i></b>		// 3 <sup>rd</sup> par.

User can choose the proper parameters of *T16M* to meet system requirement, examples as below:

```
$ T16M SYCLK, /64, BIT15;
// choose (SYCLK/64) as clock source, every 2^16 clock to set INTRQ.2=1
// if system clock SYCLK = IHRC / 4 = 4 MHz
// SYCLK/64 = 4 MHz/64 = 16 uS, about every 1 S to generate INTRQ.2=1

$ T16M PA0, /1, BIT8;
// choose PA0 as clock source, every 2^9 to generate INTRQ.2=1
// receiving every 512 times PA0 to generate INTRQ.2=1

$ T16M STOP;
// stop Timer16 counting
```

If Timer16 is operated at free running, the frequency of interrupt can be described as below:

$$F_{INTRQ\_T16M} = F_{\text{clock source}} \div P \div 2^{n+1}$$

Where, F is the frequency of selected clock source to Timer16;

P is the selection of *T16M* [4:3]; (1, 4, 16, 64)

N is the  $n^{\text{th}}$  bit selected to request interrupt service, for example: n=10 if bit 10 is selected.

## 10.1.2. Timer16 Time Out

When select \$ *INTEGS BIT\_R* (default value) and *T16M* counter BIT8 to generate interrupt, if *T16M* counts from 0, the first interrupt will occur when the counter reaches to 0x100 (BIT8 from 0 to 1) and the second interrupt will occur when the counter reaches 0x300 (BIT8 from 0 to 1). Therefore, selecting BIT8 as 1 to generate interrupt means that the interrupt occurs every 512 counts. Please notice that if *T16M* counter is restarted, the next interrupt will occur once Bit8 turns from 0 to 1.

If select \$ *INTEGS BIT\_F* (BIT triggers from 1 to 0) and *T16M* counter BIT8 to generate interrupt, the *T16M* counter changes to an interrupt every 0x200/0x400/0x600/. Please pay attention to two differences with setting *INTEGS* methods.

### 10.1.3. Timer16 Mode Register (*T16M*), address = 0x06

Bit	Reset	R/W	Description
7 – 5	000	R/W	Timer Clock source selection: 000: Timer 16 is disabled 001: CLK (system clock) 010: reserved 011: PA4 falling edge (from external pin) 100: IHRC 101: EOSC 110: ILRC 111: PA0 falling edge (from external pin)
4 – 3	00	R/W	Internal clock divider. 00: /1 01: /4 10: /16 11: /64
2 – 0	000	R/W	Interrupt source selection. Interrupt event happens when selected bit is changed. 0 : bit 8 of Timer16 1 : bit 9 of Timer16 2 : bit 10 of Timer16 3 : bit 11 of Timer16 4 : bit 12 of Timer16 5 : bit 13 of Timer16 6 : bit 14 of Timer16 7 : bit 15 of Timer16

## 10.2. 8-bit Timer with PWM Generation (Timer2, Timer3)

Two 8-bit hardware timers (Timer2/TM2, Timer3/TM3) with PWM generation are implemented in the PFC232. Timer2 is used as the example to describe its function due to these two 8-bit timers are the same. Fig. 16 shows the Timer2 hardware diagram.

Bit[7:4] of register *TM2C* are used to select the clock source of Timer2. And the output of Timer2 is selected by *TM2C*[3:2]. The clock frequency divide module is controlled by bit [6:5] of *TM2S* register. *TM2B* register controls the upper bound of 8-bit counter. It will be clear to zero automatically when the counter values reach for upper bound register. The counter values can be set or read back by *TM2CT* register.

There are two operating modes for Timer2: period mode and PWM mode. Period mode is used to generate periodical output waveform or interrupt event, and PWM mode is used to generate PWM output waveform with optional 6-bit ~ 8-bit PWM resolution.

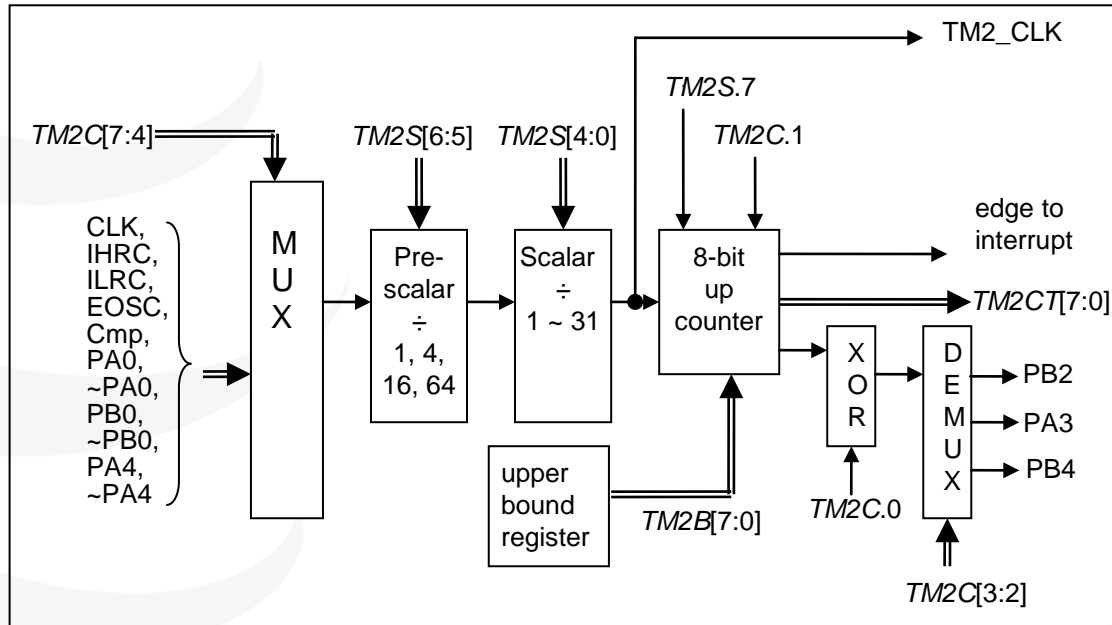


Fig. 16: Timer2 hardware diagram

The output of Timer3 can be sent to pin PB5, PB6 or PB7.

Fig. 17 shows the timing diagram of Timer2 for both period mode and PWM mode.

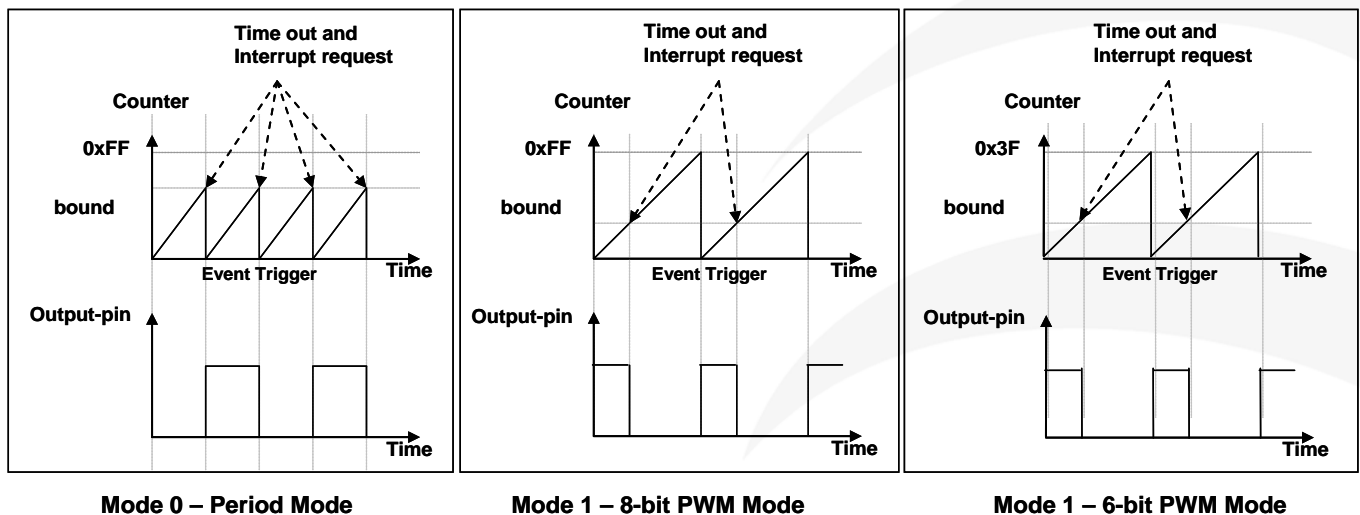


Fig. 17: Timing diagram of Timer2 in period mode and PWM mode ( $TM2C.1=1$ )

Code Options GPC\_PWM and OPA\_PWM are for the applications which need the generated PWM waveform to be controlled by the comparator result. If the Code Option GPC\_PWM or OPA\_PWM is selected, the PWM output stops while the comparator output is 1 and then the PWM output turns on while the comparator output goes back to 0, as shown in Fig. 18.



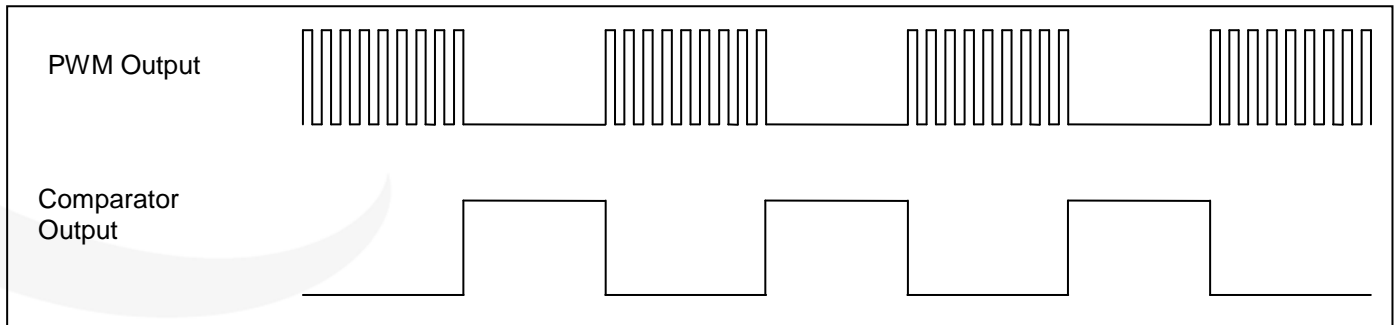


Fig.18: Comparator controls the output of PWM waveform

## 10.2.1. Timer2、Timer3 Related Registers

### 10.2.1.1. Timer2 Bound Register (*TM2B*), address = 0x09

Bit	Reset	R/W	Description
7 – 0	0x00	WO	Timer2 bound register.

### 10.2.1.2. Timer2 Counter Register (*TM2CT*), address = 0x1D

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Bit [7:0] of Timer2 counter register.

### 10.2.1.3. Timer2 Scalar Register (*TM2S*), address = 0x1E

Bit	Reset	R/W	Description
7	0	WO	PWM resolution selection. 0 : 8-bit 1 : 6-bit or 7-bit (by code option TMx_bit)
6 – 5	00	WO	Timer2 clock pre-scalar. 00 : ÷ 1 01 : ÷ 4 10 : ÷ 16 11 : ÷ 64
4 – 0	00000	WO	Timer2 clock scalar.

## 10.2.1.4. Timer2 Control Register (*TM2C*), address = 0x1C

Bit	Reset	R/W	Description
7 – 4	0000	R/W	Timer2 clock selection. 0000 : disable 0001 : CLK 0010 : IHRC or IHRC *2 (by code option TMx_source) 0011 : EOSC 0100 : ILRC 0101 : comparator output 0110 : OPA (Comparator mode) compare output 1000 : PA0 (rising edge) 1001 : ~PA0 (falling edge) 1010 : PB0 (rising edge) 1011 : ~PB0 (falling edge) 1100 : PA4 (rising edge) 1101 : ~PA4 (falling edge) Others: reserved <b>Notice:</b> In ICE mode and IHRC is selected for Timer2 clock, the clock sent to Timer2 does NOT be stopped, Timer2 will keep counting when ICE is in halt state.
3 – 2	00	R/W	Timer2 output selection. 00 : disable 01 : PB2 10 : PA3 11 : PB4
1	0	R/W	Timer2 mode selection. 0 / 1 : period mode / PWM mode
0	0	R/W	Enable to inverse the polarity of Timer2 output. 0 / 1: disable / enable

## 10.2.1.5. Timer3 Counter Register (*TM3CT*), address = 0x33

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Bit [7:0] of Timer3 counter register.

## 10.2.1.6. Timer3 Scalar Register (*TM3S*), address = 0x34

Bit	Reset	R/W	Description
7	0	WO	PWM resolution selection. 0 : 8-bit 1 : 6-bit or 7-bit (by code option TMx_bit)
6 – 5	00	WO	Timer3 clock pre-scalar. 00 : ÷ 1 01 : ÷ 4 10 : ÷ 16 11 : ÷ 64
4 – 0	00000	WO	Timer3 clock scalar.

## 10.2.1.7. Timer3 Bound Register (*TM3B*), address = 0x38

Bit	Reset	R/W	Description
7 – 0	0x00	WO	Timer3 bound register.

## 10.2.1.8. Timer3 Control Register (*TM3C*), address = 0x32

Bit	Reset	R/W	Description
7 – 4	0000	R/W	Timer3 clock selection. 0000 : disable 0001 : CLK 0010 : IHRC or IHRC *2 (by code option TMx_source) 0011 : EOSC 0100 : ILRC 0101 : comparator output 0110 : OPA (Comparator mode) compare output 1000 : PA0 (rising edge) 1001 : ~PA0 (falling edge) 1010 : PB0 (rising edge) 1011 : ~PB0 (falling edge) 1100 : PA4 (rising edge) 1101 : ~PA4 (falling edge) Others: reserved <b>Notice:</b> In ICE mode and IHRC is selected for Timer3 clock, the clock sent to Timer3 does NOT be stopped, Timer3 will keep counting when ICE is in halt state.
3 – 2	00	R/W	Timer3 output selection. 00 : disable 01 : PB5 10 : PB6 11 : PB7
1	0	R/W	Timer3 mode selection. 0 / 1 : period mode / PWM mode
0	0	R/W	Enable to inverse the polarity of Timer3 output. 0 / 1: disable / enable

## 10.2.2. Using the Timer2 to Generate Periodical Waveform

If periodical mode is selected, the duty cycle of output is always 50%. Its frequency can be summarized as below:

$$\text{Frequency of Output} = Y \div [2 \times (K+1) \times S1 \times (S2+1)]$$

Where,

$Y = TM2C[7:4]$  : frequency of selected clock source

$K = TM2B[7:0]$  : bound register in decimal

$S1 = TM2S[6:5]$  : pre-scalar ( $S1 = 1, 4, 16, 64$ )

$S2 = TM2S[4:0]$  : scalar register in decimal ( $S2 = 0 \sim 31$ )

Example 1:

$TM2C = 0b0001\_1100$ ,  $Y=4\text{MHz}$

$TM2B = 0b0111\_1111$ ,  $K=127$

$TM2S = 0b0\_00\_00000$ ,  $S1=1$ ,  $S2=0$

frequency of output =  $4\text{MHz} \div [2 \times (127+1) \times 1 \times (0+1)] = 15.625\text{KHz}$

Example 2:

$TM2C = 0b0001\_1000$ ,  $Y=4\text{MHz}$

$TM2B = 0b0000\_0001$ ,  $K=1$

$TM2S = 0b0\_00\_00000$ ,  $S1=1$ ,  $S2=0$

frequency =  $4\text{MHz} \div [2 \times (1+1) \times 1 \times (0+1)] = 1\text{MHz}$

The sample program for using the Timer2 to generate periodical waveform to PA3 is shown as below:

```
void FPPA0 (void)
{
    . ADJUST_IC    SYSCLK=IHRC/4, IHRC=16MHz, VDD=5V
    ...
    TM2CT = 0x00;
    TM2B = 0x7f;
    TM2S = 0b0_00_00001;           // 8-bit PWM, pre-scalar = 1, scalar = 2
    TM2C = 0b0001_10_0_0;         // system clock, output=PA3, period mode
    while(1)
    {
        nop;
    }
}
```

## 10.2.3. Using the Timer2 to Generate 8-bit PWM Waveform

If 8-bit PWM mode is selected, it should set  $TM2C[1]=1$  and  $TM2S[7]=0$ , the frequency and duty cycle of output waveform can be summarized as below:

$$\text{Frequency of Output} = Y \div [256 \times S1 \times (S2+1)]$$

$$\text{Duty of Output} = [(K+1) \div 256] \times 100\%$$

Where,

$Y = TM2C[7:4]$  : frequency of selected clock source

$K = TM2B[7:0]$  : bound register in decimal

$S1 = TM2S[6:5]$  : pre-scalar ( $S1 = 1, 4, 16, 64$ )

$S2 = TM2S[4:0]$  : scalar register in decimal ( $S2 = 0 \sim 31$ )

### Example 1:

$TM2C = 0b0001\_1010$ ,  $Y=4\text{MHz}$

$TM2B = 0b0111\_1111$ ,  $K=127$

$TM2S = 0b0\_00\_00000$ ,  $S1=1$ ,  $S2=0$

frequency of output =  $4\text{MHz} \div (256 \times 1 \times (0+1)) = 15.625\text{KHz}$

duty of output =  $[(127+1) \div 256] \times 100\% = 50\%$

### Example 2:

$TM2C = 0b0001\_1010$ ,  $Y=4\text{MHz}$

$TM2B = 0b0000\_1001$ ,  $K = 9$

$TM2S = 0b0\_00\_00000$ ,  $S1=1$ ,  $S2=0$

frequency of output =  $4\text{MHz} \div (256 \times 1 \times (0+1)) = 15.625\text{KHz}$

duty of output =  $[(9+1) \div 256] \times 100\% = 3.9\%$

The sample program for using the Timer2 to generate PWM waveform from PA3 is shown as below:

```
void    FPPA0 (void)
{
    .ADJUST_IC    SYSCLK=IHRC/4, IHRC=16MHz, VDD=5V
    wdreset;
    TM2CT = 0x00;
    TM2B = 0x7f;
    TM2S = 0b0_00_00001;    //    8-bit PWM, pre-scalar = 1, scalar = 2
    TM2C = 0b0001_10_1_0;    //    system clock, output=PA3, PWM mode
    while(1)
    {
        nop;
    }
}
```

## 10.2.4. Using the Timer2 to Generate 6-bit PWM Waveform

If 6-bit PWM mode is selected, it should set  $TM2C[1]=1$  and  $TM2S[7]=1$ , the frequency and duty cycle of output waveform can be summarized as below:

$$\text{Frequency of Output} = Y \div [64 \times S1 \times (S2+1)]$$

$$\text{Duty of Output} = [(K+1) \div 64] \times 100\%$$

Where,

$TM2C[7:4] = Y$  : frequency of selected clock source

$TM2B[7:0] = K$  : bound register in decimal

$TM2S[6:5] = S1$  : pre-scalar ( $S1 = 1, 4, 16, 64$ )

$TM2S[4:0] = S2$  : scalar register in decimal ( $S2 = 0 \sim 31$ )

### Example 1:

$TM2C = 0b0001\_1010$ ,  $Y=4\text{MHz}$

$TM2B = 0b0011\_1111$ ,  $K=63$

$TM2S = 0b1\_00\_00000$ ,  $S1=1$ ,  $S2=0$

frequency of output =  $4\text{MHz} \div (64 \times 1 \times (0+1)) = 62.5\text{KHz}$

duty of output =  $[(63+1) \div 64] \times 100\% = 100\%$

### Example 2:

$TM2C = 0b0001\_1010$ ,  $Y=4\text{MHz}$

$TM2B = 0b0000\_0000$ ,  $K=0$

$TM2S = 0b1\_00\_00000$ ,  $S1=1$ ,  $S2=0$

Frequency =  $4\text{MHz} \div (64 \times 1 \times (0+1)) = 62.5\text{KHz}$

Duty =  $[(0+1) \div 64] \times 100\% = 1.5\%$

## 10.3. 11-bit PWM Generation

Three 11-bit hardware PWM generators (PWMG0, PWMG1 & PWMG2) are implemented in the PFC232. PWMG0 is used as the example to describe its functions due to all of them are almost the same. Their individual outputs are listed as below:

- (1) PWMG0 – PA0, PB4, PB5
- (2) PWMG1 – PA4, PB6, PB7
- (3) PWMG2 – PA3, PB2, PB3, PA5 (Only PA5 ICE does not support)

### 10.3.1. PWM Waveform

A PWM output waveform (Fig. 19) has a time-base ( $T_{\text{Period}} = \text{Time of Period}$ ) and a time with output high level (Duty Cycle). The frequency of the PWM output is the inverse of the period ( $f_{\text{PWM}} = 1/T_{\text{Period}}$ ), the resolution of the PWM is the clock count numbers for one period ( $N$  bits resolution,  $2^N \times T_{\text{clock}} = T_{\text{Period}}$ ).

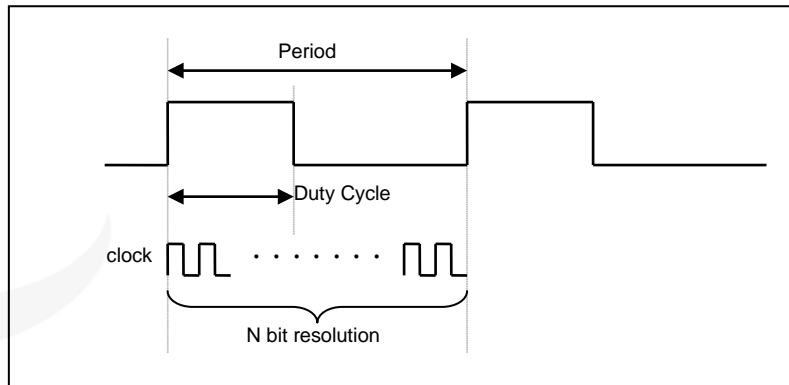


Fig. 19: PWM Output Waveform

## 10.3.2. Hardware and Timing Diagram

Fig. 20 shows the hardware diagram of 11-bit Timer. The clock source can be IHRC or system clock. The PWM output pin is selected by register *PWMG0C*. The period of PWM waveform is defined in the PWM upper bond high and low registers (*PWMG0CUBH* and *PWMG0CUBL*), the duty cycle of PWM waveform is defined in the PWM duty high and low registers (*PWMG0DTH* and *PWMG0DTL*).

Selecting code option GPC\_PWM can also control the generated PWM waveform by the comparator result. Please refer the section of Timer2 for further information.

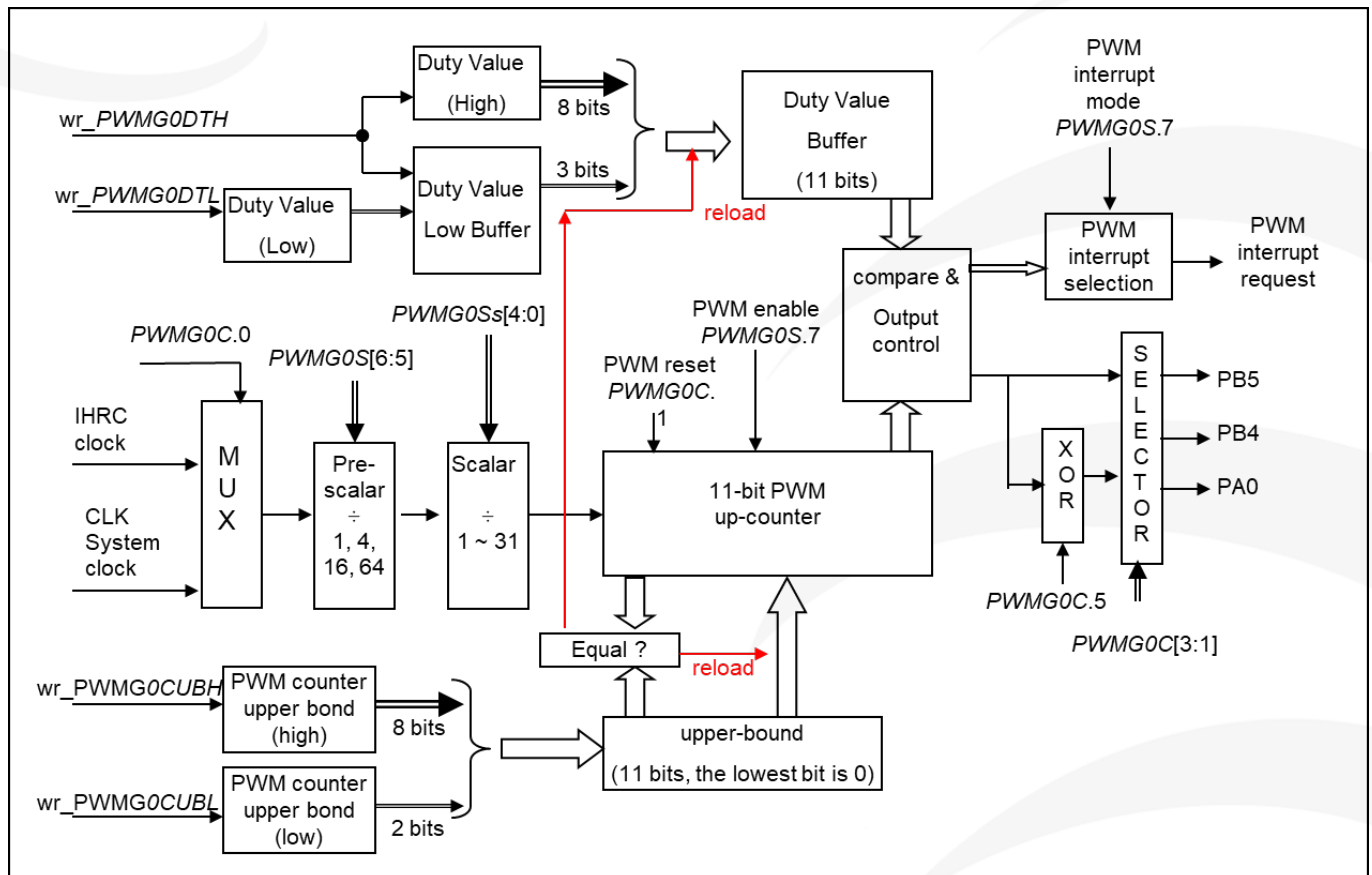


Fig. 20: Hardware Diagram of 11-bit PWM Generator 0 (PWMG0)

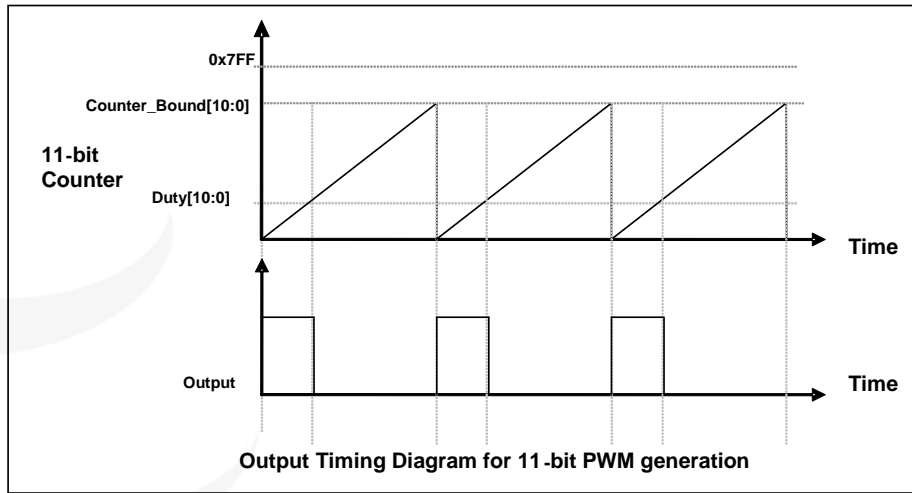


Fig. 21: Output Timing Diagram of 11-bit PWM Generator

### 10.3.3. Equations for 11-bit PWM Generator

The frequency and duty cycle of 11bit PWM can be obtained from the following formula:

$$\text{PWM Frequency } F_{\text{PWM}} = F_{\text{clock source}} \div [P \times (K + 1) \times (\text{CB10\_1} + 1)]$$

$$\text{PWM Duty(in time)} = (1 / F_{\text{PWM}}) \times (\text{DB10\_1} + \text{DB0} \times 0.5 + 0.5) \div (\text{CB10\_1} + 1)$$

$$\text{PWM Duty(in percentage)} = (\text{DB10\_1} + \text{DB0} \times 0.5 + 0.5) \div (\text{CB10\_1} + 1) \times 100\%$$

Where,

**P** = *PWMGxS* [6:5] : pre-scalar (**P** = 1, 4, 16, 64)

**K** = *PWMGxS* [4:0] : scalar in decimal (**K** = 0 ~ 31)

**DB10\_1** = *Duty\_Bound*[10:1] = {*PWMGxDTH*[7:0], *PWMGxDTL*[7:6]}, duty bound

**DB0** = *Duty\_Bound*[0] = *PWMGxDTL*[5]

**CB10\_1** = *Counter\_Bound*[10:1] = {*PWMGxCUBH*[7:0], *PWMGxCUBL*[7:6]}, counter bound



## 10.3.4. 11bit PWM Related Registers

### 10.3.4.1. PWMG0 control Register (*PWMG0C*), address = 0x20

Bit	Reset	R/W	Description
7	0	R/W	Enable PWMG0 generator. 0 / 1: disable / enable
6	-	RO	Output status of PWMG0 generator.
5	0	R/W	Enable to inverse the polarity of PWMG0 generator output. 0 / 1: disable / enable.
4	0	R/W	PWMG0 counter reset. Writing "1" to clear PWMG0 counter and this bit will be self clear to 0 after counter reset.
3 – 1	0	R/W	Select PWM output pin for PWMG0. 000: none 001: PB5 011: PA0 100: PB4 Others: reserved
0	0	R/W	Clock source of PWMG0 generator. 0: CLK, 1: IHRC or IHRC*2 (by code option PWM_source)

### 10.3.4.2. PWMG0 Scalar Register (*PWMG0S*), address = 0x21

Bit	Reset	R/W	Description
7	0	WO	PWMG0 interrupt mode 0: Generate interrupt when counter matches the duty value 1: Generate interrupt when counter is 0
6 – 5	0	WO	PWMG0 clock pre-scalar 00 : ÷1 01 : ÷4 10 : ÷16 11 : ÷64
4 – 0	0	WO	PWMG0 clock divider

### 10.3.4.3. PWMG0 Duty Value High Register (*PWMG0DTH*), address = 0x22

Bit	Reset	R/W	Description
7 – 0	-	WO	Duty values bit[10:3] of PWMG0.

### 10.3.4.4. PWMG0 Duty Value Low Register (*PWMG0DTL*), address = 0x23

Bit	Reset	R/W	Description
7 – 5	-	WO	Duty values bit [2:0] of PWMG0.
4 – 0	-	-	Reserved

**Note:** It's necessary to write *PWMG0DTL* Register before writing *PWMG0DTH* Register.

## 10.3.4.5. PWMG0 Counter Upper Bound High Register (*PWMG0CUBH*), address = 0x24

Bit	Reset	R/W	Description
7 – 0	-	WO	Bit[10:3] of PWMG0 counter upper bound.

## 10.3.4.6. PWMG0 Counter Upper Bound Low Register (*PWMG0CUBL*), address = 0x25

Bit	Reset	R/W	Description
7 – 6	-	WO	Bit[2:1] of PWMG0 counter upper bound.
5	-	WO	Bit[0] of PWMG0 counter upper bound.
4 – 0	-	-	Reserved

## 10.3.4.7. PWMG1 Control Register (*PWMG1C*), address = 0x26

Bit	Reset	R/W	Description
7	0	R/W	Enable PWMG1. 0 / 1: disable / enable
6	-	RO	Output of PWMG1.
5	0	R/W	Enable to inverse the polarity of PWMG1 output. 0 / 1 : disable / enable.
4	0	R/W	PWMG1 counter reset. Writing “1” to clear PWMG1 counter and this bit will be self clear to 0 after counter reset.
3 – 1	0	R/W	Select PWMG1 output pin. 000: none 001: PB6 011: PA4 100: PB7 Others: reserved
0	0	R/W	Clock source of PWMG1. 0: CLK, 1: IHRC or IHRC*2 (by code option PWM_source)

## 10.3.4.8. PWMG1 Scalar Register (*PWMG1S*), address = 0x27

Bit	Reset	R/W	Description
7	0	WO	PWMG1 interrupt mode. 0: Generate interrupt when counter matches the duty value 1: Generate interrupt when counter is 0
6 – 5	0	WO	PWMG1 clock pre-scalar. 00 : ÷1 01 : ÷4 10 : ÷16 11 : ÷64
4 – 0	0	WO	PWMG1 clock divider.

## 10.3.4.9. PWMG1 Duty Value High Register (*PWMG1DTH*), address = 0x28

Bit	Reset	R/W	Description
7 – 0	0x00	WO	Duty values bit[10:3] of PWMG1.

## 10.3.4.10. PWMG1 Duty Value Low Register (*PWMG1DTL*), address = 0x29

Bit	Reset	R/W	Description
7 – 5	000	WO	Duty values bit[2:0] of PWMG1.
4 – 0	-	-	Reserved

**Note:** It's necessary to write *PWMG1DTL* Register before writing *PWMG1DTH* Register.

## 10.3.4.11. PWMG1 Counter Upper Bound High Register (*PWMG1CUBH*), address = 0x2A

Bit	Reset	R/W	Description
7 – 0	0x00	WO	Bit[10:3] of PWMG1 counter upper bound.

## 10.3.4.12. PWMG1 Counter Upper Bound Low Register (*PWMG1CUBL*), address = 0x2B

Bit	Reset	R/W	Description
7 – 6	00	WO	Bit[2:1] of PWMG1 counter upper bound.
5	0	WO	Bit[0] of PWMG1 counter upper bound.
4 – 0	-	-	Reserved

## 10.3.4.13. PWMG2 Control Register (*PWMG2C*), address = 0x2C

Bit	Reset	R/W	Description
7	0	R/W	Enable PWMG2. 0 / 1: disable / enable.
6	-	RO	Output of PWMG2.
5	0	R/W	Enable to inverse the polarity of PWMG2 output. 0 / 1: disable / enable.
4	0	R/W	PWMG2 counter reset. Writing "1" to clear PWMG2 counter and this bit will be self clear to 0 after counter reset.
3 – 1	0	R/W	Select PWMG2 output pin. 000: disable 001: PB3 011: PA3 100: PB2 101: PA5 (ICE does NOT Support.) Others: reserved
0	0	R/W	Clock source of PWMG2. 0: CLK, 1: IHRC or IHRC*2 (by code option PWM_source)

## 10.3.4.14. PWMG2 Scalar Register (*PWMG2S*), address = 0x2D

Bit	Reset	R/W	Description
7	0	RO	PWMG2 interrupt mode. 0: Generate interrupt when counter matches the duty value 1: Generate interrupt when counter is 0.
6 – 5	0	RO	PWMG2 clock pre-scalar. 00 : ÷1 01 : ÷4 10 : ÷16 11 : ÷64
4 – 0	0	RO	PWMG2 clock divider.

## 10.3.4.15. PWMG2 Duty Value High Register (*PWMG2DTH*), address = 0x2E

Bit	Reset	R/W	Description
7 – 0	0x00	WO	Duty values bit[10:3] of PWMG2.

## 10.3.4.16. PWMG2 Duty Value Low Register (*PWMG2DTL*), address = 0x2F

Bit	Reset	R/W	Description
7 – 5	000	WO	Duty values bit[2:0] of PWMG2.
4 – 0	-	-	Reserved

**Note:** It's necessary to write *PWMG2DTL* Register before writing *PWMG2DTH* Register.

## 10.3.4.17. PWMG2 Counter Upper Bound High Register (*PWMG2CUBH*), address = 0x30

Bit	Reset	R/W	Description
7 – 0	0x00	WO	Bit[10:3] of PWMG2 counter upper bound.

## 10.3.4.18. PWMG2 Counter Upper Bound Low Register (*PWMG2CUBL*), address = 0x31

Bit	Reset	R/W	Description
7 – 6	00	WO	Bit[2:1] of PWMG2 counter upper bound.
5	0	WO	Bit[0] of PWMG2 counter upper bound.
4 – 0	-	-	Reserved

## 10.3.5. Examples of PWM Waveforms with Complementary Dead Zones

Users can use two 11bit PWM generators to output two complementary PWM waveforms with dead zones. Take PWMG0 output PWM0, PWMG1 output PWM1 as an example, the program reference is as follows.

In addition, Timer2 and Timer3 can also output 8-bit PWM waveforms with complementary dead zones of two bands. The principle is similar to this, and it will not be described in detail.

```
#define dead_zone_R 2           // Control dead-time before rising edge of PWM1
#define dead_zone_F 3           // Control dead-time after falling edge of PWM1

void FPPA0(void)
{
    .ADJUST_IC    SYSCLK=IHRC/16, IHRC=16MHz, VDD=5V;
    //.....
    Byte duty      = 60;          // Represents the duty cycle of PWM0
    Byte _duty      = 100 - duty; // Represents the duty cycle of PWM1

    //***** Set the counter upper bound and duty cycle *****
    PWMG0DTL       = 0x00;
    PWMG0DTH       = _duty;
    PWMG0CUBL       = 0x00;
    PWMG0CUBH       = 100;

    PWMG1DTL       = 0x00;
    PWMG1DTH       = _duty - dead_zone_F;
    //Use duty cycle to adjust the dead-time after the falling edge of PWM1
    PWMG1CUBL       = 0x00;
    PWMG1CUBH       = 100;      // The above values are assigned before enable PWM output

    //***** PWM out control *****
    $ PWMG0C Enable,Inverse,PA0,SYSCLK; // PWMG0 output the PWM0 waveform to PA0
    $ PWMG0S INTR_AT_DUTY,/1,/1;

    .delay dead_zone_R; // Use delay to adjust the dead-time before the rising edge of PWM1

    $ PWMG1C Enable, PA4, SYSCLK; // PWMG1 output the PWM1 waveform to PA4
    $ PWMG1S INTR_AT_DUTY,/1,/1;

    //**** Note: for the output control part of the program, the code sequence can not be moved ****//

    While(1)
    {
        nop;
    }
}
```

The PWM0 / PWM1 waveform obtained by the above program is shown in Fig. 22.

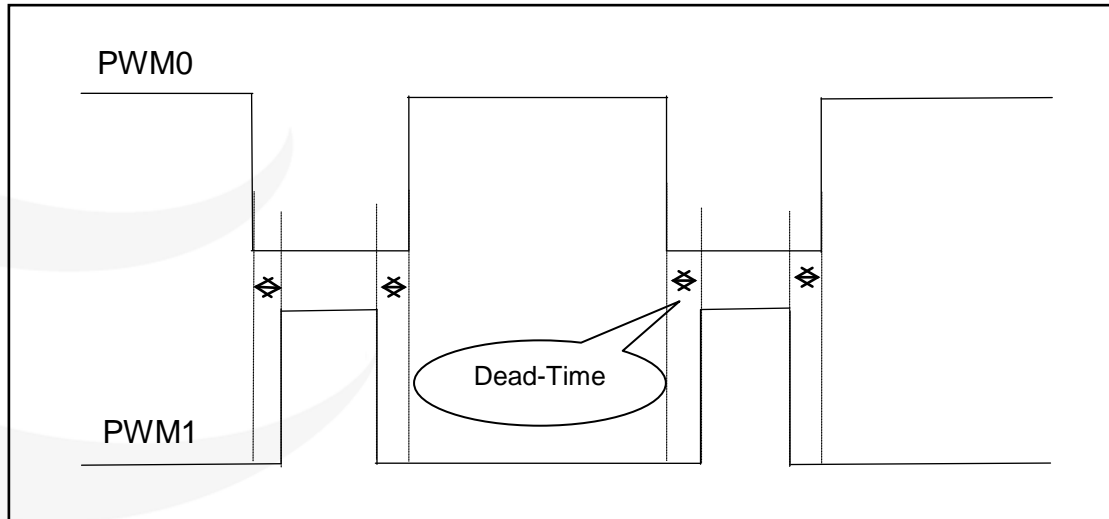


Fig. 22: Two complementary PWM waveforms with dead zones

Users can modify the **dead\_zone\_R** and **dead\_zone\_F** values in the program to adjust the dead-time. Table 10 provides data corresponding to different dead-time for users' reference. Where, if dead-time = 4us, then there are dead zones of 4us before and after PWM1 high level.

dead-time (us)	dead_zone_R	dead_zone_F
4 (minimum)	0	2
6	2	3
8	4	4
10	6	5
12	8	6
14	10	7

Table 10: The value of dead-time for reference

**Dead\_zone\_R** and **dead\_zone\_F** need to work together to get an ideal dead-time. If user wants to adjust other dead-time, please note that **dead\_zone\_R** and **dead\_zone\_F** need to meet the following criteria:

dead_zone_R	dead_zone_F
1 / 2 / 3	> 1
4 / 5 / 6 / 7	> 2
8 / 9	> 3
...	...

## 11. Special Functions

### 11.1. Comparator

One hardware comparator is built inside the PFC232; Fig. 23 shows its hardware diagram. It can compare signals between two input pins. The two signals to be compared, one is the plus input and the other one is the minus input. The plus input pin is selected by register *GPCC.0*, and the minus input pin is selected by *GPCQ[3:1]*.

The output result can be:

- (1) read back by *GPCC.6*;
- (2) inversed the polarity by *GPCC.4*;
- (3) sampled by Time2 clock (TM2\_CLK) which comes from *GPCC.5*;
- (4) enabled to output to PA0 directly by *GPCS.7*;
- (5) used to request interrupt service.

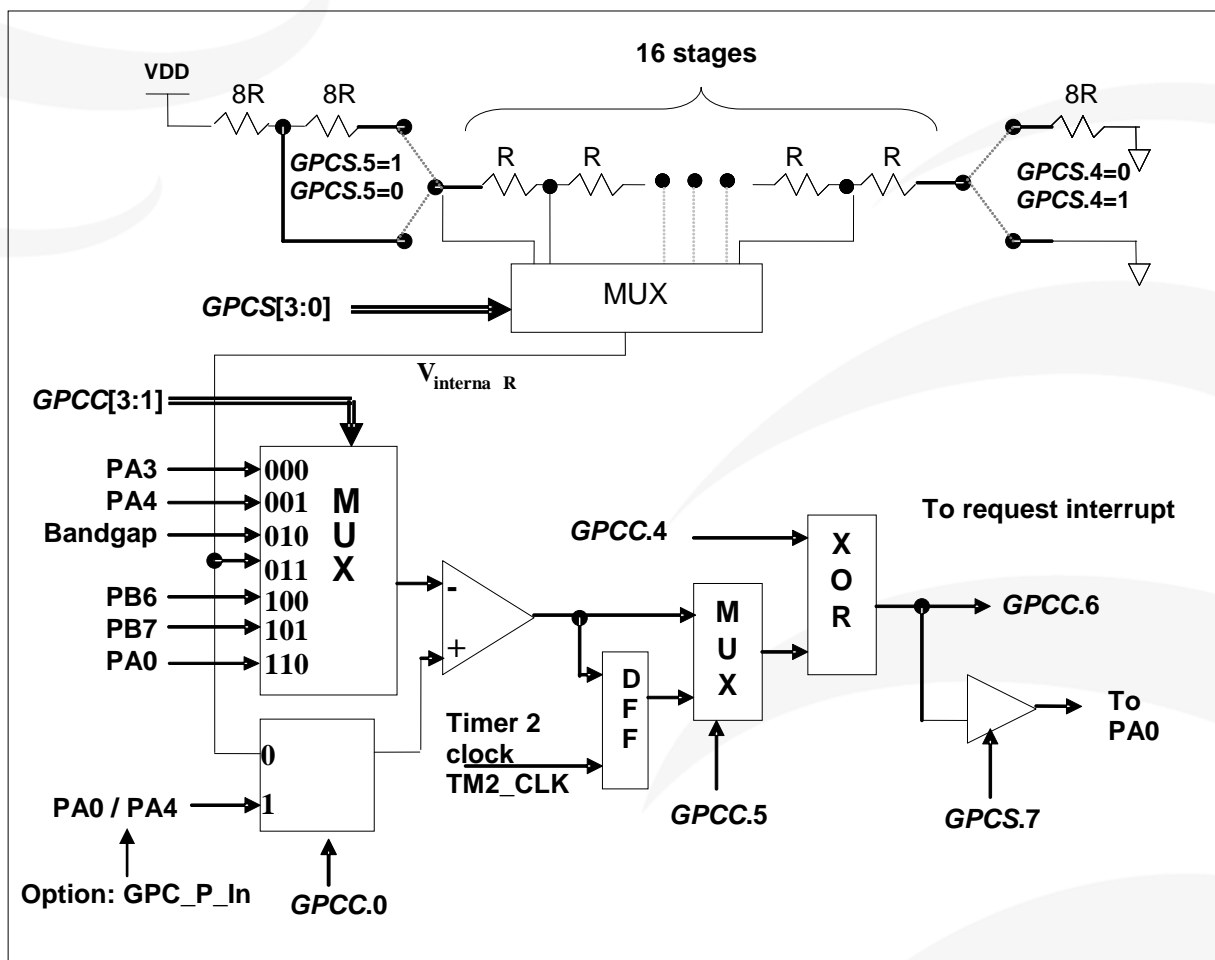


Fig. 23: Hardware diagram of comparator

## 11.1.1. Comparator Control Register (GPCC), address = 0x18

Bit	Reset	R/W	Description
7	0	R/W	Enable comparator. 0 / 1 : disable / enable When this bit is set to enable, please also set the corresponding input pins to be digital disable to prevent IO leakage.
6	-	RO	Comparator result. 0: plus input < minus input 1: plus input > minus input
5	0	R/W	Select whether the comparator result output will be sampled by TM2_CLK? 0: result output NOT sampled by TM2_CLK 1: result output sampled by TM2_CLK
4	0	R/W	Inverse the polarity of result output of comparator. 0: polarity is NOT inversed. 1: polarity is inversed.
3 – 1	000	R/W	Selection the minus input (-) of comparator. 000: PA3 001: PA4 010: Internal 1.20 volt Bandgap reference voltage 011: $V_{internal R}$ 100: PB6 (ICE DOES NOT support) 101: PB7 (ICE DOES NOT support) 110 : PA0 111: reserved
0	0	R/W	Selection the plus input (+) of comparator. 0 : $V_{internal R}$ 1 : PA4 or PA0 (by code option GPC_P_In)

## 11.1.2. Comparator Selection Register (GPCS), address = 0x19

Bit	Reset	R/W	Description
7	0	WO	Comparator output enable (to PA0). 0 / 1 : disable / enable Before setting this bit to enable the comparator, please make sure the OPA is not enabled to prevent signal fighting at PA0.
6	-	-	Reserved.
5	0	WO	Selection of high range of comparator.
4	0	WO	Selection of low range of comparator.
3 – 0	0000	WO	Selection the voltage level of comparator. 0000 (lowest) ~ 1111 (highest)



## 11.1.3. Internal Reference Voltage ( $V_{\text{internal R}}$ )

The internal reference voltage  $V_{\text{internal R}}$  is built by series resistance to provide different level of reference voltage, bit 4 and bit 5 of  $GPCS$  register are used to select the maximum and minimum values of  $V_{\text{internal R}}$  and bit [3:0] of  $GPCS$  register are used to select one of the voltage level which is divided-by-16 from the defined maximum level to minimum level. By setting the  $GPCS$  register, the internal reference voltage  $V_{\text{internal R}}$  can be ranged from  $(1/32)*V_{DD}$  to  $(3/4)*V_{DD}$ .

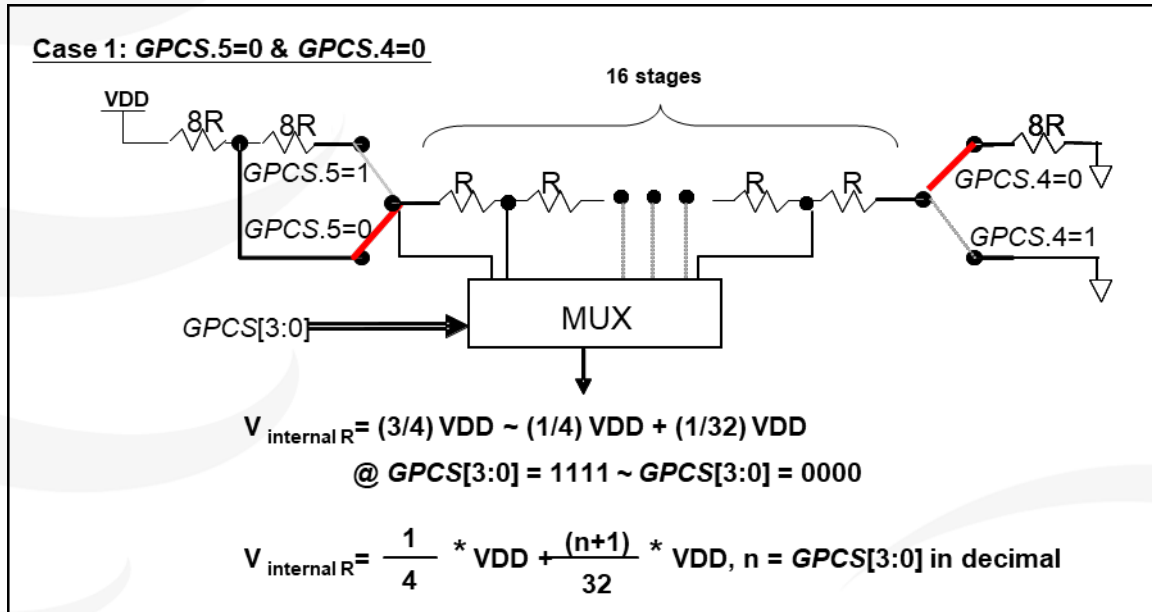


Fig. 24:  $V_{\text{internal R}}$  hardware connection if  $GPCS.5=0$  and  $GPCS.4=0$

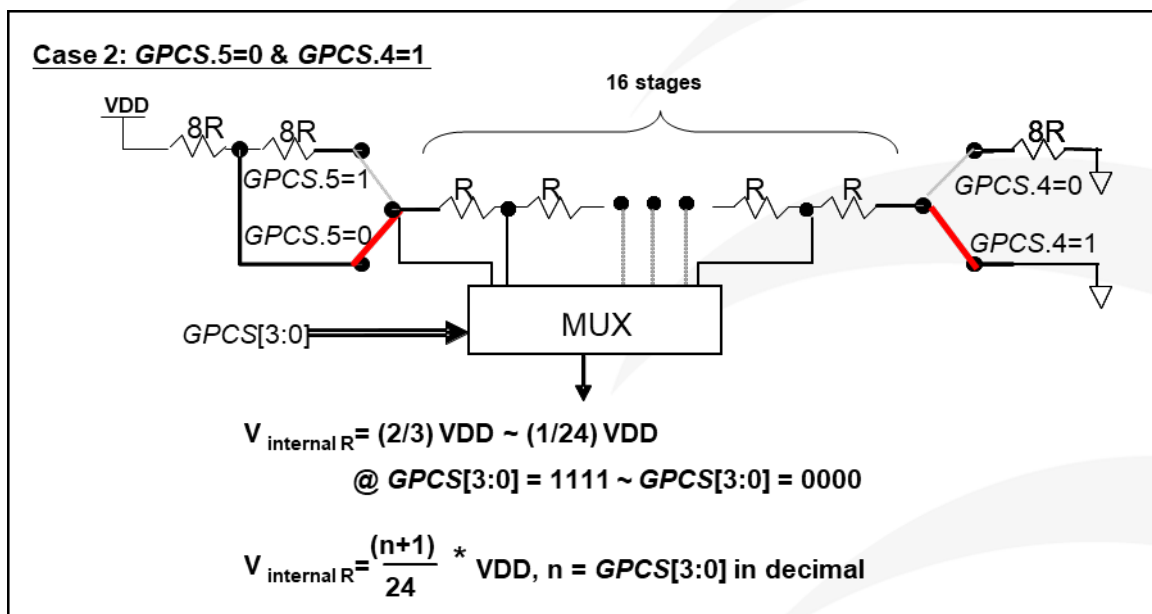


Fig. 25:  $V_{\text{internal R}}$  hardware connection if  $GPCS.5=0$  and  $GPCS.4=1$

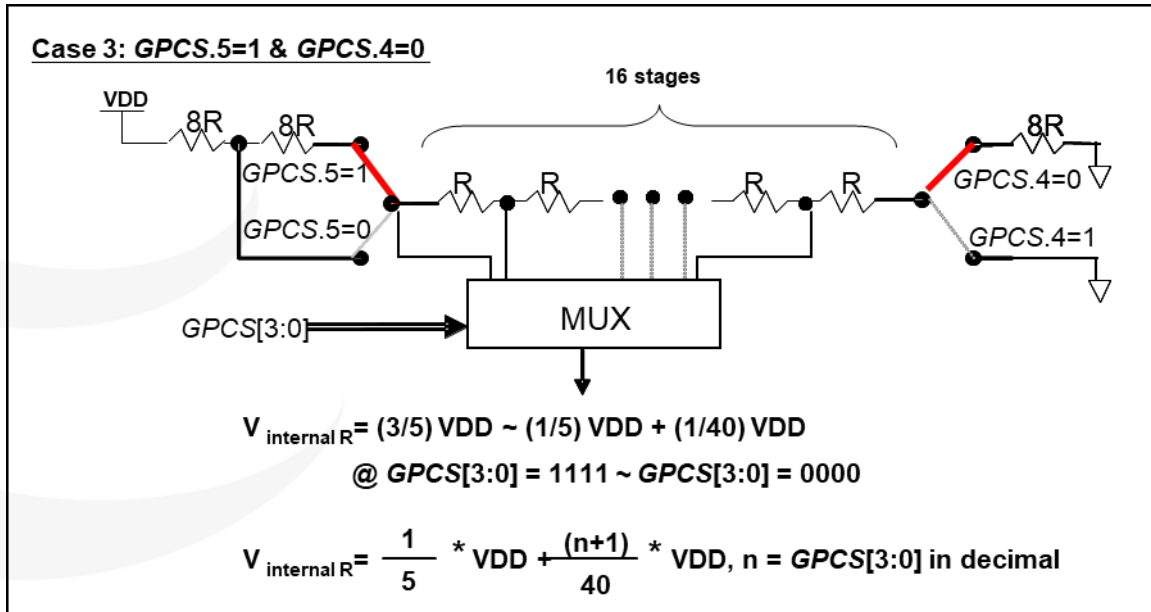


Fig. 26:  $V_{internal R}$  hardware connection if  $GPCS.5=1$  and  $GPCS.4=0$

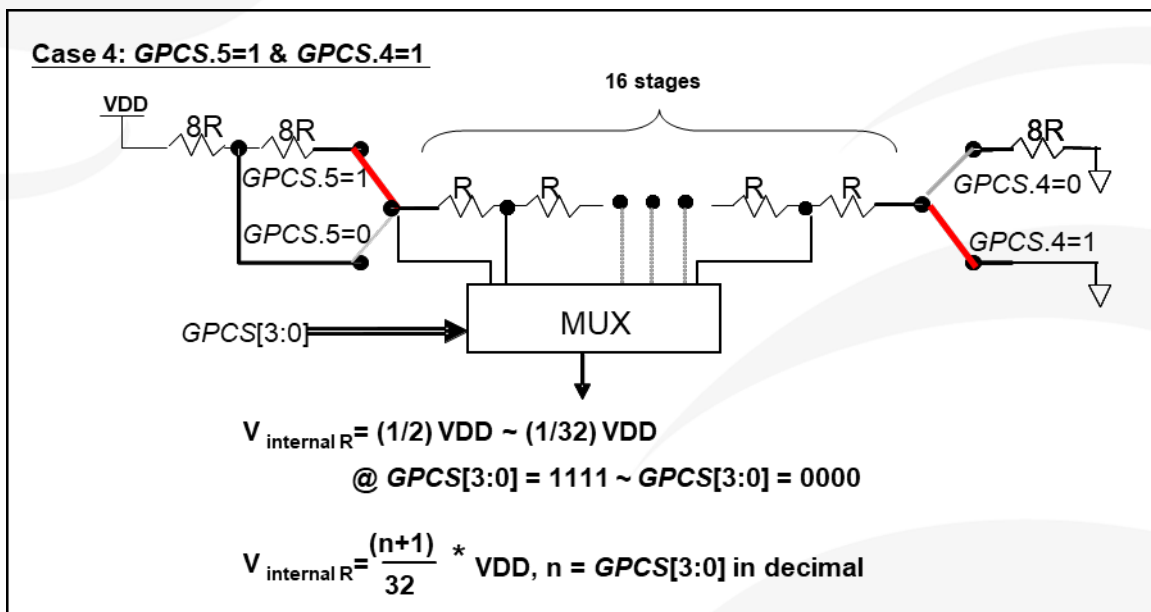


Fig. 27:  $V_{internal R}$  hardware connection if  $GPCS.5=1$  and  $GPCS.4=1$

## 11.1.4. Using the Comparator

### Case 1:

Choosing PA3 as minus input and  $V_{\text{internal R}}$  with  $(18/32)*V_{\text{DD}}$  voltage level as plus input.  $V_{\text{internal R}}$  is configured as the above Figure “GPCS[5:4] = 2b'00” and GPCS[3:0] = 4b'1001 (n=9) to have  $V_{\text{internal R}} = (1/4)*V_{\text{DD}} + [(9+1)/32]*V_{\text{DD}} = [(9+9)/32]*V_{\text{DD}} = (18/32)*V_{\text{DD}}$ .

```
GPCS  = 0b0_0_00_1001;    //  $V_{\text{internal R}} = V_{\text{DD}}*(18/32)$ 
GPCC  = 0b1_0_0_0_000_0;  // enable comp, - input: PA3, + input:  $V_{\text{internal R}}$ 
PADIER = 0bxxxx_0_xxx;    // disable PA3 digital input to prevent leakage current
```

or

```
$ GPCS   $V_{\text{DD}}*18/32$ ;
$ GPCC  Enable, N_PA3, P_R;    // - input: N_xx, + input: P_R( $V_{\text{internal R}}$ )
PADIER = 0bxxxx_0_xxx;
```

### Case 2:

Choosing  $V_{\text{internal R}}$  as minus input with  $(22/40)*V_{\text{DD}}$  voltage level and PA4 as plus input, the comparator result will be inversed and then output to PA0.  $V_{\text{internal R}}$  is configured as the above Figure “GPCS[5:4] = 2b'10” and GPCS[3:0] = 4b'1101 (n=13) to have  $V_{\text{internal R}} = (1/5)*V_{\text{DD}} + [(13+1)/40]*V_{\text{DD}} = [(13+9)/40]*V_{\text{DD}} = (22/40)*V_{\text{DD}}$ .

```
GPCS  = 0b1_0_10_1101;    // output to PA0,  $V_{\text{internal R}} = V_{\text{DD}}*(22/40)$ 
GPCC  = 0b1_0_0_1_011_1;  // Inverse output, - input:  $V_{\text{internal R}}$ , + input: PA4
PADIER = 0bxxxx_0_xxx;    // disable PA4 digital input to prevent leakage current
```

or

```
$ GPCS  Output,  $V_{\text{DD}}*22/40$ ;
$ GPCC  Enable, Inverse, N_R, P_PA4; // - input: N_R( $V_{\text{internal R}}$ ), + input: P_xx
PADIER = 0bxxx_0_xxxx;
```

Note: When selecting output to PA0 output, GPCS will affect the PA3 output function in ICE. Though the IC is fine, be careful to avoid this error during emulation.

## 11.1.5. Using the Comparator and Bandgap 1.20V

The internal Bandgap module provides a stable 1.20V output, and it can be used to measure the external supply voltage level. The Bandgap 1.20V is selected as minus input of comparator and  $V_{\text{internal R}}$  is selected as plus input, the supply voltage of  $V_{\text{internal R}}$  is VDD, the VDD voltage level can be detected by adjusting the voltage level of  $V_{\text{internal R}}$  to compare with Bandgap.

If N ( $GPCS[3:0]$  in decimal) is the number to let  $V_{\text{internal R}}$  closest to Bandgap 1.20 volt, the supply voltage VDD can be calculated by using the following equations:

For using Case 1:  $V_{DD} = [ 32 / (N+9) ] * 1.20 \text{ volt}$  ;

For using Case 2:  $V_{DD} = [ 24 / (N+1) ] * 1.20 \text{ volt}$  ;

For using Case 3:  $V_{DD} = [ 40 / (N+9) ] * 1.20 \text{ volt}$  ;

For using Case 4:  $V_{DD} = [ 32 / (N+1) ] * 1.20 \text{ volt}$  ;

Case 1:

```
$ GPCS  VDD*12/40;           // 4.0V * 12/40 = 1.2V
$ GPCC  Enable, BANDGAP, P_R; // - input: BANDGAP, + input: P_R(Vinternal R)
....
if  (GPC_Out)                 // or GPCC.6
{                               // when VDD > 4V
}
else
{                               // when VDD < 4V
}
```

## 11.2. VDD/2 Bias Voltage Generator

The five pins of PFC232: PA0, PA3, PA4, PB0 and PB7, can generate VDD/2 as the COM function when driving the LCD display. This function can be enabled by setting the register *MISC.4* as 1.

MISC Register ( <i>MISC</i> ), address = 0x08			
Bit	Reset	R/W	Description
7 – 5	-	-	Reserved. (keep 0 for future compatibility)
4	0	WO	<b>Enable VDD/2 bias voltage generator</b> 0 / 1 : Disable / Enable (ICE cannot be dynamically switched)
3	-	-	Reserved.
2	0	WO	Disable LVR function. 0 / 1 : Enable / Disable
1 – 0	00	WO	Watch dog time out period

The COM port can generate VDD/2 by switching it to input mode (*PAC.x / PBC.x=0*). However, keep in mind to turn off the pull-high / pull-low resistor (*PxPH.x / PxPL.x=0*) and digital input from *PADIER.x / PBDIER.x* register to prevent the output voltage level from disturbing. Fig.28 shows how to use this function.

The output function of COM port is the same as other normal IO.

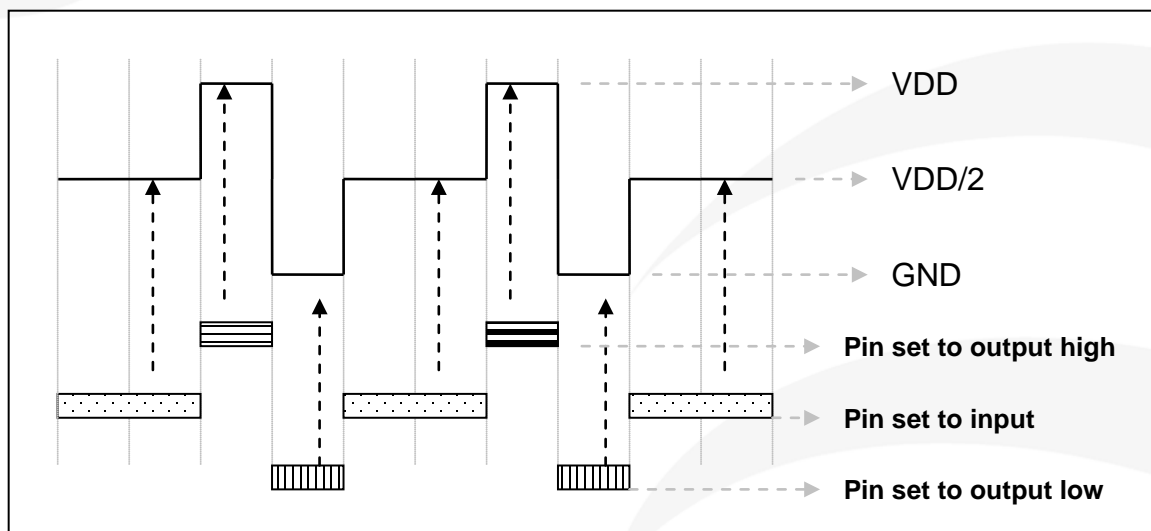
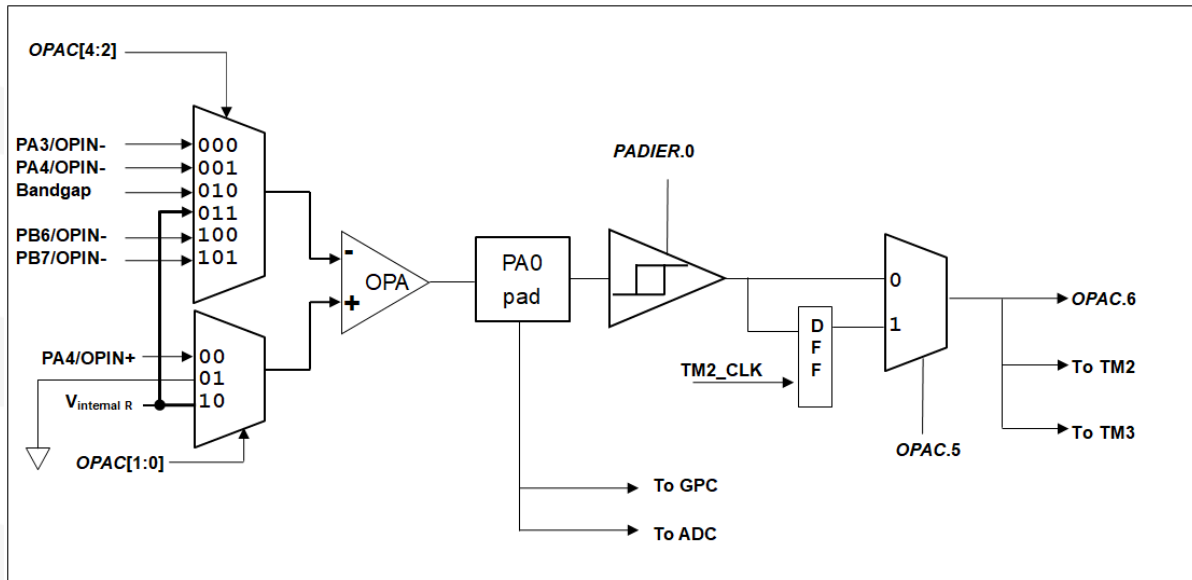


Fig. 28: Using VDD/2 bias voltage generator

## 11.3. Operational Amplifier (OPA) module

An Operational Amplifier (OPA) is built-in in the PFC232, the basic configuration is shown in the following diagram. There are 2 different configurations, one is called OPA Comparator mode and the other is Amplifier mode.



When user turns on the OPA by enabling the *OPAC.7*, the IO port PA0 turns to be the output of OPA. User can measure the analog PA0 voltage by GPC or ADC in Amplifier mode, or read the digital OPA compare result from PA0 directly in Comparator mode.

### 11.3.1. OPA Comparator Mode

The open-loop configuration shown in the above diagram is called OPA Comparator mode. There is no feedback path between input and output (PA0) of OPA. In this mode, user can enable *PADIER.0* to read the compare result from *OPAC.6*.

Like the comparator (GPC), the compare result of OPA can also be the counting source of TM2 or TM3. Also like GPC, the OPA compare result can also be used to control generated PWM waveform by enable code option *OPA\_PWM*.

Moreover, user can select the internal reference voltage  $V_{\text{internal R}}$  which generated in GPC as one of the plus or minus input of OPA as the compare reference voltage.

### 11.3.2. OPA Amplifier Mode

Another configuration is called Amplifier mode, which needs some external components to make a feedback amplifier. When it is configured as a feedback amplifier, PA0 becomes an analog output pad. Always keep in mind to disable *PADIER.0* to prevent it from current leakage.

PA0 can be selected as the input of comparator (GPC) or ADC, therefore the output voltage of OPA can be compared by GPC or measured by ADC as well.

## 11.3.3. OPA Control Register (OPAC), address = 0x1A

Bit	Reset	R/W	Description
7	0	R/W	Enable OPA. 0 / 1 : disable / enable When this bit is set to enable, please also set the corresponding analog input pins to be digital disable to prevent IO leakage. Please note PA0 will be assigned to the output of OPA when it is enabled.
6	-	RO	Compare result of OPA in Comparator mode. 0: plus input < minus input 1: plus input > minus input
5	0	R/W	Select whether the compare result of OPA output is sampled by TM2_CLK? 0: result output NOT sampled by TM2_CLK 1: result output sampled by TM2_CLK
4 - 2	000	R/W	Selection the minus input (-) of OPA. 000 : PA3 001 : PA4 010 : Internal 1.20 volt Bandgap reference voltage 011 : $V_{\text{internal R}}$ 100 : PB6 101 : PB7 11X: reserved
0	0	R/W	Selection the plus input (+) of OPA. 00 : PA4 01 : GND 10 : $V_{\text{internal R}}$ from the comparator (refer to GPCS register) 11 : reserved

## 11.3.4. OPA Offset Register (OPAofs), address = 0x07

Bit	Reset	R/W	Description
7 - 4	-	-	Reserved
3 - 0	0000	R/W	Select the offset level of OPA. 0000 : +1mV 0001 : +2mV 0010 : +5mV 0011 : +10mV 0100 : +15mV 0101 : +20mV 0110 : +25mV 0111 : +30mV 1000 : -1mV 1001 : -2mV 1010 : -5mV 1011 : -10mV 1100 : -15mV 1101 : -20mV 1110 : -25mV 1111 : -30mV

## 11.4. Analog-to-Digital Conversion (ADC) module

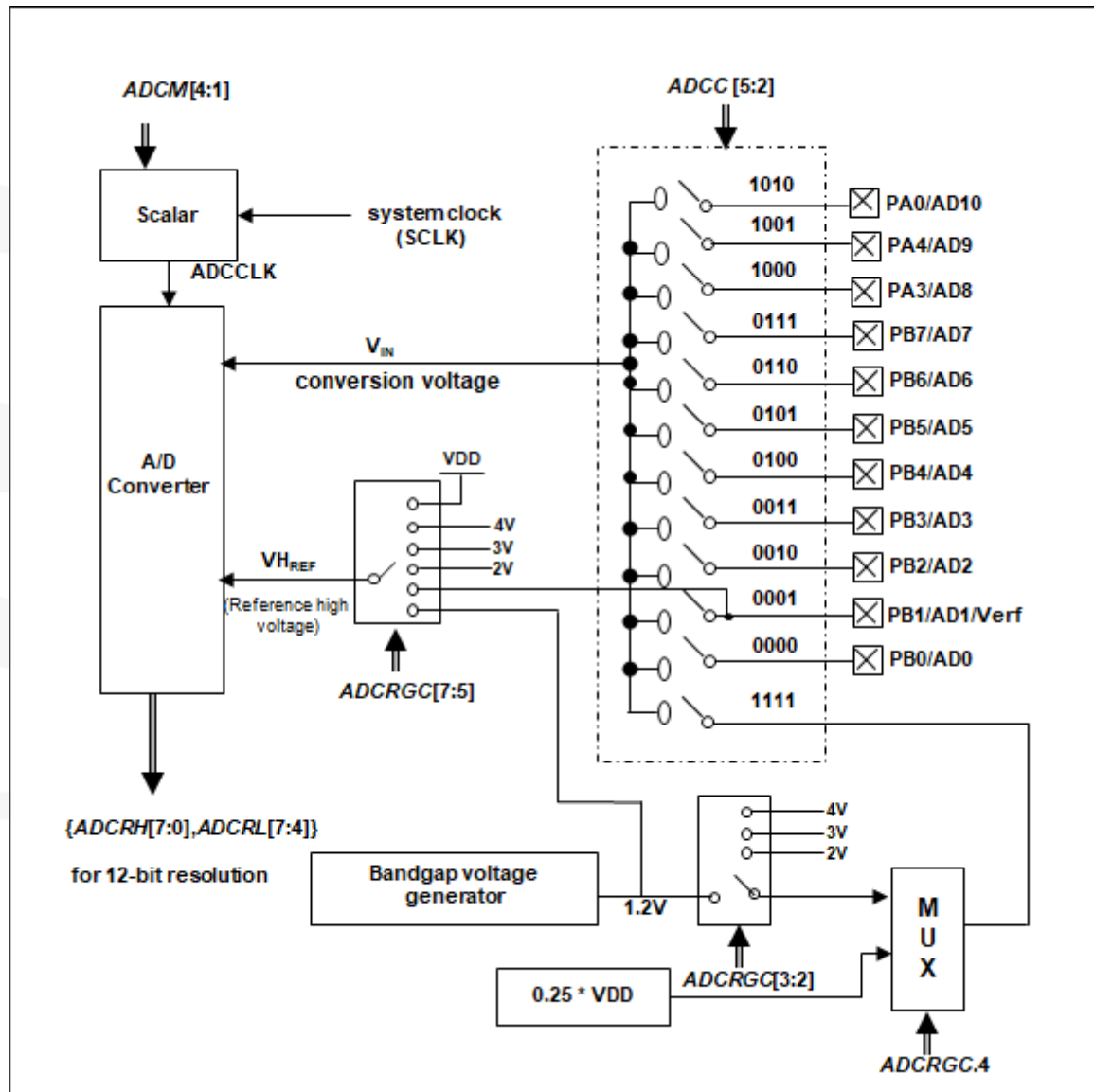


Fig.29: ADC Block Diagram

The following steps are required to do the AD conversion procedure:

- (1) Configure the voltage reference high by *ADCRGC* register
- (2) Configure the AD conversion clock by *ADCM* register
- (3) Configure the pin as analog input by *PADIER*, *PBDIER* register
- (4) Select the ADC input channel by *ADCC* register
- (5) Enable the ADC module by *ADCC* register
- (6) Delay a certain amount of time after enabling the ADC module

**Condition 1:** using the internal voltage reference high which are 2V, 3V, 4V or the input channel is bandgap

It must delay more than 1 ms when the time of 200 AD clocks is less than 1ms. Or it must delay 200 AD clocks when the time of 200 AD clocks is larger than 1ms

**Condition 2:** without using any internal 2V, 3V, 4V, bandgap voltage

It needs to delay 200 AD clocks only.



- (7) Execute the AD conversion and check if ADC data is ready  
set '1' to *ADCC.6* to start the conversion and check whether *ADCC.6* is '1'
- (8) Read the ADC result registers:  
First read the *ADCRH* register and then read the *ADCRL* register.

If user power down the ADC and enable the ADC again, be sure to go to step 6 to confirm the ADC becomes ready before the conversion.

## 11.4.1. The input requirement for AD conversion

For the AD conversion to meet its specified accuracy, the charge holding capacitor ( $C_{HOLD}$ ) must be allowed to fully charge to the voltage reference high level and discharge to the voltage reference low level. The analog input model is shown as Fig.30, the signal driving source impedance ( $R_s$ ) and the internal sampling switch impedance ( $R_{ss}$ ) will affect the required time to charge the capacitor  $C_{HOLD}$  directly. The internal sampling switch impedance may vary with ADC supply voltage; the signal driving source impedance will affect accuracy of analog input signal. User must ensure the measured signal is stable before sampling; therefore, the maximum signal driving source impedance is highly dependent on the frequency of signal to be measured. The recommended maximum impedance for analog driving source is about 10K $\Omega$  under 500KHz input frequency.

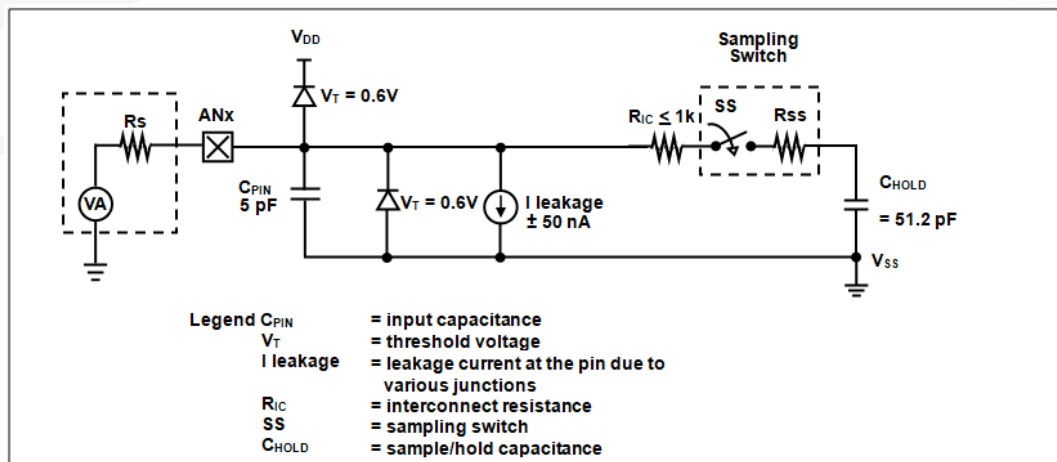


Fig.30: Analog Input Model

Before starting the AD conversion, the minimum signal acquisition time should be met for the selected analog input signal, the selection of ADCLK must be met the minimum signal acquisition time.

## 11.4.2. Select the reference high voltage

The ADC reference high voltage can be selected via bit[7:5] of register *ADCRGC* and its option can be  $V_{DD}$ , 4V, 3V, 2V, Bandgap (1.20V) reference voltage or PB1 from external pin.

## 11.4.3. ADC clock selection

The clock of ADC module (ADCLK) can be selected by *ADCM* register; there are 8 possible options for ADCLK from CLK÷1 to CLK÷128 (CLK is the system clock). Due to the signal acquisition time  $T_{ACQ}$  is one clock period of ADCLK, the ADCLK must meet that requirement. The recommended ADC clock is to operate at 2 $\mu$ s.

## 11.4.4. Configure the analog pins

There are 12 analog signals can be selected for AD conversion, 11 analog input signals come from external pins and one is from internal Bandgap reference voltage or  $0.25 \times V_{DD}$ . There are 4 voltage levels selectable for the internal Bandgap reference, they are 1.2V, 2V, 3V and 4V. For external pins, the analog signals are shared with Port A[0], Port A[4:3], and Port B[7:0]. To avoid leakage current at the digital circuit, those pins defined for analog input should disable the digital input function (set the corresponding bit of *PADIER* or *PBDIER* register to be 0).

The measurement signals of ADC belong to small signal; it should avoid the measured signal to be interfered during the measurement period. The selected pin should:

- (1) be set to input mode
- (2) turn off weak pull-high / pull-low resistor
- (3) set the corresponding pin to analog input by port A/B digital input disable register (*PADIER* / *PBDIER*).

## 11.4.5. Using the ADC

The following example shows how to use ADC with PB0~PB3.  
First, defining the selected pins:

```
PBC      = 0B_XXXX_0000;      // PB0 ~ PB3 as Input
PBPH    = 0B_XXXX_0000;      // PB0 ~ PB3 without pull-high
PBPL    = 0B_XXXX_0000;      // PB0 ~ PB3 without pull-low
PBDIER  = 0B_XXXX_0000;      // PB0 ~ PB3 digital input is disabled
```

Next, setting *ADCC* register, example as below:

```
$ ADCC Enable, PB3;      // set PB3 as ADC input
$ ADCC Enable, PB2;      // set PB2 as ADC input
$ ADCC Enable, PB0;      // set PB0 as ADC input
```

Next, setting *ADCM* and *ADCRGC* register, example as below:

```
$ ADCM 12BIT, /16;      // recommend /16 @System Clock=8MHz
$ ADCM 12BIT, /8;       // recommend /8 @System Clock=4MHz
$ ADCRGC VDD;
```

Next, delay 400us, example as below:

```
.Delay 8*400;           // System Clock=8MHz
.Delay 4*400;           // System Clock=4MHz
```

Then, start the ADC conversion:

```
AD_START  = 1;          // start ADC conversion
while (! AD_DONE) NULL; // wait ADC conversion result
```

Finally, it can read ADC result when *AD\_DONE* is high:

```
WORD      = Data;       // two bytes result: ADCRH and ADCRL
Data$1    = ADCRH
Data$0    = ADCRL;
Data      = Data >> 4;
```

The ADC can be disabled by using the following method:

```
$ ADCC Disable;
```

or

```
ADCC      = 0;
```

## 11.4.6. ADC Related Registers

### 11.4.6.1. ADC Control Register (*ADCC*), address = 0x35

Bit	Reset	R/W	Description
7	0	R/W	Enable ADC function. 0/1: Disable/Enable.
6	0	R/W	ADC process control bit. Read "1" to indicate the ADC is ready or end of conversion.
5 - 2	0000	R/W	Channel selector. These four bits are used to select input signal for AD conversion. 0000: PB0/AD0, 0001: PB1/AD1, 0010: PB2/AD2, 0011: PB3/AD3, 0100: PB4/AD4, 0101: PB5/AD5, 0110: PB6/AD6, 0111: PB7/AD7, 1000: PA3/AD8, 1001: PA4/AD9, 1010: PA0/AD10, 1111: (Channel F) Bandgap reference voltage or $0.25 \cdot V_{DD}$ Others: reserved
0 - 1	-	-	Reserved. (keep 0 for future compatibility)

### 11.4.6.2. ADC Mode Register (*ADCM*), address = 0x36

Bit	Reset	R/W	Description
7 - 4	-	-	Reserved (keep 0 for future compatibility)
3 - 1	000	WO	ADC clock source selection. 000: CLK (system clock) $\div 1$ , 001: CLK (system clock) $\div 2$ , 010: CLK (system clock) $\div 4$ , 011: CLK (system clock) $\div 8$ , 100: CLK (system clock) $\div 16$ , 101: CLK (system clock) $\div 32$ , 110: CLK (system clock) $\div 64$ , 111: CLK (system clock) $\div 128$ ,
0	-	-	Reserved

## 11.4.6.3. ADC Regulator Control Register (*ADCRGC*), address = 0x39

Bit	Reset	R/W	Description
7 - 5	000	WO	These three bits are used to select input signal for ADC reference high voltage. 000: $V_{DD}$ , 001: 2V, 010: 3V, 011: 4V, 100: PB1, 101: Bandgap 1.20 volt reference voltage Others: reserved
4	0	WO	ADC channel F selector: 0: Bandgap reference voltage 1: $0.25 \cdot V_{DD}$ . The deviation is within $\pm 0.01 \cdot V_{DD}$ mostly.
3 - 2	00	WO	Bandgap reference voltage selector for ADC channel F: 00: 1.2V 01: 2V 10: 3V 11: 4V
1 - 0	-	-	Reserved. Please keep 0.

## 11.4.6.4. ADC Result High Register (*ADCRH*), address = 0x37

Bit	Reset	R/W	Description
7 - 0	-	RO	These eight read-only bits will be the bit [11:4] of AD conversion result. The bit 7 of this register is the MSB of ADC result for any resolution.

## 11.4.6.5. ADC Result Low Register (*ADCRL*), address = 0x38

Bit	Reset	R/W	Description
7 - 4	-	RO	These four bits will be the bit [3:0] of AD conversion result.
3 - 0	-	-	Reserved

## 11.5. Multiplier

There is an 8x8 multiplier on-chip to enhance hardware capability in arithmetic function, its multiplication is an 8 x 8 unsigned operation and can be finished in one clock cycle. Before issuing the *mul* command, both multiplicand and multiplier must be put on *ACC* and register *MULOP* (0x08); After *mul* command, the high byte result will be put on register *MULRH* (0x09) and low byte result on *ACC*. The hardware diagram of this multiplier is shown as Fig.31.

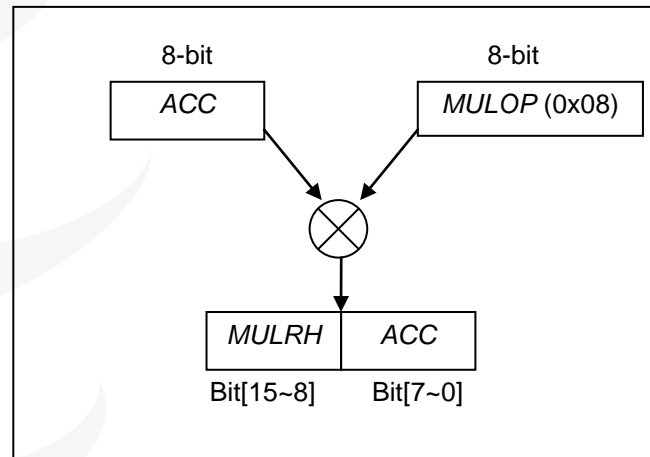


Fig.31: Block diagram of hardware multiplier

### 11.5.1. Multiplier Operand Register (*MULOP*), address = 0x08

Bit	Reset	R/W	Description
7 - 0	-	R/W	Operand for hardware multiplication operation.

### 11.5.2. Multiplier Result High Byte Register (*MULRH*), address = 0x09

Bit	Reset	R/W	Description
7 - 0	-	RO	High byte result of multiplication operation (read only).

## 12. Notes for Emulation

It is recommended to use PDK5S-I-S01/2(B) for emulation of PFC232. PDK5S-I-S01/2(B) supports PFC232 1-FPPA(FPPA0) MCU emulation work, the following items should be noted when using PDK5S-I-S01/2(B) to emulate PFC232:

- (1) PDK5S-I-S01/2(B) doesn't support the instruction *nadd, comp*.
- (2) PDK5S-I-S01/2(B) doesn't support  $\text{SYSCLK} = \text{ILRC}/16$ .
- (3) PDK5S-I-S01/2(B) doesn't support the function *TM2C.GPCRS/TM3C.GPCRS*.
- (4) PDK5S-I-S01/2(B) doesn't support the function *TM2C.OPA/TM3C.OPA*.
- (5) PDK5S-I-S01/2(B) doesn't support the function *PAPL/PBPL*.
- (6) PDK5S-I-S01/2(B) doesn't support the function *GPCC.P\_PA0*.
- (7) PDK5S-I-S01/2(B) doesn't support the dynamic setting of function *MISC.4* (Only fix to 0 or 1).
- (8) PDK5S-I-S01/2(B) doesn't support the function *PWMG2C.PA5*.
- (9) PDK5S-I-S01/2(B) doesn't support the function *ADCRGC.BG\_2V/BG\_3V/BG\_4V*, and fix *BG\_1V2* only.
- (10) PDK5S-I-S01/2(B) doesn't support the code options: *PB4\_PB7\_Drive*, *GPC\_P\_In*, *OPA\_PWM*, *GPC\_PWM*, *PWM\_Source*, *TMx\_Source* and *TMx\_bit*.
- (11) The PA3 output function will be affected when *GPCS* selects output to PA0 output.
- (12) When using PB1 in *ADCRGC*, PA1 must float.
- (13) Fast Wakeup time is different from PDK5S-I-S01/2(B): 128 SYSCLK, PFC232: 45 ILRC
- (14) Watch dog time out period is different from PDK5S-I-S01/2(B):

WDT period	PDK5S-I-S01/2(B)	PFC232
<i>MISC</i> [1:0]=00	$2048 * T_{\text{ILRC}}$	$8192 * T_{\text{ILRC}}$
<i>MISC</i> [1:0]=01	$4096 * T_{\text{ILRC}}$	$16384 * T_{\text{ILRC}}$
<i>MISC</i> [1:0]=10	$16384 * T_{\text{ILRC}}$	$65536 * T_{\text{ILRC}}$
<i>MISC</i> [1:0]=11	$256 * T_{\text{ILRC}}$	$262144 * T_{\text{ILRC}}$

## 13. Program Writing

Please use PDK5S-P-003 to program. PDK3S-P-002 or older versions do not support programming PFC232.

Jumper connection: Please follow the instruction inside the writer software to connect the jumper.

Please select the following program mode according to the actual situation.

### 13.1. Normal Programming Mode

Range of application:

- Single-Chip-Package IC with programming at the writer IC socket or on the handler.
- Multi-Chip-Package(MCP) with PFC232. Be sure its connected IC and devices will not be damaged by the following voltages, and will not clam the following voltages.

**The voltage conditions in normal programming mode:**

- (1) VDD is 7.5V, and the maximum supply current is up to about 20mA.
- (2) PA5 is 5.5V.
- (3) The voltages of other program pins (except GND) are the same as VDD.

**Important Cautions:**

- You MUST follow the instructions on APN004 and APN011 for programming IC on the handler.
- Connecting a 0.01uF capacitor between VDD and GND at the handler port to the IC is always good for suppressing disturbance. But please DO NOT connect with > 0.01uF capacitor, otherwise, programming mode may be fail.

### 13.2. Limited-Voltage Programming Mode

Range of application:

- On-Board writing. Its peripheral circuits and devices will not be damaged by the following voltages, and will not clam the following voltages. Please refer to Chapter 13.3 for more details about On-Board Writing.
- Multi-Chip-Package(MCP) with PFC232. Please be sure that its connected IC and devices will not be damaged by the following voltages, and will not clam the following voltages.

**The voltage conditions in Limited-Voltage programming mode:**

- (1) VDD is 5.0V, and the maximum supply current is up to about 20mA.
- (2) PA5 is 5.0V.
- (3) The voltage of other program pins (except GND) is the same as VDD.

Please select "MTP On-Board VDD Limitation" or "On-Board Program" on the writer screen to enable the limited-voltage programming mode. (Please refer to the file of Writer "PDK5S-P-003 UM").

## 13.3. On-Board Writing

PFC232 can support On-board writing. On-Board Writing is known as the situation that the IC have to be programmed when the IC itself and other peripheral circuits and devices have already been mounted on the PCB. Five wires of PDK5S-P-003 are used for On-Board Writing: ICPCK, ICPDA, VDD, GND and ICVPP. They are used to connect PA3, PA6, VDD, GND and PA5 of the IC correspondingly.

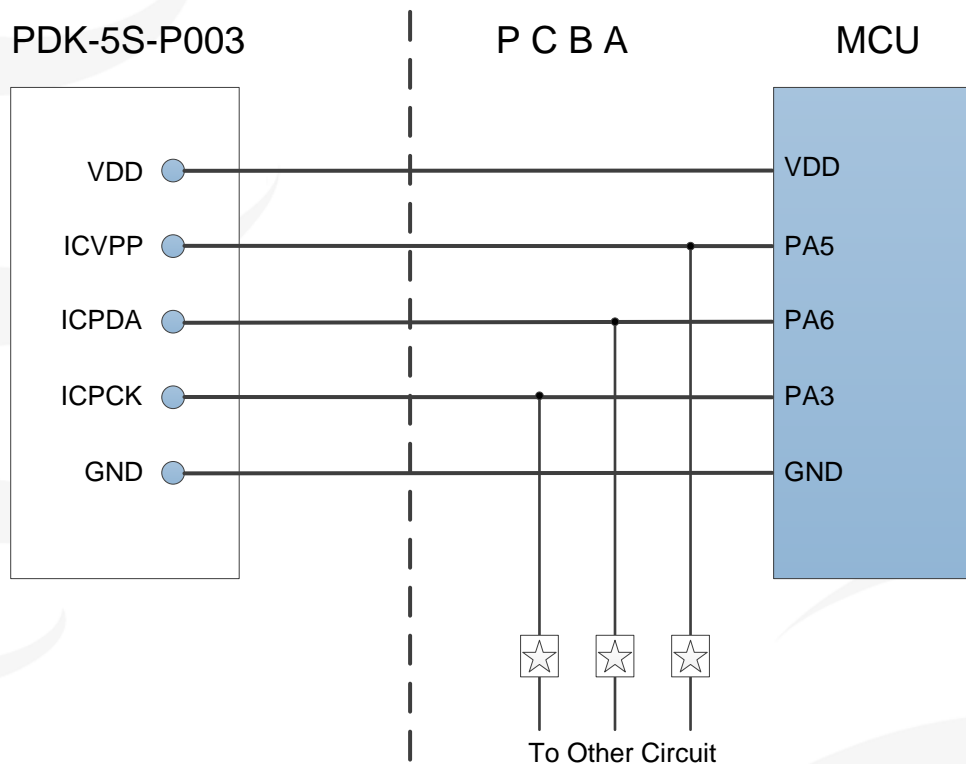


Fig. 32: Schematic Diagram of On-Board Wiring

The symbol ☆ on Fig. 32 can be either resistors or capacitors. They are used to isolate the programming signal wires from the peripheral circuit. it should be  $\geq 10K\Omega$  for resistance while  $\leq 220pF$  for capacitance.

### Notice:

- In general, the limited-voltage programming mode is used in On-board Writing, Please refers to the 13.2 for more detail about limited-voltage programming mode.
- Any zener diode  $\leq 5.0V$ , or any circuitry which clam the 5.0V to be created SHOULD NOT be connected between VDD and GND of the PCB.
- Any capacitor  $\geq 500\mu F$  SHOULD NOT be connected between VDD and GND of the PCB.
- In general, the writing signal pins PA3, PA5 and PA6 SHOULD NOT be considered as strong output pins.



## 14. Device Characteristics

### 14.1. Absolute Maximum Ratings

Name	Min	Typ.	Max	Unit	Notes
Supply Voltage (VDD)	2.2		5.5	V	Exceed the maximum rating may cause permanent damage !!
Input Voltage	-0.3		$V_{DD} + 0.3$	V	
Operating Temperature	-40		85	°C	
Storage Temperature	-50		125	°C	
Junction Temperature		150		°C	

### 14.2. DC/AC Characteristics

All data are acquired under the conditions of  $V_{DD}=5.0V$ ,  $f_{SYS}=2MHz$  unless noted.

Symbol	Description	Min	Typ	Max	Unit	Conditions (Ta=25°C)
$V_{DD}$	Operating Voltage	2.2	5.0	5.5	V	* Subject to LVR tolerance
LVR%	Low Voltage Reset Tolerance	-5		5	%	
$f_{SYS}$	System clock (CLK)* = IHRC/2 IHRC/4 IHRC/8 ILRC	0 0 0	   40K	8M 4M 2M	Hz	$V_{DD} \geq 3.75V$ $V_{DD} \geq 2.5V$ $V_{DD} \geq 2.2V$ $V_{DD} = 5V$
$I_{OP}$	Operating Current		1 65		mA uA	$f_{SYS}=IHRC/16=1MIPS@5V$ $f_{SYS}=ILRC=40KHz@5V$
$I_{PD}$	Power Down Current (by <i>stopsys</i> command)		1		uA	$f_{SYS}=0Hz$ , $V_{DD}=5V$
$I_{PS}$	Power Save Current (by <i>stopexe</i> command)		3		uA	$V_{DD}=5V$ ; $f_{SYS}=ILRC$ Only ILRC module is enabled.
$V_{IL}$	Input low voltage for IO lines	0		$0.1 V_{DD}$	V	
$V_{IH}$	Input high voltage for IO lines	$0.7 V_{DD}$		$V_{DD}$	V	
$I_{OL}$	IO lines sink current PA0, PA3, PA4, PB2 PA5, PA6, PA7, PB0, PB1, PB3, PB5, PB6 PB4, PB7 (Strong) PB4, PB7 (Normal)		23 17 23 37 23		mA	$V_{DD}=5V$ , $V_{OL}=0.5V$
$I_{OH}$	IO lines drive current PB4, PB7 (Normal) PB4, PB7 (Low) Others IO		-26 -10 -10		mA	$V_{DD}=5V$ , $V_{OH}=4.5V$
$V_{IN}$	Input voltage	-0.3		$V_{DD} + 0.3$	V	
$I_{INJ(PIN)}$	Injected current on pin		1		uA	$V_{DD} + 0.3 \geq V_{IN} \geq -0.3$

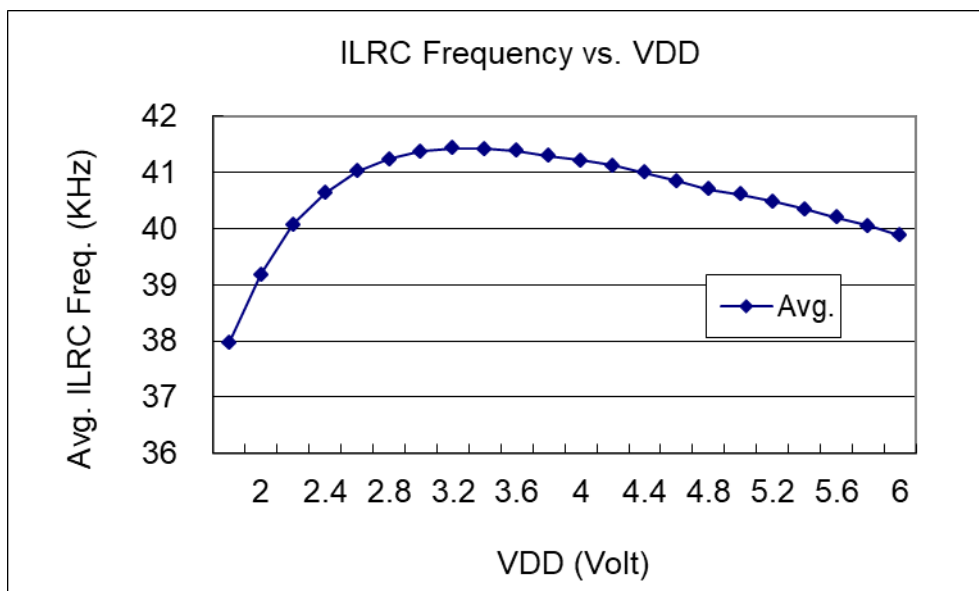
Symbol	Description	Min	Typ	Max	Unit	Conditions (Ta=25°C)
R <sub>PH</sub>	Pull-high Resistance		82		KΩ	V <sub>DD</sub> =5V
R <sub>PL</sub>	Pull-low Resistance		82		KΩ	V <sub>DD</sub> =5V
V <sub>BG</sub>	Bandgap Reference Voltage	1.145*	1.20*	1.255*	V	V <sub>DD</sub> =2.2V ~ 5.5V -40°C < Ta < 85°C*
f <sub>IHRC</sub>	Frequency of IHRC after calibration *	15.84*	16*	16.16*	MHz	VDD=5V, Ta=25 °C
		15.20*	16*	16.80*		VDD =2.2V~5.5V, -40 °C <Ta<85 °C *
t <sub>INT</sub>	Interrupt pulse width	30			ns	V <sub>DD</sub> = 5V
V <sub>AD</sub>	AD Input Voltage	0		V <sub>DD</sub>	V	
ADrs	ADC resolution		12		bit	
ADcs	ADC current consumption		0.8 0.75		mA	@5V @3V
ADclk	ADC clock period		2		us	2.2V ~ 5.5V
t <sub>ADCONV</sub>	ADC conversion time (T <sub>ADCLK</sub> is the period of the selected AD conversion clock)		16		T <sub>ADCLK</sub>	12-bit resolution
AD DNL	ADC Differential NonLinearity		±2*		LSB	
AD INL	ADC Integral NonLinearity		±4*		LSB	
ADos	ADC offset*		2		mV	V <sub>DD</sub> =3V
V <sub>REFH</sub>	ADC reference high voltage					V <sub>DD</sub> =5V, 25 °C
	4V	3.90	4	4.10		
	3V	2.93	3	3.07		
	2V	1.95	2	2.05		
V <sub>DR</sub>	RAM data retention voltage*	1.5			V	in power-down mode
t <sub>WDT</sub>	Watchdog timeout period		8k		T <sub>ILRC</sub>	misc[1:0]=00 (default)
			16k			misc[1:0]=01
			64k			misc[1:0]=10
			256k			misc[1:0]=11
t <sub>WUP</sub>	Wake-up time period for fast wake-up		45		T <sub>ILRC</sub>	Where T <sub>ILRC</sub> is the time period of ILRC
	Wake-up time period for normal wake-up		3000			
t <sub>SBP</sub>	System boot-up period from power-on		72		ms	V <sub>DD</sub> =5V
t <sub>RST</sub>	External reset pulse width	120			us	V <sub>DD</sub> =5V

Symbol	Description	Min	Typ	Max	Unit	Conditions (Ta=25°C)
CPos	Comparator offset*	-	±10	±20	mV	
CPcm	Comparator input common mode*	0		VDD-1.5	V	
CPspt	Comparator response time**		100	500	ns	Both Rising and Falling
CPmc	Stable time to change comparator mode		2.5	7.5	us	
CPcs	Comparator current consumption		20		uA	V <sub>DD</sub> = 3.3V
OPAcn	OPA input common mode*	0		VDD-1.3	V	
OPAos	OPA offset*		±10		mV	V <sub>DD</sub> =5V
I <sub>OPA</sub>	OPA output current*	200			uA	
OPAgain	OPA DC gain*		80		dB	

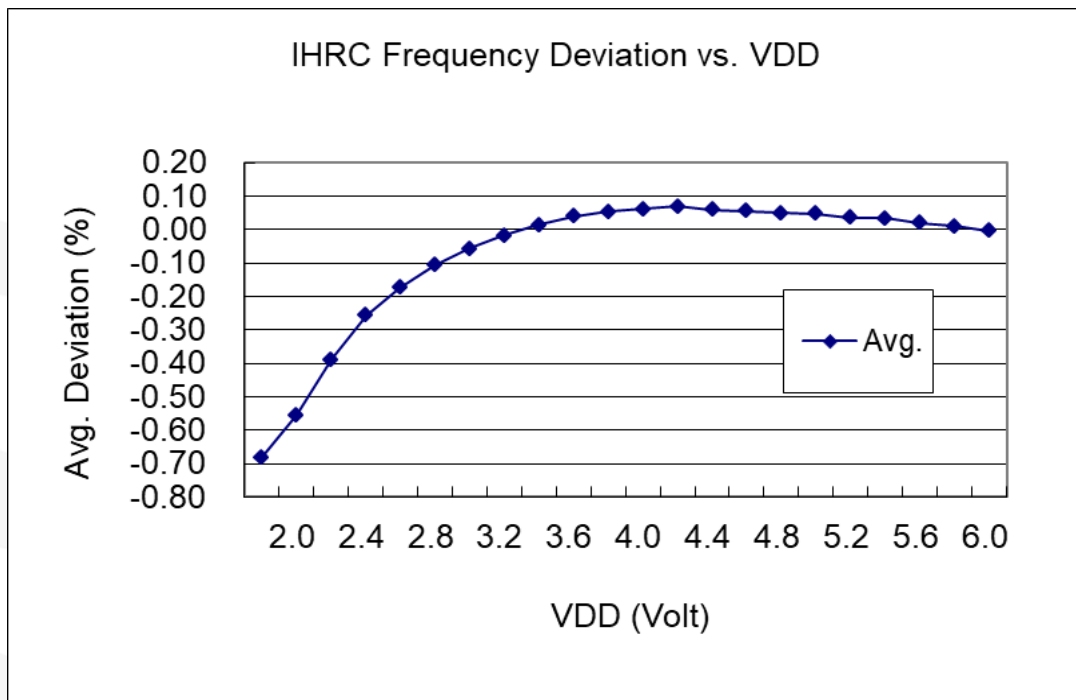
\*These parameters are for design reference, not tested for every chip.

The characteristic diagrams are the actual measured values. Considering the influence of production drift and other factors, the data in the table are within the safety range of the actual measured values.

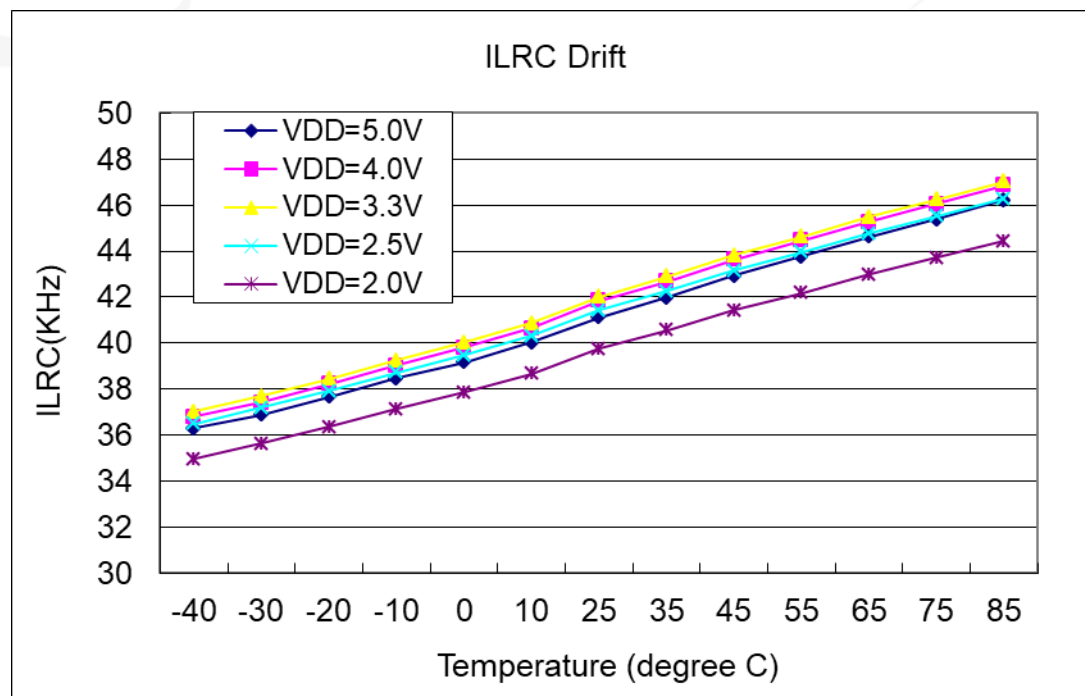
## 14.3. Typical ILRC frequency vs. VDD



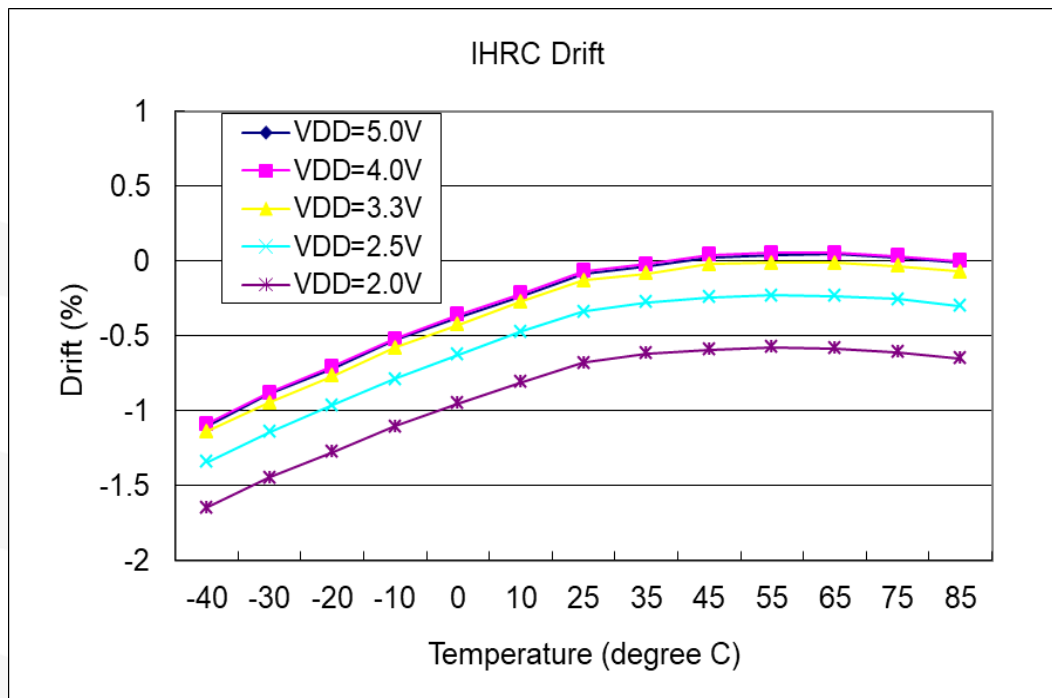
## 14.4. Typical IHRC frequency deviation vs. VDD(calibrated to 16MHz)



## 14.5. Typical ILRC Frequency vs. Temperature



## 14.6. Typical IHRC Frequency vs. Temperature (calibrated to 16MHz)



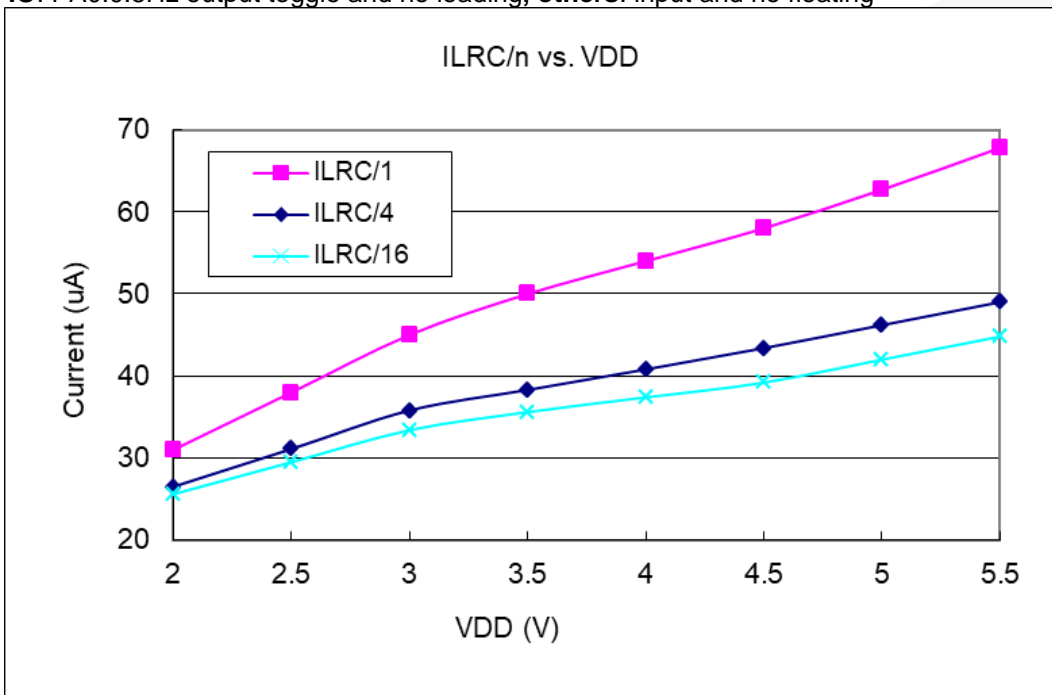
## 14.7. Typical operating current vs. VDD @ system clock = ILRC/n

Conditions:

2-FPPA (FPPA0: tog PA0, FPPA1: idle)

**ON:** ILRC, Bandgap, LVR; **OFF:** IHRC, EOSC, T16, TM2, TM3, ADC modules;

**IO:** PA0:0.5Hz output toggle and no loading, **others:** input and no floating



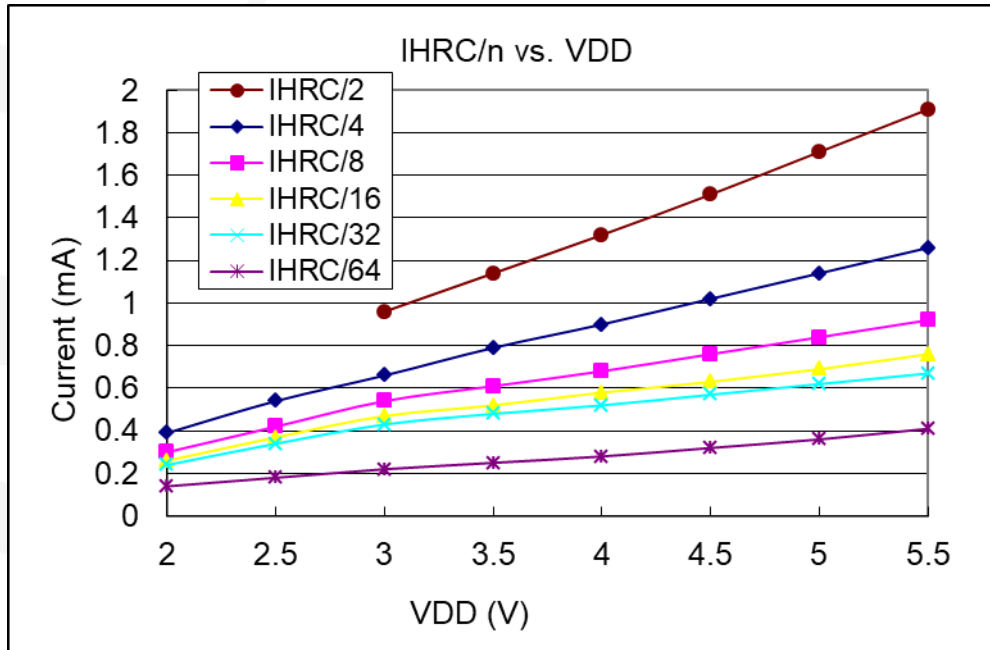
## 14.8. Typical operating current vs. VDD @ system clock = IHRC/n

Conditions:

2-FPPA (FPPA0: tog PA0, FPPA1: idle)

**ON:** Bandgap, LVR, IHRC; **OFF:** ILRC, EOSC, LVR, T16, TM2, TM3, ADC modules;

**IO:** PA0:0.5Hz output toggle and no loading, **others:** input and no floating

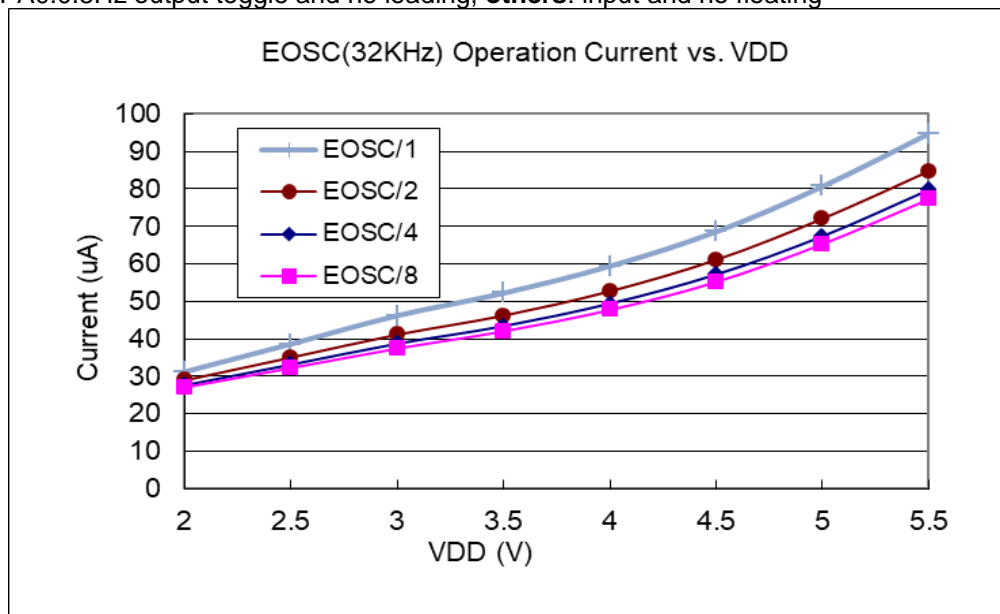


## 14.9. Typical operating current vs. VDD @ system clock = 32KHz EOSC / n

Conditions:

**ON:** EOSC, MISC.6 = 1, Bandgap, LVR; **OFF:** IHRC, ILRC, T16, TM2, TM3, ADC modules;

**IO:** PA0:0.5Hz output toggle and no loading, **others:** input and no floating

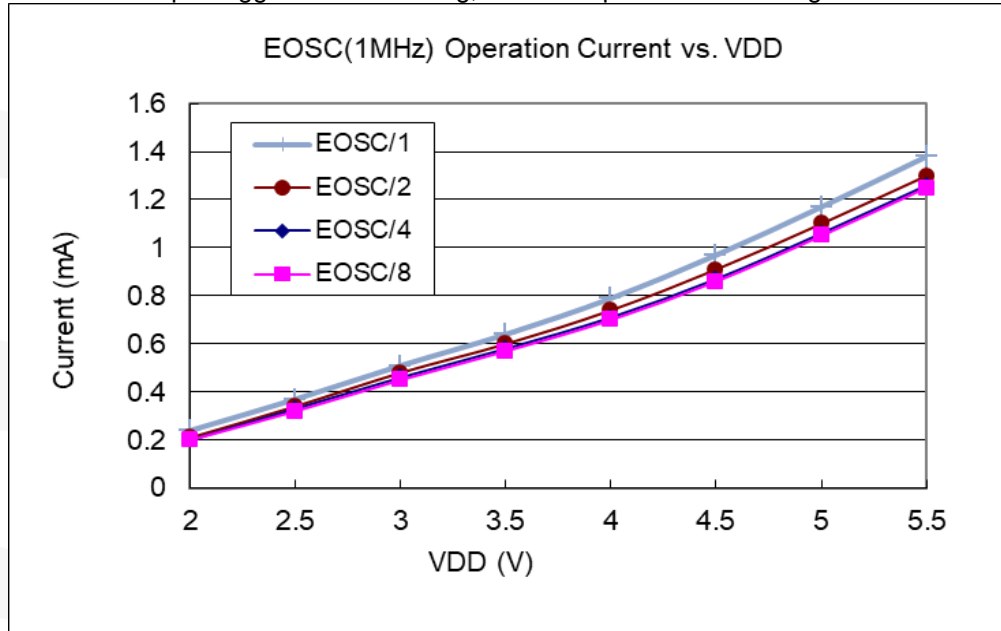


## 14.10. Typical operating current vs. VDD @ system clock = 1MHz EOSC / n

Conditions:

**ON:** EOSC, MISC.6 = 1, Bandgap, LVR; **OFF:** IHRC, ILRC, T16, TM2, TM3, ADC modules;

**IO:** PA0:0.5Hz output toggle and no loading, **others:** input and no floating

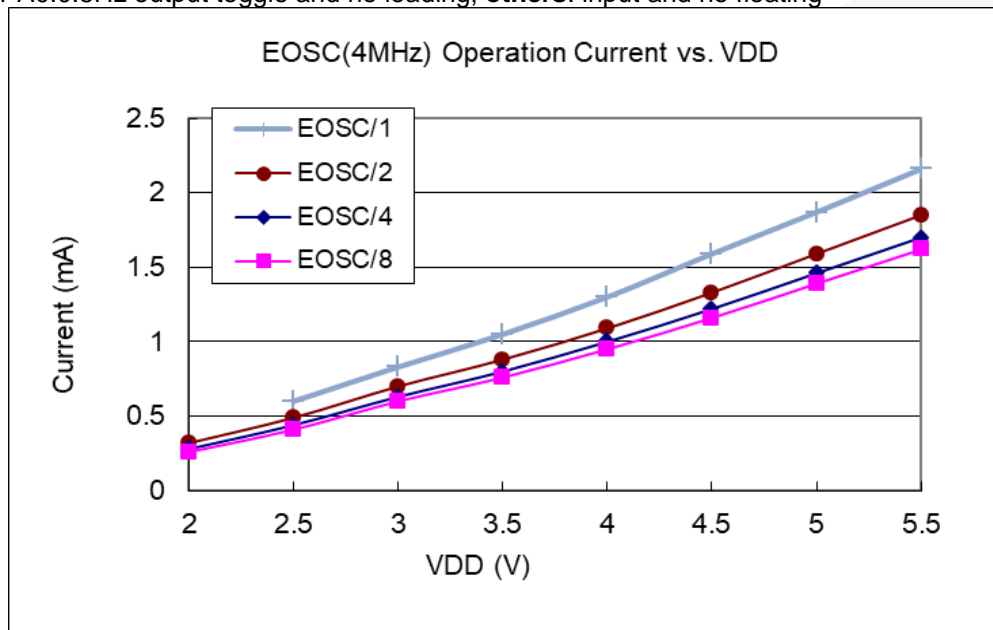


## 14.11. Typical operating current vs. VDD @ system clock = 4MHz EOSC / n

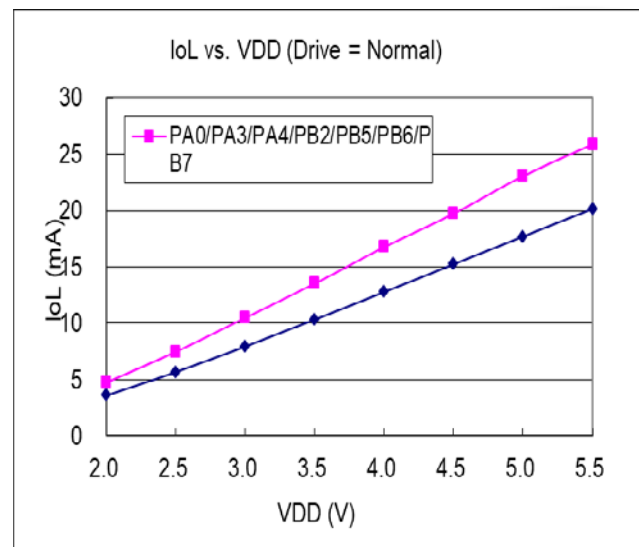
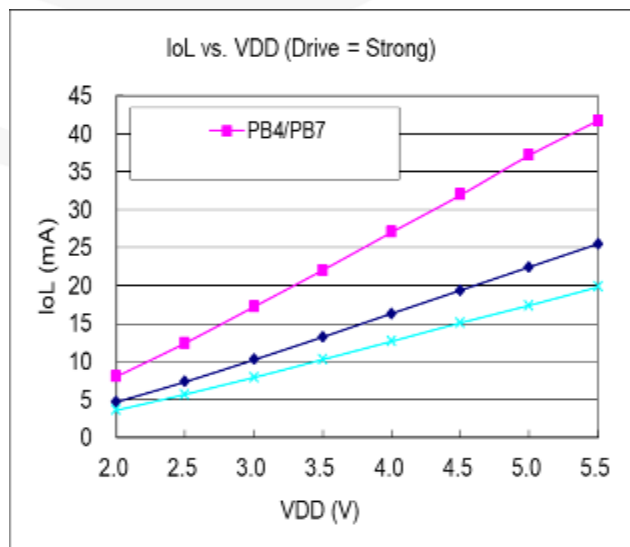
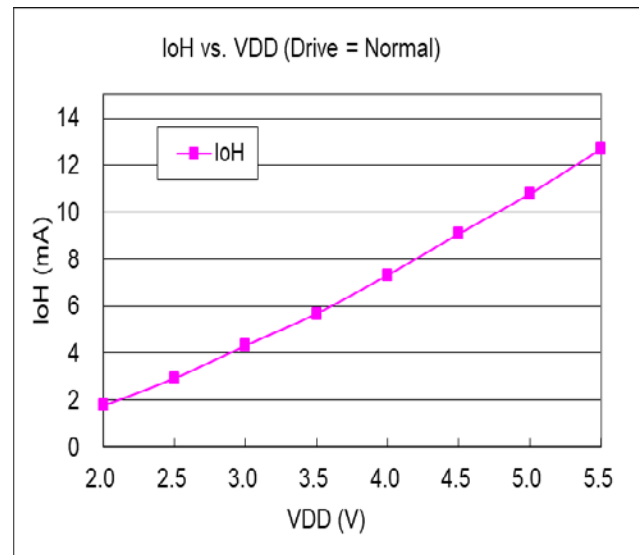
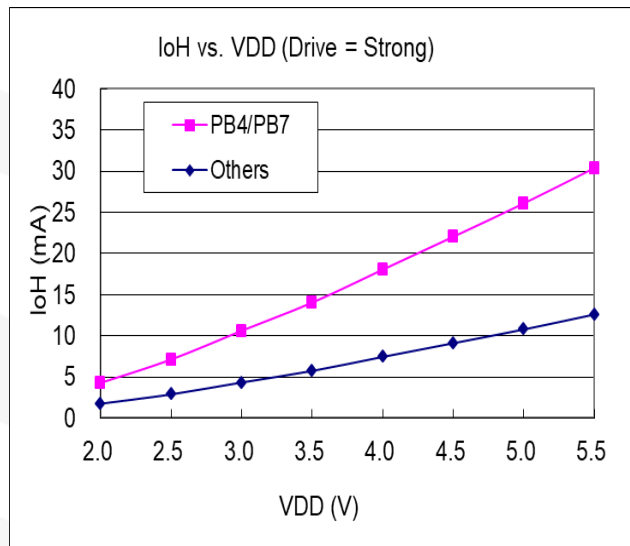
Conditions:

**ON:** EOSC, MISC.6 = 1, Bandgap, LVR; **OFF:** IHRC, ILRC, T16, TM2, TM3, ADC modules;

**IO:** PA0:0.5Hz output toggle and no loading, **others:** input and no floating

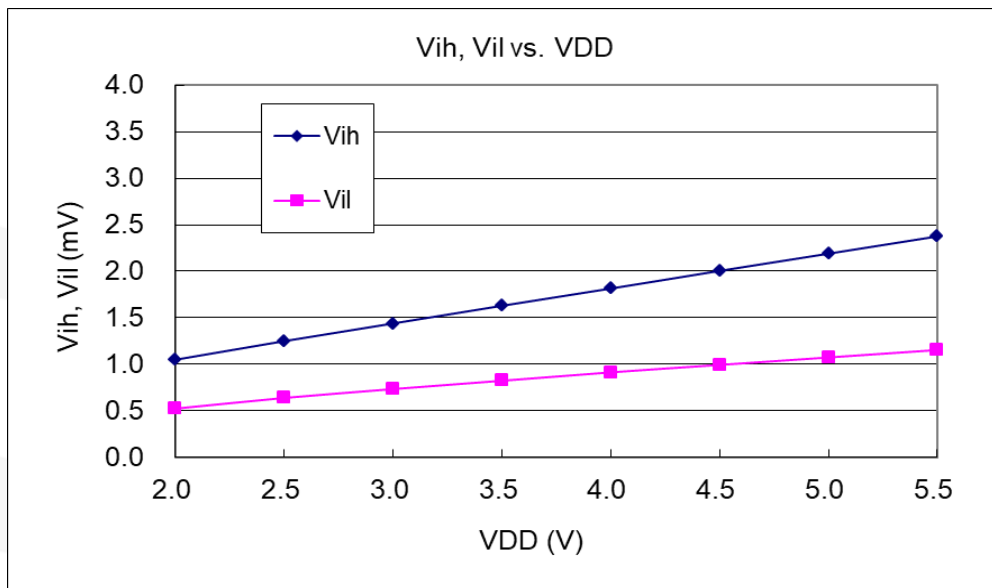


## 14.12. Typical IO driving current ( $I_{OH}$ ) and sink current ( $I_{OL}$ )

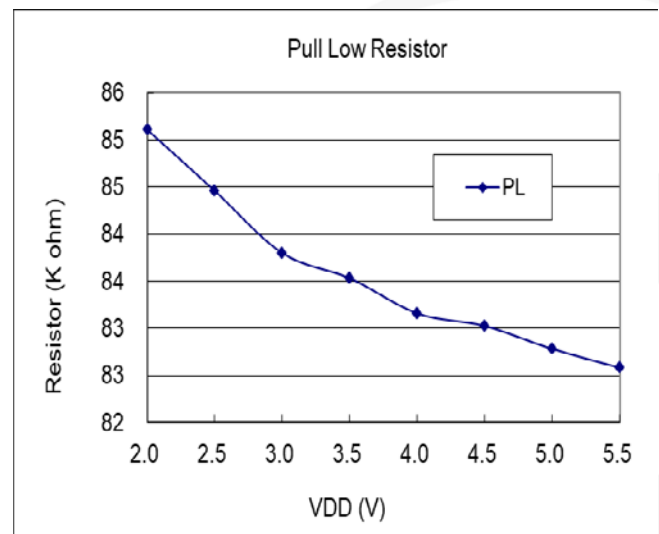
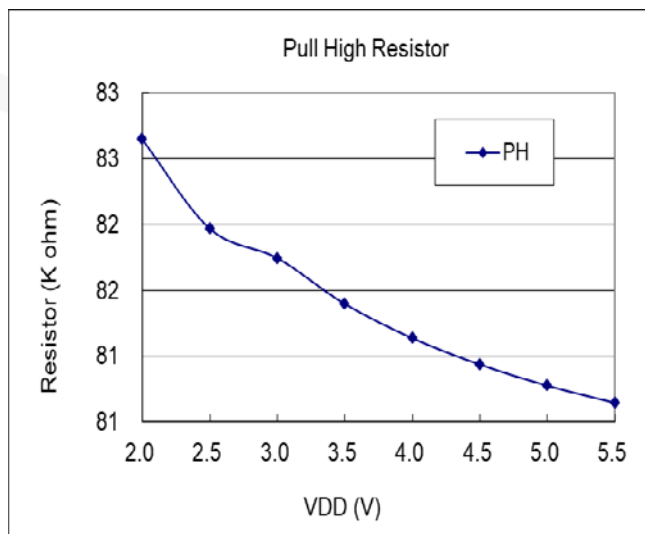




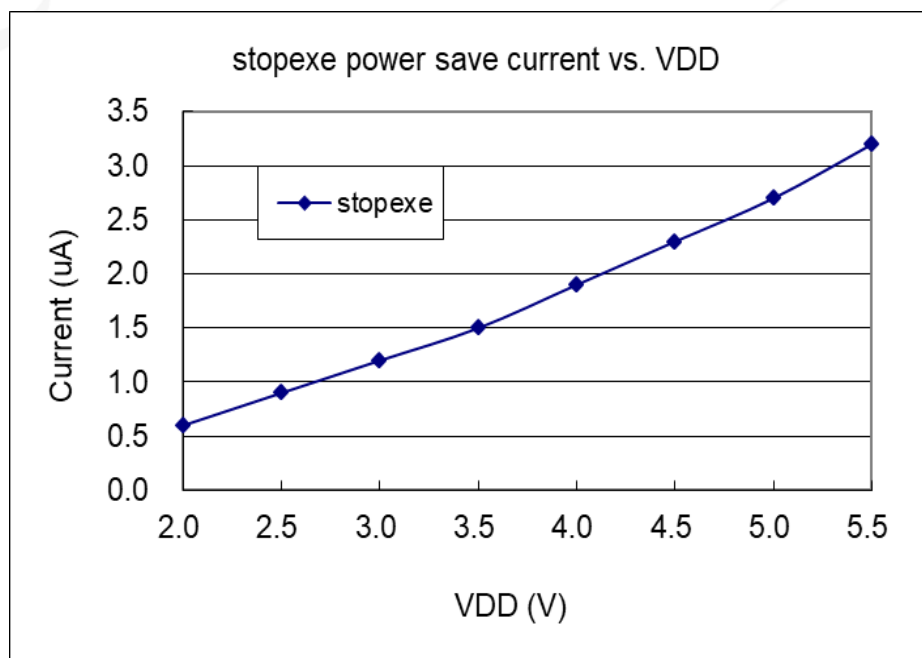
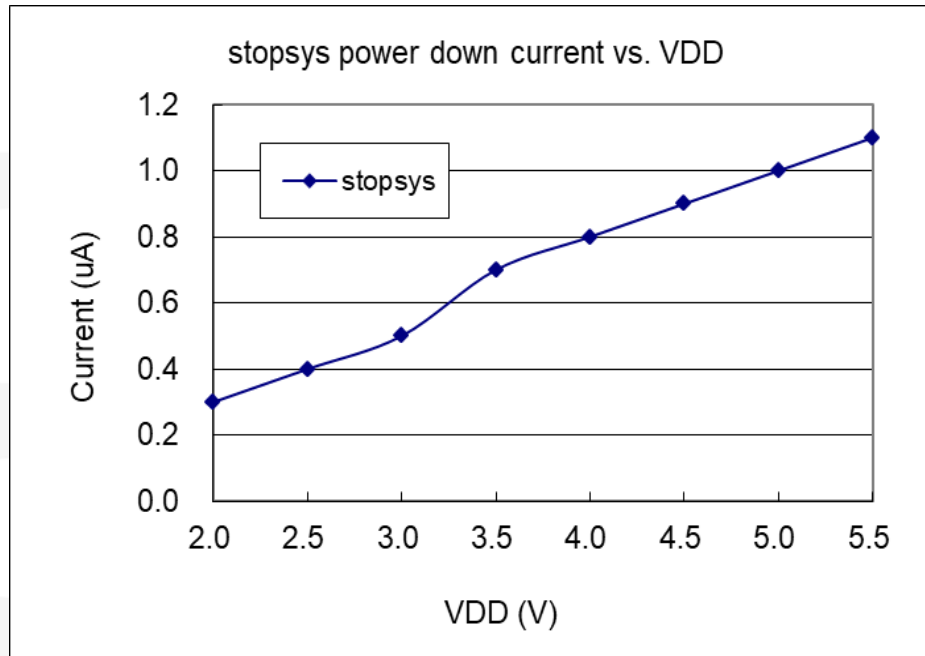
## 14.13. Typical IO input high/low threshold voltage ( $V_{IH}/V_{IL}$ )



## 14.14. Typical resistance of IO pull high/low device



## 14.15. Typical power down current ( $I_{PD}$ ) and power save current ( $I_{PS}$ )



## 15. Instructions

Symbol	Description
<b>ACC</b>	Accumulator ( Abbreviation of accumulator)
<b>a</b>	Accumulator ( Symbol of accumulator in program)
<b>sp</b>	Stack pointer
<b>flag</b>	ACC status flag register
<b>I</b>	Immediate data
<b>&amp;</b>	Logical AND
<b> </b>	Logical OR
<b>←</b>	Movement
<b>^</b>	Exclusive logic OR
<b>+</b>	Add
<b>—</b>	Subtraction
<b>~</b>	NOT (logical complement, 1's complement)
<b>¯</b>	NEG (2's complement)
<b>OV</b>	Overflow (The operational result is out of range in signed 2's complement number system)
<b>Z</b>	Zero (If the result of <i>ALU</i> operation is zero, this bit is set to 1)
<b>C</b>	Carry (The operational result is to have carry out for addition or to borrow carry for subtraction in unsigned number system)
<b>AC</b>	Auxiliary Carry (If there is a carry out from low nibble after the result of <i>ALU</i> operation, this bit is set to 1)
<b>IO.n</b>	The bit of register
<b>M.n</b>	Only addressed in 0~0x3F (0~63) is allowed

## 15.1. Instruction Table

Instructions	Function	Cycles	Z	C	AC	OV
<b>Data Transfer and Arithmetic Operation Instructions</b>						
<i>mov a, l</i>	<i>mov a, 0x0f; a ← 0fh;</i>	1	-	-	-	-
<i>mov M, a</i>	<i>mov MEM, a; MEM ← a</i>	1	-	-	-	-
<i>mov a, M</i>	<i>mov a, MEM; a ← MEM; Flag Z is set when MEM is zero.</i>	1	Y	-	-	-
<i>mov a, IO</i>	<i>mov a, pa; a ← pa; Flag Z is set when pa is zero.</i>	1	Y	-	-	-
<i>mov IO, a</i>	<i>mov pb, a; pb ← a;</i>	1	-	-	-	-
<i>ldt16 word</i>	<i>ldt16 word; word ← 16-bit timer</i>	1	-	-	-	-
<i>stt16 word</i>	<i>stt16 word; 16-bit timer ← word</i>	1	-	-	-	-
<i>ldtabh index</i>	<i>ldtabh index; a ← {bit 15~8 of MTP [index]};</i>	2	-	-	-	-
<i>ldtabl index</i>	<i>ldtabl index; a ← {bit7~0 of MTP [index]};</i>	2	-	-	-	-
<i>idxm a, index</i>	<i>idxm a, index; a ← [index], where index is declared by word.</i>	2	-	-	-	-
<i>idxm index, a</i>	<i>idxm index, a; [index] ← a; where index is declared by word.</i>	2	-	-	-	-
<i>xch M</i>	<i>xch MEM; MEM ← a, a ← MEM</i>	1	-	-	-	-
<i>pushaf</i>	<i>pushaf; [sp] ← {flag, ACC}; sp ← sp + 2;</i>	1	-	-	-	-
<i>popaf</i>	<i>popaf; sp ← sp - 2; {Flag, ACC} ← [sp];</i>	1	Y	Y	Y	Y
<i>add a, l</i>	<i>add a, 0x0f; a ← a + 0fh</i>	1	Y	Y	Y	Y
<i>add a, M</i>	<i>add a, MEM; a ← a + MEM</i>	1	Y	Y	Y	Y
<i>add M, a</i>	<i>add MEM, a; MEM ← a + MEM</i>	1	Y	Y	Y	Y
<i>addc a, M</i>	<i>addc a, MEM; a ← a + MEM + C</i>	1	Y	Y	Y	Y
<i>addc M, a</i>	<i>addc MEM, a; MEM ← a + MEM + C</i>	1	Y	Y	Y	Y
<i>addc a</i>	<i>addc a; a ← a + C</i>	1	Y	Y	Y	Y
<i>addc M</i>	<i>addc MEM; MEM ← MEM + C</i>	1	Y	Y	Y	Y
<i>nadd a, M</i>	<i>nadd a, MEM; a ← <math>\overline{a}</math> + MEM</i>	1	Y	Y	Y	Y
<i>nadd M, a</i>	<i>nadd MEM, a; MEM ← <math>\overline{MEM}</math> + a</i>	1	Y	Y	Y	Y
<i>sub a, l</i>	<i>sub a, 0x0f; a ← a - 0fh ( a + [2's complement of 0fh] )</i>	1	Y	Y	Y	Y
<i>sub a, M</i>	<i>sub a, MEM; a ← a - MEM ( a + [2's complement of M] )</i>	1	Y	Y	Y	Y
<i>sub M, a</i>	<i>sub MEM, a; MEM ← MEM - a ( MEM + [2's complement of a] )</i>	1	Y	Y	Y	Y
<i>subc a, M</i>	<i>subc MEM, a; a ← a - MEM - C</i>	1	Y	Y	Y	Y
<i>subc M, a</i>	<i>subc MEM, a; MEM ← MEM - a - C</i>	1	Y	Y	Y	Y
<i>subc a</i>	<i>subc a; a ← a - C</i>	1	Y	Y	Y	Y
<i>subc M</i>	<i>subc MEM; MEM ← MEM - C</i>	1	Y	Y	Y	Y
<i>inc M</i>	<i>inc MEM; MEM ← MEM + 1</i>	1	Y	Y	Y	Y
<i>dec M</i>	<i>dec MEM; MEM ← MEM - 1</i>	1	Y	Y	Y	Y
<i>clear M</i>	<i>clear MEM; MEM ← 0</i>	1	-	-	-	-
<i>mul</i>	<i>mul; {MulRH, ACC} ← ACC * MulOp</i>	1	-	-	-	-

Instructions	Function	Cycle	Z	C	AC	OV
<b>Shift Operation Instructions</b>						
<i>sr a</i>	<i>sr a</i> ; $a(0, b7, b6, b5, b4, b3, b2, b1) \leftarrow a(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow a(b0)$	1	-	Y	-	-
<i>src a</i>	<i>src a</i> ; $a(c, b7, b6, b5, b4, b3, b2, b1) \leftarrow a(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow a(b0)$	1	-	Y	-	-
<i>sr M</i>	<i>sr MEM</i> ; $MEM(0, b7, b6, b5, b4, b3, b2, b1) \leftarrow MEM(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow MEM(b0)$	1	-	Y	-	-
<i>src M</i>	<i>src MEM</i> ; $MEM(c, b7, b6, b5, b4, b3, b2, b1) \leftarrow MEM(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow MEM(b0)$	1	-	Y	-	-
<i>sl a</i>	<i>sl a</i> ; $a(b6, b5, b4, b3, b2, b1, b0, 0) \leftarrow a(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow a(b7)$	1	-	Y	-	-
<i>slc a</i>	<i>slc a</i> ; $a(b6, b5, b4, b3, b2, b1, b0, c) \leftarrow a(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow a(b7)$	1	-	Y	-	-
<i>sl M</i>	<i>sl MEM</i> ; $MEM(b6, b5, b4, b3, b2, b1, b0, 0) \leftarrow MEM(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow MEM(b7)$	1	-	Y	-	-
<i>slc M</i>	<i>slc MEM</i> ; $MEM(b6, b5, b4, b3, b2, b1, b0, C) \leftarrow MEM(b7, b6, b5, b4, b3, b2, b1, b0), C \leftarrow MEM(b7)$	1	-	Y	-	-
<i>swap a</i>	<i>swap a</i> ; $a(b3, b2, b1, b0, b7, b6, b5, b4) \leftarrow a(b7, b6, b5, b4, b3, b2, b1, b0)$	1	-	-	-	-
<b>Logic Operation Instructions</b>						
<i>and a, l</i>	<i>and a, 0x0f</i> ; $a \leftarrow a \& 0fh$	1	Y	-	-	-
<i>and a, M</i>	<i>and a, RAM10</i> ; $a \leftarrow a \& RAM10$	1	Y	-	-	-
<i>and M, a</i>	<i>and MEM, a</i> ; $MEM \leftarrow a \& MEM$	1	Y	-	-	-
<i>or a, l</i>	<i>or a, 0x0f</i> ; $a \leftarrow a   0fh$	1	Y	-	-	-
<i>or a, M</i>	<i>or a, MEM</i> ; $a \leftarrow a   MEM$	1	Y	-	-	-
<i>or M, a</i>	<i>or MEM, a</i> ; $MEM \leftarrow a   MEM$	1	Y	-	-	-
<i>xor a, l</i>	<i>xor a, 0x0f</i> ; $a \leftarrow a \wedge 0fh$	1	Y	-	-	-
<i>xor IO, a</i>	<i>xor pa, a</i> ; $pa \leftarrow a \wedge pa$ ;	1	-	-	-	-
<i>xor a, M</i>	<i>xor a, MEM</i> ; $a \leftarrow a \wedge RAM10$	1	Y	-	-	-
<i>xor M, a</i>	<i>xor MEM, a</i> ; $MEM \leftarrow a \wedge MEM$	1	Y	-	-	-
<i>not a</i>	<i>not a</i> ; $a \leftarrow \sim a$	1	Y	-	-	-
<i>not M</i>	<i>not MEM</i> ; $MEM \leftarrow \sim MEM$	1	Y	-	-	-
<i>neg a</i>	<i>neg a</i> ; $a \leftarrow \overline{a}$	1	Y	-	-	-
<i>neg M</i>	<i>neg MEM</i> ; $MEM \leftarrow \overline{MEM}$	1	Y	-	-	-
<i>comp a, M</i>	<i>comp a, MEM</i> ; Flag will be changed by regarding as ( $a - MEM$ )	1	Y	Y	Y	Y
<i>comp M, a</i>	<i>comp MEM, a</i> ; Flag will be changed by regarding as ( $MEM - a$ )	1	Y	Y	Y	Y

Instructions	Function	Cycles	Z	C	AC	OV
<b>Bit Operation Instructions</b>						
<i>set0</i> IO.n	<i>set0</i> pa.5 ; PA5=0	1	-	-	-	-
<i>set1</i> IO.n	<i>set1</i> pb.5 ; PB5=1	1	-	-	-	-
<i>set0</i> M.n	<i>set0</i> MEM.5 ; set bit 5 of MEM to low	1	-	-	-	-
<i>set1</i> M.n	<i>set1</i> MEM.5 ; set bit 5 of MEM to high	1	-	-	-	-
<i>swapc</i> IO.n	<i>swapc</i> IO.0; C $\leftarrow$ IO.0 , IO.0 $\leftarrow$ C When IO.0 is a port to output pin, carry C will be sent to IO.0; When IO.0 is a port from input pin, IO.0 will be sent to carry C;	1	-	Y	-	-
<b>Conditional Operation Instructions</b>						
<i>ceqsn</i> a, l	<i>ceqsn</i> a, 0x55 ; <i>inc</i> MEM ; <i>goto</i> error ; If a=0x55, then “goto error”; otherwise, “inc MEM”.	1 / 2	Y	Y	Y	Y
<i>ceqsn</i> a, M	<i>ceqsn</i> a, MEM; If a=MEM, skip next instruction	1 / 2	Y	Y	Y	Y
<i>cneqsn</i> a, M	<i>cneqsn</i> a, MEM; If a $\neq$ MEM, skip next instruction	1 / 2	Y	Y	Y	Y
<i>cneqsn</i> a, l	<i>cneqsn</i> a, 0x55 ; <i>inc</i> MEM ; <i>goto</i> error ; If a $\neq$ 0x55, then “goto error”; Otherwise, “inc MEM”	1 / 2	Y	Y	Y	Y
<i>t0sn</i> IO.n	<i>t0sn</i> pa.5; If bit 5 of port A is low, skip next instruction	1 / 2	-	-	-	-
<i>t1sn</i> IO.n	<i>t1sn</i> pa.5; If bit 5 of port A is high, skip next instruction	1 / 2	-	-	-	-
<i>t0sn</i> M.n	<i>t0sn</i> MEM.5 ; If bit 5 of MEM is low, then skip next instruction	1 / 2	-	-	-	-
<i>t1sn</i> M.n	<i>t1sn</i> MEM.5 ; If bit 5 of MEM is high, then skip next instruction	1 / 2	-	-	-	-
<i>izsn</i> a	<i>izsn</i> a; a $\leftarrow$ a + 1, skip next instruction if a = 0	1 / 2	Y	Y	Y	Y
<i>dzsn</i> a	<i>dzsn</i> a; a $\leftarrow$ a - 1, skip next instruction if a = 0	1 / 2	Y	Y	Y	Y
<i>izsn</i> M	<i>izsn</i> MEM; MEM $\leftarrow$ MEM + 1, skip next instruction if MEM= 0	1 / 2	Y	Y	Y	Y
<i>dzsn</i> M	<i>dzsn</i> MEM; MEM $\leftarrow$ MEM - 1, skip next instruction if MEM= 0	1 / 2	Y	Y	Y	Y
<b>System Control Instructions</b>						
<i>call</i> label	<i>call</i> function1; [sp] $\leftarrow$ pc + 1, pc $\leftarrow$ function1, sp $\leftarrow$ sp + 2	2	-	-	-	-
<i>goto</i> label	<i>goto</i> routine1; Go to routine1 and execute program.	2	-	-	-	-
<i>ret</i> l	<i>ret</i> 0x55; A $\leftarrow$ 55h <i>ret</i> ;	2	-	-	-	-
<i>ret</i>	<i>ret</i> ; sp $\leftarrow$ sp - 2 pc $\leftarrow$ [sp]	2	-	-	-	-
<i>reti</i>	<i>reti</i> ; Return to program that is interrupt service routine. After this command is executed, global interrupt is enabled automatically.	2	-	-	-	-
<i>nop</i>	<i>nop</i> ; Nothing changed.	1	-	-	-	-
<i>pcadd</i> a	<i>pcadd</i> a; pc $\leftarrow$ pc + a	2	-	-	-	-
<i>engint</i>	<i>engint</i> ; Interrupt request can be sent to FPP0	1	-	-	-	-
<i>disgint</i>	<i>disgint</i> ; Interrupt request is blocked from FPP0	1	-	-	-	-
<i>stopsys</i>	<i>stopsys</i> ; Stop the system clocks and halt the system	1	-	-	-	-
<i>stopexe</i>	<i>stopexe</i> ; Stop the system clocks and keep oscillator modules active.	1	-	-	-	-
<i>reset</i>	<i>reset</i> ; Reset the whole chip.	1	-	-	-	-
<i>wdreset</i>	<i>wdreset</i> ; Reset Watchdog timer.	1	-	-	-	-